



# ADS126x 高精度、5 チャンネルおよび 10 チャンネル、40kSPS、 24 ビット、PGA およびモニタ付きのデルタ-シグマ ADC

## 1 特長

- 24 ビットの高精度 ADC
  - オフセット・ドリフト係数: 1nV/°C
  - ゲイン・ドリフト係数: 0.5ppm/°C
  - ノイズ: 30nV<sub>RMS</sub> (20SPS、ゲイン = 128)
  - 直線性: 2ppm
- CMOS PGA ゲイン: 1~128
- 広い入力電圧範囲: ±7mV~±5V
- データ・レート: 2.5SPS~40kSPS
- 2.5Vの基準電圧: 2ppm/°C
- 50Hz/60Hz 同時除去モード
- シングルサイクル・セトリング・モード
- 信号および基準モニタ
- 5V または ±2.5V 電源
- 内部温度センサ
- 巡回冗長性検査 (CRC)
- 励起電流源
- センサ・バーンアウト電流源
- 4つの汎用入力/出力 (ADS1261)
- ブリッジ・センサ用 AC 励起 (ADS1261)
- 5mm × 5mm VQFN パッケージ

## 2 アプリケーション

- PLC アナログ入力モジュール
- 重量計および歪みゲージ・デジタイザ
- 温度、圧力測定
- ラボ計測機器
- プロセス分析

## 3 概要

ADS1260 および ADS1261 (ADS126x) は、プログラマブル・ゲイン・アンプ (PGA) を内蔵した高精度、40kSPS、デルタ-シグマ ( $\Delta\Sigma$ ) アナログ/デジタル・コンバータ (ADC) です。このデバイスは、高精度の基準電圧と内部フォルト・モニタも内蔵しています。このセンサ対応 ADCは、重量計や測温抵抗体(RTD)など最も要求の厳しい測定装置に適した、高精度のシングルチップ・ソリューションを提供します。

このADCは、入力信号マルチプレクサ、低ノイズのPGA (ゲイン1~128)、24ビットの $\Delta\Sigma$ 変調器、高精度の基準電圧、プログラマブル・デジタル・フィルタを内蔵しています。

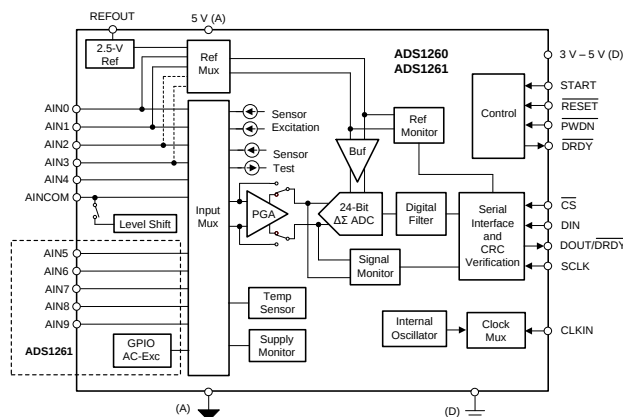
高インピーダンスのPGA入力(1G $\Omega$ )は、センサ負荷に起因する計測誤差を低減します。ADS1260 は、3つの差動入力または5つのシングル・エンド入力をサポートしています。ADS1261 は、5つの差動入力または10個のシングル・エンド入力をサポートしています。内蔵された電流源により、RTD の測定が簡素化されます。

### 製品情報<sup>(1)</sup>

| 型番      | パッケージ     | 本体サイズ(公称)   |
|---------|-----------|-------------|
| ADS126x | VQFN (32) | 5.0mm×5.0mm |

(1) 利用可能なすべてのパッケージについては、このデータシートの末尾にあるパッケージ・オプションについての付録を参照してください。

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## 5 概要（続き）

柔軟性の高いデジタル・フィルタは、50Hz/60Hz のライン・サイクル除去を同時に行いながら、シングルサイクル・セトリング変換を行うようにプログラム可能です。信号および基準モニタ、温度センサ、CRC データ検証により、データの信頼性が向上します。

ADS126x はピン互換のデバイスで、5mm×5mm の VQFN パッケージで供給され、 $-40^{\circ}\text{C}$ ～ $+125^{\circ}\text{C}$ の温度範囲で動作が規定されています。

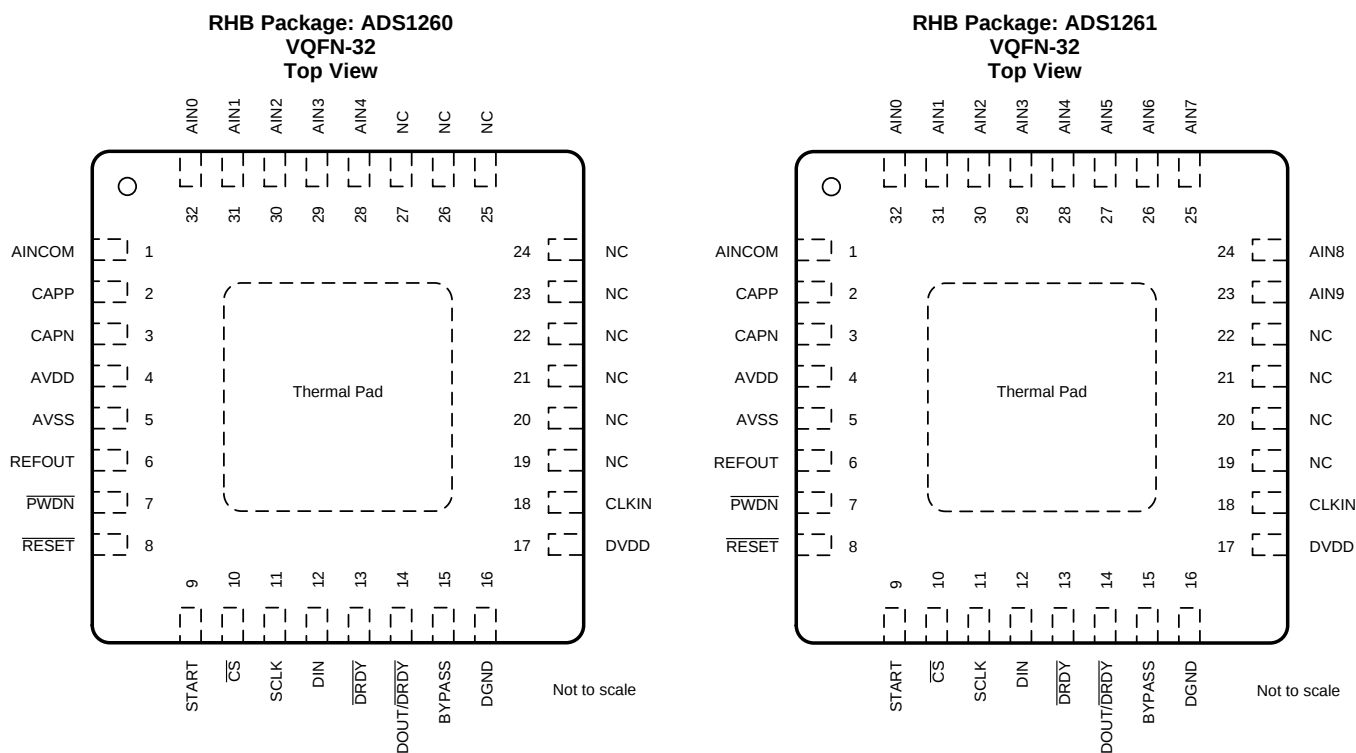
## 6 Device Comparison Table

| PART<br>NUMBER          | CHANNELS <sup>(1)</sup> |              | VOLTAGE REFERENCE GRADE | REFERENCE INPUTS | GPIO<br>AC EXCITATION |
|-------------------------|-------------------------|--------------|-------------------------|------------------|-----------------------|
|                         | SINGLE-ENDED            | DIFFERENTIAL |                         |                  |                       |
| ADS1260B <sup>(2)</sup> | 5                       | 3            | 12 ppm/°C max           | 1                | —                     |
| ADS1261B                | 10                      | 5            | 12 ppm/°C max           | 2                | 4                     |
| ADS1261                 | 10                      | 5            | 40 ppm/°C max           | 2                | 4                     |

(1) Reference inputs, GPIOs, and AC-excitation outputs are multiplexed with the analog input channels.

(2) The ADS1260 is available in B grade only.

## 7 Pin Configuration and Functions



**Pin Functions**

| NO.         | PIN                            |                                | TYPE                | DESCRIPTION                                                                                                            |
|-------------|--------------------------------|--------------------------------|---------------------|------------------------------------------------------------------------------------------------------------------------|
|             | ADS1260                        | ADS1261                        |                     |                                                                                                                        |
| 1           | AINCOM                         | AINCOM                         | Analog input/output | Analog input common, IDAC1, IDAC2, VBIAS                                                                               |
| 2           | CAPP                           | CAPP                           | Analog output       | PGA output P; connect a 4.7-nF C0G dielectric capacitor across CAPP and CAPN                                           |
| 3           | CAPN                           | CAPN                           | Analog output       | PGA output N; connect a 4.7-nF C0G dielectric capacitor across CAPP and CAPN                                           |
| 4           | AVDD                           | AVDD                           | Analog              | Positive analog power supply                                                                                           |
| 5           | AVSS                           | AVSS                           | Analog              | Negative analog power supply                                                                                           |
| 6           | REFOUT                         | REFOUT                         | Analog output       | Internal 2.5-V reference output; connect a 10-μF capacitor to AVSS                                                     |
| 7           | $\overline{\text{PWDN}}$       | $\overline{\text{PWDN}}$       | Digital input       | Power down, active low                                                                                                 |
| 8           | $\overline{\text{RESET}}$      | $\overline{\text{RESET}}$      | Digital input       | Reset, active low                                                                                                      |
| 9           | START                          | START                          | Digital input       | Start conversion control, active high                                                                                  |
| 10          | $\overline{\text{CS}}$         | $\overline{\text{CS}}$         | Digital input       | Serial interface chip select, active low                                                                               |
| 11          | SCLK                           | SCLK                           | Digital Input       | Serial interface shift clock                                                                                           |
| 12          | DIN                            | DIN                            | Digital Input       | Serial interface data input                                                                                            |
| 13          | $\overline{\text{DRDY}}$       | $\overline{\text{DRDY}}$       | Digital output      | Data ready indicator, active low                                                                                       |
| 14          | DOUT/ $\overline{\text{DRDY}}$ | DOUT/ $\overline{\text{DRDY}}$ | Digital output      | Dual function serial interface data output and active-low data ready indicator                                         |
| 15          | BYPASS                         | BYPASS                         | Analog output       | Internal subregulator bypass; connect a 1-μF capacitor to DGND                                                         |
| 16          | DGND                           | DGND                           | Digital             | Digital ground                                                                                                         |
| 17          | DVDD                           | DVDD                           | Digital             | Digital power supply                                                                                                   |
| 18          | CLKIN                          | CLKIN                          | Digital input       | 1) Internal oscillator: connect to DGND<br>2) External clock: connect clock input                                      |
| 19-22       | NC                             | NC                             | —                   | No connection. Electrically float or connect to DGND                                                                   |
| 23          | NC                             | AIN9                           | Analog input/output | ADS1260: No connection. Electrically float or connect to DGND<br>ADS1261: Analog input 9, IDAC1, IDAC2                 |
| 24          | NC                             | AIN8                           | Analog input/output | ADS1260: No connection. Electrically float or connect to DGND<br>ADS1261: Analog input 8, IDAC1, IDAC2                 |
| 25          | NC                             | AIN7                           | Analog input/output | ADS1260: No connection. Electrically float or connect to DGND<br>ADS1261: Analog input 7, IDAC1, IDAC2                 |
| 26          | NC                             | AIN6                           | Analog input/output | ADS1260: No connection. Electrically float or connect to DGND<br>ADS1261: Analog input 6, IDAC1, IDAC2                 |
| 27          | NC                             | AIN5                           | Analog input/output | ADS1260: No connection. Electrically float or connect to DGND<br>ADS1261: Analog input 5, IDAC1, IDAC2, GPIO3, ACX2    |
| 28          | AIN4                           | AIN4                           | Analog input/output | ADS1260: Analog input 4, IDAC1, IDAC2<br>ADS1261: Analog input 4, IDAC1, IDAC2, GPIO2, ACX1                            |
| 29          | AIN3                           | AIN3                           | Analog input/output | ADS1260: Analog input 3, IDAC1, IDAC2<br>ADS1261: Analog input 3, IDAC1, IDAC2, REFN1, GPIO1, $\overline{\text{ACX2}}$ |
| 30          | AIN2                           | AIN2                           | Analog input/output | ADS1260: Analog input 2, IDAC1, IDAC2<br>ADS1261: Analog input 2, IDAC1, IDAC2, REFP1, GPIO0, $\overline{\text{ACX1}}$ |
| 31          | AIN1                           | AIN1                           | Analog input/output | Analog input 1, IDAC1, IDAC2, REFN0                                                                                    |
| 32          | AIN0                           | AIN0                           | Analog input/output | Analog input 0, IDAC1, IDAC2, REFP0                                                                                    |
| Thermal Pad | Pad                            | Pad                            | —                   | Exposed thermal pad; Connect to AVSS. Pad must be soldered for mechanical integrity.                                   |

## 8 Specifications

### 8.1 Absolute Maximum Ratings

see <sup>(1)</sup>

|                       |                                                                                                                                  | MIN        | MAX        | UNIT |
|-----------------------|----------------------------------------------------------------------------------------------------------------------------------|------------|------------|------|
| Power-supply voltage  | AVDD to AVSS                                                                                                                     | –0.3       | 7          | V    |
|                       | AVSS to DGND                                                                                                                     | –3         | 0.3        |      |
|                       | DVDD to DGND                                                                                                                     | –0.3       | 7          |      |
| Analog input voltage  | AINx                                                                                                                             | AVSS – 0.3 | AVDD + 0.3 | V    |
| Digital input voltage | $\overline{CS}$ , SCLK, DIN, DOUT/ $\overline{DRDY}$ , $\overline{DRDY}$ , START, $\overline{RESET}$ , $\overline{PWDN}$ , CLKIN | DGND – 0.3 | DVDD + 0.3 | V    |
| Input current         | Continuous, all pins except power-supply pins <sup>(2)</sup>                                                                     | –10        | 10         | mA   |
| Temperature           | Junction, T <sub>J</sub>                                                                                                         |            | 150        | °C   |
|                       | Storage, T <sub>stg</sub>                                                                                                        | –60        | 150        | °C   |

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) Input and output pins are diode-clamped to the internal power supplies. Limit the input current to 10 mA in the event the analog input voltage exceeds AVDD + 0.3 V or AVSS – 0.3 V, or if the digital input voltage exceeds DVDD + 0.3 V or DGND – 0.3 V.

### 8.2 ESD Ratings

|                    |                         |                                                                                | VALUE | UNIT |
|--------------------|-------------------------|--------------------------------------------------------------------------------|-------|------|
| V <sub>(ESD)</sub> | Electrostatic discharge | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>              | ±2000 | V    |
|                    |                         | Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | ±500  |      |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 8.3 Recommended Operating Conditions

|                                        |                                |                                                                | MIN                        | NOM    | MAX                        | UNIT |
|----------------------------------------|--------------------------------|----------------------------------------------------------------|----------------------------|--------|----------------------------|------|
| POWER SUPPLY                           |                                |                                                                |                            |        |                            |      |
|                                        | Analog power supply            | AVDD to AVSS                                                   | 4.75                       | 5      | 5.25                       | V    |
|                                        |                                | AVSS to DGND                                                   | −2.6                       |        | 0                          |      |
|                                        | Digital power supply           | DVDD to DGND                                                   | 2.7                        |        | 5.25                       | V    |
| ANALOG INPUTS                          |                                |                                                                |                            |        |                            |      |
| V <sub>(AINx)</sub>                    | Absolute input voltage         | PGA mode                                                       | See 式 5                    |        |                            | V    |
|                                        |                                | PGA bypassed                                                   | AVSS − 0.1                 |        | AVDD + 0.1                 |      |
| V <sub>IN</sub>                        | Differential input voltage     | V <sub>IN</sub> = V <sub>AINp</sub> − V <sub>AINn</sub>        | ±V <sub>REF</sub> / Gain   |        | See <sup>(1)</sup>         | V    |
| VOLTAGE REFERENCE INPUTS               |                                |                                                                |                            |        |                            |      |
| V <sub>REF</sub>                       | Differential reference voltage | V <sub>REF</sub> = V <sub>(REFPx)</sub> − V <sub>(REFNx)</sub> | 0.9                        |        | AVDD − AVSS                | V    |
| V <sub>(REFNx)</sub>                   | Negative reference voltage     |                                                                | AVSS − 0.05                |        | V <sub>(REFPx)</sub> − 0.9 | V    |
| V <sub>(REFPx)</sub>                   | Positive reference voltage     |                                                                | V <sub>(REFNx)</sub> + 0.9 |        | AVDD + 0.05                | V    |
| EXTERNAL CLOCK                         |                                |                                                                |                            |        |                            |      |
| f <sub>CLK</sub>                       | Frequency                      | 2.5 SPS to 25.6 kSPS                                           | 1                          | 7.3728 | 8                          | MHz  |
|                                        |                                | 40 kSPS                                                        | 1                          | 10.24  | 10.75                      |      |
|                                        | Duty cycle                     |                                                                | 40%                        |        | 60%                        |      |
| GENERAL-PURPOSE INPUTS/OUTPUTS (GPIOs) |                                |                                                                |                            |        |                            |      |
|                                        | Input voltage                  |                                                                | AVSS                       |        | AVDD                       | V    |
| DIGITAL INPUTS (Other Than GPIOs)      |                                |                                                                |                            |        |                            |      |
|                                        | Input voltage                  |                                                                | DGND                       |        | DVDD                       | V    |
| TEMPERATURE                            |                                |                                                                |                            |        |                            |      |
| T <sub>A</sub>                         | Operating ambient temperature  |                                                                | −45                        |        | 125                        | °C   |

- (1) In PGA mode, the maximum differential input voltage is  $\pm(\text{AVDD} - \text{AVSS} - 0.6 \text{ V}) / \text{Gain}$ , when operating with  $V_{REF} \geq \text{AVDD} - \text{AVSS} - 0.6 \text{ V}$ .

### 8.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |                                              | ADS126x    | UNIT |
|-------------------------------|----------------------------------------------|------------|------|
|                               |                                              | RHB (VQFN) |      |
|                               |                                              | 32 PINS    |      |
| $R_{\theta JA}$               | Junction-to-ambient thermal resistance       | 28.6       | °C/W |
| $R_{\theta JC(top)}$          | Junction-to-case (top) thermal resistance    | 17.0       | °C/W |
| $R_{\theta JB}$               | Junction-to-board thermal resistance         | 9.7        | °C/W |
| $\Psi_{JT}$                   | Junction-to-top characterization parameter   | 0.2        | °C/W |
| $\Psi_{JB}$                   | Junction-to-board characterization parameter | 9.7        | °C/W |
| $R_{\theta JC(bot)}$          | Junction-to-case (bottom) thermal resistance | 0.7        | °C/W |

- (1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics application report](#).

## 8.5 Electrical Characteristics

minimum and maximum specifications apply from  $T_A = -40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$ ; typical specifications are at  $T_A = 25^{\circ}\text{C}$ ; all specifications are at  $\text{AVDD} = 5\text{ V}$ ,  $\text{AVSS} = 0\text{ V}$ ,  $\text{DVDD} = 3.3\text{ V}$ ,  $\text{V}_{\text{REF}} = 2.5\text{ V}$ ,  $f_{\text{CLK}} = 7.3728\text{ MHz}$ , PGA mode, gain = 1, and data rate = 20 SPS (unless otherwise noted)

| PARAMETER           |                                             | TEST CONDITIONS                                       | MIN                         | TYP         | MAX               | UNIT               |        |
|---------------------|---------------------------------------------|-------------------------------------------------------|-----------------------------|-------------|-------------------|--------------------|--------|
| ANALOG INPUTS       |                                             |                                                       |                             |             |                   |                    |        |
|                     | Absolute input current                      | PGA mode, $V_{(\text{AINx})} = 2.5\text{ V}$          | 4                           |             |                   | nA                 |        |
|                     |                                             | PGA bypass                                            | 200                         |             |                   |                    |        |
|                     | Absolute input current drift                |                                                       | 0.01                        |             |                   | nA/°C              |        |
|                     | Differential input current                  | PGA mode, $V_{\text{IN}} = 19\text{ mV}$              | ±0.1                        |             |                   | nA                 |        |
|                     |                                             | PGA mode, $V_{\text{IN}} = 2.5\text{ V}$              | −3                          | ±1          | 3                 |                    |        |
|                     |                                             | PGA mode, chop mode <sup>(1)</sup>                    | ±5                          |             |                   |                    |        |
|                     |                                             | PGA bypass, $V_{\text{IN}} = 2.5\text{ V}$            | ±40                         |             |                   |                    |        |
|                     | Differential input current drift            |                                                       | 0.05                        |             |                   | nA/°C              |        |
|                     | Differential input impedance                | PGA mode                                              | 1                           |             |                   | GΩ                 |        |
|                     |                                             | PGA bypass                                            | 50                          |             |                   | MΩ                 |        |
|                     | Crosstalk                                   |                                                       | 0.1                         |             |                   | μV/V               |        |
| PGA                 |                                             |                                                       |                             |             |                   |                    |        |
|                     | Gain settings                               |                                                       | 1, 2, 4, 8, 16, 32, 64, 128 |             |                   | V/V                |        |
|                     | Antialias filter frequency                  | $C_{\text{CAPP}}, C_{\text{APN}} = 4.7\text{ nF}$     | 60                          |             |                   | kHz                |        |
| PERFORMANCE         |                                             |                                                       |                             |             |                   |                    |        |
|                     | Resolution                                  | No missing codes                                      | 24                          |             |                   | Bits               |        |
| DR                  | Data rate                                   |                                                       | 2.5                         |             |                   | 40000              | SPS    |
|                     | Noise performance                           |                                                       | See 表 1                     |             |                   |                    |        |
| INL                 | Integral nonlinearity                       | Gain = 1 to 16                                        | −10                         | ±2          | 10                | ppm <sub>FSR</sub> |        |
|                     |                                             | Gain = 32 to 128                                      | −12                         | ±3          | 12                |                    |        |
|                     |                                             | Gain = 1 to 32 (40 kSPS)                              | −15                         | ±5          | 15                |                    |        |
| $V_{\text{OS}}$     | Offset voltage                              | $T_{\text{A}} = 25^{\circ}\text{C}$                   | −175 / gain − 5             | ±50 / gain  | 175 / gain + 5    | μV                 |        |
|                     |                                             | $T_{\text{A}} = 25^{\circ}\text{C}$ , chop mode       | −0.5 / gain − 0.05          | ±0.2 / gain | 0.5 / gain + 0.05 |                    |        |
|                     |                                             | After calibration                                     | On the level of noise       |             |                   |                    |        |
|                     | Offset voltage drift                        | Gain = 1 to 8                                         | 100 / gain                  |             |                   | nV/°C              |        |
|                     |                                             | Gain = 16 to 128                                      | 10                          |             |                   |                    | 50     |
|                     |                                             | Chop mode, gain = 1 to 128                            | 1                           |             |                   |                    | 5      |
|                     | Offset voltage long-term drift              | Gain = 1, 1000 hr                                     | ±0.1                        |             |                   | μV                 |        |
| GE                  | Gain error                                  | $T_{\text{A}} = 25^{\circ}\text{C}$ , gain = 1 to 128 | −0.5%                       | ±0.05%      | 0.5%              |                    |        |
|                     |                                             | After calibration                                     | On the level of noise       |             |                   |                    |        |
|                     | Gain drift                                  | Gain = 1 to 128                                       | 0.5                         |             |                   | 4                  | ppm/°C |
| NMRR                | Normal-mode rejection ratio <sup>(2)</sup>  |                                                       | See 表 7                     |             |                   |                    |        |
| CMRR                | Common-mode rejection ratio <sup>(3)</sup>  | Data rate = 20 SPS                                    | 130                         |             |                   | dB                 |        |
|                     |                                             | Data rate = 400 SPS                                   | 105                         | 115         |                   |                    |        |
| PSRR                | Power-supply rejection ratio <sup>(4)</sup> | AVDD and AVSS                                         | 85                          | 100         |                   | dB                 |        |
|                     |                                             | DVDD                                                  | 100                         | 120         |                   |                    |        |
| INTERNAL OSCILLATOR |                                             |                                                       |                             |             |                   |                    |        |
| $f_{\text{CLK}}$    | Frequency                                   | 2.5 SPS to 25.6 kSPS                                  | 7.3728                      |             |                   | MHz                |        |
|                     |                                             | 40 kSPS                                               | 10.24                       |             |                   |                    |        |
|                     | Accuracy                                    |                                                       | −2%                         | ±0.5%       | 2%                |                    |        |

- (1) Chop-mode input current scales with data rate.
- (2) Normal-mode rejection ratio performance depends on the digital filter configuration.
- (3) Common-mode rejection ratio is specified at 60 Hz.
- (4) Power-supply rejection ratio specified at dc. PSRR (dB) = 20 Log ( $\Delta$  power supply voltage /  $\Delta$  offset voltage).

## Electrical Characteristics (continued)

minimum and maximum specifications apply from  $T_A = -40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$ ; typical specifications are at  $T_A = 25^{\circ}\text{C}$ ; all specifications are at  $AVDD = 5\text{ V}$ ,  $AVSS = 0\text{ V}$ ,  $DVDD = 3.3\text{ V}$ ,  $V_{REF} = 2.5\text{ V}$ ,  $f_{CLK} = 7.3728\text{ MHz}$ , PGA mode, gain = 1, and data rate = 20 SPS (unless otherwise noted)

| PARAMETER                                 |                                   | TEST CONDITIONS                                      | MIN                                                  | TYP        | MAX   | UNIT   |
|-------------------------------------------|-----------------------------------|------------------------------------------------------|------------------------------------------------------|------------|-------|--------|
| VOLTAGE REFERENCE INPUTS                  |                                   |                                                      |                                                      |            |       |        |
|                                           | Absolute input current            |                                                      | ±250                                                 |            |       | nA     |
|                                           | Input current vs voltage          |                                                      | 15                                                   |            |       | nA/V   |
|                                           | Input current drift               |                                                      | 0.2                                                  |            |       | nA/°C  |
|                                           | Input impedance                   | Differential                                         | 30                                                   |            |       | MΩ     |
| INTERNAL VOLTAGE REFERENCE <sup>(5)</sup> |                                   |                                                      |                                                      |            |       |        |
|                                           | Voltage                           |                                                      | 2.5                                                  |            |       | V      |
|                                           | Initial error                     | T <sub>A</sub> = 25°C, ADS1260B, ADS1261B            | ±0.1%                                                | ±0.2%      |       |        |
|                                           |                                   | T <sub>A</sub> = 25°C, ADS1261                       | ±0.2%                                                |            |       |        |
|                                           | Temperature drift                 | T <sub>A</sub> = 0°C to +85°C, ADS1260B, ADS1261B    | 2                                                    | 9          |       | ppm/°C |
|                                           |                                   | T <sub>A</sub> = −40°C to +125°C, ADS1260B, ADS1261B | 4                                                    | 12         |       |        |
|                                           |                                   | T <sub>A</sub> = −40°C to +125°C, ADS1261            | 10                                                   | 40         |       |        |
|                                           | Long-term drift                   | 1000 hr                                              | ±25                                                  |            |       | ppm    |
|                                           | Thermal hysteresis <sup>(6)</sup> | First temperature cycle                              | ±70                                                  |            |       | ppm    |
|                                           |                                   | Second temperature cycle                             | ±20                                                  |            |       |        |
|                                           | Output current                    |                                                      | −10                                                  | 10         |       | mA     |
|                                           | Load regulation                   |                                                      | 50                                                   |            |       | μV/mA  |
|                                           | Start-up time                     | Settling time to ±0.001% of final value              | 100                                                  |            |       | ms     |
| EXCITATION CURRENT SOURCES (IDACS)        |                                   |                                                      |                                                      |            |       |        |
|                                           | Current settings                  |                                                      | 50, 100, 250, 500, 750, 1000, 1500, 2000, 2500, 3000 |            |       | μA     |
|                                           | Compliance range                  |                                                      | AVSS                                                 | AVDD − 1.1 |       | V      |
|                                           | Accuracy                          |                                                      | −4%                                                  | ±0.7%      | 4%    |        |
|                                           | Match error                       | Same current magnitudes                              | −1%                                                  | ±0.1%      | 1%    |        |
|                                           |                                   | Different current magnitudes                         | ±1%                                                  |            |       |        |
|                                           | Temperature drift                 | Absolute                                             | 50                                                   |            |       | ppm/°C |
|                                           |                                   | Match drift, I <sub>IDAC1</sub> = I <sub>IDAC2</sub> | 525                                                  |            |       |        |
| LEVEL-SHIFT VOLTAGE (VBIAS)               |                                   |                                                      |                                                      |            |       |        |
|                                           | Voltage                           |                                                      | (AVDD + AVSS) / 2                                    |            |       | V      |
|                                           | Output impedance                  |                                                      | 100                                                  |            |       | Ω      |
| BURN-OUT CURRENT SOURCES                  |                                   |                                                      |                                                      |            |       |        |
|                                           | Current settings                  | Sink and source                                      | 0.05, 0.2, 1, 10                                     |            |       | μA     |
|                                           | Accuracy                          | 0.05-μA range                                        | 0.025                                                | 0.05       | 0.075 | μA     |
| TEMPERATURE SENSOR                        |                                   |                                                      |                                                      |            |       |        |
|                                           | Sensor voltage                    | T <sub>A</sub> = 25°C                                | 122.4                                                |            |       | mV     |
|                                           | Temperature coefficient           |                                                      | 420                                                  |            |       | μV/°C  |
| MONITORS                                  |                                   |                                                      |                                                      |            |       |        |
|                                           | PGA output                        | Low                                                  | AVSS + 0.2                                           |            |       | V      |
|                                           |                                   | High                                                 | AVDD − 0.2                                           |            |       |        |
|                                           | Reference voltage                 | Low                                                  | 0.40.6                                               |            |       | V      |

(5) Soldered to PCB using recommended PCB layout pattern and using reflow profile per JEDEC standard J-STD-020D.1

(6) Voltage reference hysteresis measured by operating the device at  $25^{\circ}\text{C}$  cycling the device to  $0^{\circ}\text{C}$  and  $105^{\circ}\text{C}$  and returning the device to  $25^{\circ}\text{C}$ .

## Electrical Characteristics (continued)

minimum and maximum specifications apply from  $T_A = -40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$ ; typical specifications are at  $T_A = 25^{\circ}\text{C}$ ; all specifications are at  $\text{AVDD} = 5\text{ V}$ ,  $\text{AVSS} = 0\text{ V}$ ,  $\text{DVDD} = 3.3\text{ V}$ ,  $V_{\text{REF}} = 2.5\text{ V}$ ,  $f_{\text{CLK}} = 7.3728\text{ MHz}$ , PGA mode, gain = 1, and data rate = 20 SPS (unless otherwise noted)

| PARAMETER                                                   |                                     | TEST CONDITIONS                    | MIN                     | TYP                      | MAX                     | UNIT          |
|-------------------------------------------------------------|-------------------------------------|------------------------------------|-------------------------|--------------------------|-------------------------|---------------|
| <b>GENERAL-PURPOSE INPUTS/OUTPUTS (GPIOs)<sup>(7)</sup></b> |                                     |                                    |                         |                          |                         |               |
| $V_{\text{OL}}$                                             | Low-level output voltage            | $I_{\text{OL}} = -1\text{ mA}$     |                         |                          | $0.2 \cdot \text{AVDD}$ | V             |
| $V_{\text{OH}}$                                             | High-level output voltage           | $I_{\text{OH}} = 1\text{ mA}$      | $0.8 \cdot \text{AVDD}$ |                          |                         | V             |
| $V_{\text{IL}}$                                             | Low-level input voltage             |                                    |                         |                          | $0.3 \cdot \text{AVDD}$ | V             |
| $V_{\text{IH}}$                                             | High-level input voltage            |                                    | $0.7 \cdot \text{AVDD}$ |                          |                         | V             |
|                                                             | Input hysteresis                    |                                    |                         | 0.5                      |                         | V             |
| <b>DIGITAL INPUTS/OUTPUTS (Other Than GPIOs)</b>            |                                     |                                    |                         |                          |                         |               |
| $V_{\text{OL}}$                                             | Low-level output voltage            | $I_{\text{OL}} = -1\text{ mA}$     |                         |                          | $0.2 \cdot \text{DVDD}$ | V             |
|                                                             |                                     | $I_{\text{OL}} = -8\text{ mA}$     |                         | $0.2 \cdot \text{DVDD}$  |                         |               |
| $V_{\text{OH}}$                                             | High-level output voltage           | $I_{\text{OH}} = 1\text{ mA}$      | $0.8 \cdot \text{DVDD}$ |                          |                         | V             |
|                                                             |                                     | $I_{\text{OH}} = 8\text{ mA}$      |                         | $0.75 \cdot \text{DVDD}$ |                         |               |
| $V_{\text{IL}}$                                             | Low-level input voltage             |                                    |                         |                          | $0.3 \cdot \text{DVDD}$ | V             |
| $V_{\text{IH}}$                                             | High-level input voltage            |                                    | $0.7 \cdot \text{DVDD}$ |                          |                         | V             |
|                                                             | Input hysteresis                    |                                    |                         | 0.1                      |                         | V             |
|                                                             | Input leakage                       | $V_{\text{IH}}$ or $V_{\text{IL}}$ | -10                     |                          | 10                      | $\mu\text{A}$ |
| <b>POWER SUPPLY</b>                                         |                                     |                                    |                         |                          |                         |               |
| $I_{\text{AVDD}}, I_{\text{AVSS}}$                          | Analog supply current               | PGA bypass                         |                         | 2.7                      | 4.5                     | mA            |
|                                                             |                                     | PGA mode, gain = 1 to 32           |                         | 3.8                      | 6                       |               |
|                                                             |                                     | PGA mode, gain = 64 or 128         |                         | 4.3                      | 6.5                     |               |
|                                                             |                                     | Power-down mode                    |                         | 2                        | 8                       | $\mu\text{A}$ |
| $I_{\text{AVDD}}, I_{\text{AVSS}}$                          | Analog supply current (by function) | Voltage reference                  |                         | 0.2                      |                         | mA            |
|                                                             |                                     | 40-kSPS mode                       |                         | 0.5                      |                         |               |
|                                                             |                                     | Current sources                    |                         | As programmed            |                         |               |
| $I_{\text{DVDD}}$                                           | Digital supply current              | 20 SPS                             |                         | 0.4                      | 0.65                    | mA            |
|                                                             |                                     | 40 kSPS                            |                         | 0.6                      | 0.85                    |               |
|                                                             |                                     | Power-down mode <sup>(8)</sup>     |                         | 30                       | 50                      | $\mu\text{A}$ |
| $P_{\text{D}}$                                              | Power dissipation                   | PGA mode                           |                         | 20                       | 32                      | mW            |
|                                                             |                                     | Power-down mode                    |                         | 0.1                      | 0.2                     |               |

(7) GPIO voltage with respect to AVSS.

(8) CLKIN input stopped.

## 8.6 Timing Requirements

over operating ambient temperature range, DVDD = 2.7 V to 5.25 V, and DOUT/ $\overline{\text{DRDY}}$  load: 20 pF || 100 k $\Omega$  to DGND (unless otherwise noted); see [Figure 8](#)

|                                              |                                                                                                                       | MIN | MAX    | UNIT               |
|----------------------------------------------|-----------------------------------------------------------------------------------------------------------------------|-----|--------|--------------------|
| <b>SERIAL INTERFACE</b>                      |                                                                                                                       |     |        |                    |
| $t_{d(\text{CSSC})}$                         | Delay time, first SCLK rising edge after $\overline{\text{CS}}$ falling edge <sup>(1)</sup>                           | 50  |        | ns                 |
| $t_{su(\text{DI})}$                          | Setup time, DIN valid before SCLK falling edge                                                                        | 25  |        | ns                 |
| $t_{h(\text{DI})}$                           | Hold time, DIN valid after SCLK falling edge                                                                          | 25  |        | ns                 |
| $t_{c(\text{SC})}$                           | SCLK period <sup>(2)</sup>                                                                                            | 97  | $10^6$ | ns                 |
| $t_{w(\text{SCH})}$ ,<br>$t_{w(\text{SCL})}$ | Pulse duration, SCLK high or low                                                                                      | 40  |        | ns                 |
| $t_{d(\text{SCCS})}$                         | Delay time, last SCLK falling edge before $\overline{\text{CS}}$ rising edge                                          | 50  |        | ns                 |
| $t_{w(\text{CSH})}$                          | Pulse duration, $\overline{\text{CS}}$ high to reset interface                                                        | 25  |        | ns                 |
| $t_{d(\text{SCIR})}$                         | Delay time, SCLK high or low to force interface auto-reset                                                            |     | 65540  | $1/f_{\text{CLK}}$ |
| <b>RESET</b>                                 |                                                                                                                       |     |        |                    |
| $t_{w(\text{RSTL})}$                         | Pulse duration, $\overline{\text{RESET}}$ low                                                                         | 4   |        | $1/f_{\text{CLK}}$ |
| <b>CONVERSION CONTROL</b>                    |                                                                                                                       |     |        |                    |
| $t_{w(\text{STH})}$                          | Pulse duration, START high                                                                                            | 4   |        | $1/f_{\text{CLK}}$ |
| $t_{w(\text{STL})}$                          | Pulse duration, START low                                                                                             | 4   |        | $1/f_{\text{CLK}}$ |
| $t_{su(\text{DRST})}$                        | Setup time, START low or STOP command after $\overline{\text{DRDY}}$ low to stop next conversion (continuous mode)    |     | 100    | $1/f_{\text{CLK}}$ |
| $t_{h(\text{DRSP})}$                         | Hold time, START low or STOP command after $\overline{\text{DRDY}}$ low to continue next conversion (continuous mode) | 150 |        | $1/f_{\text{CLK}}$ |

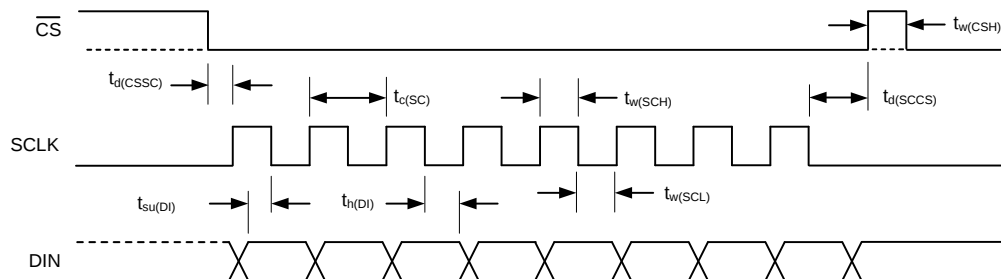
(1)  $\overline{\text{CS}}$  can be tied low.

(2) Serial interface time-out mode: minimum SCLK frequency = 1 kHz. Otherwise, no minimum SCLK frequency.

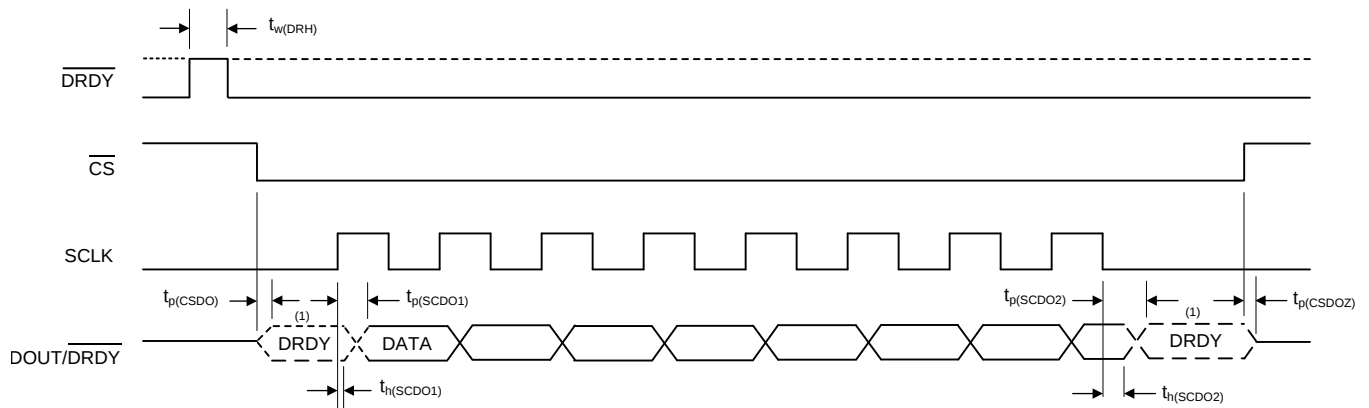
## 8.7 Switching Characteristics

over operating ambient temperature range, DVDD = 2.7 V to 5.25 V, and DOUT/ $\overline{\text{DRDY}}$  load: 20 pF || 100 k $\Omega$  to DGND (unless otherwise noted); see [Figure 8](#)

| PARAMETER                 |                                                                                                               | MIN | TYP             | MAX | UNIT               |
|---------------------------|---------------------------------------------------------------------------------------------------------------|-----|-----------------|-----|--------------------|
| <b>SERIAL INTERFACE</b>   |                                                                                                               |     |                 |     |                    |
| $t_{w(\text{DRH})}$       | Pulse duration, $\overline{\text{DRDY}}$ high                                                                 | 16  |                 |     | 1/f <sub>CLK</sub> |
| $t_{p(\text{CSDO})}$      | Propagation delay time, $\overline{\text{CS}}$ falling edge to DOUT/ $\overline{\text{DRDY}}$ driven          | 0   |                 | 50  | ns                 |
| $t_{p(\text{SCDO1})}$     | Propagation delay time, SCLK rising edge to valid DOUT/ $\overline{\text{DRDY}}$                              |     |                 | 40  | ns                 |
| $t_{h(\text{SCDO1})}$     | Hold time, SCLK rising edge to invalid data on DOUT/ $\overline{\text{DRDY}}$                                 | 0   |                 |     | ns                 |
| $t_{h(\text{SCDO2})}$     | Hold time, last SCLK falling edge of operation to invalid data on DOUT/ $\overline{\text{DRDY}}$              | 15  |                 |     | ns                 |
| $t_{p(\text{SCDO2})}$     | Propagation delay time, last SCLK falling edge to valid data ready function on DOUT/ $\overline{\text{DRDY}}$ |     |                 | 110 | ns                 |
| $t_{p(\text{CSDOZ})}$     | Propagation delay time, $\overline{\text{CS}}$ rising edge to DOUT/ $\overline{\text{DRDY}}$ high impedance   |     |                 | 50  | ns                 |
| <b>RESET</b>              |                                                                                                               |     |                 |     |                    |
| $t_{p(\text{RSCN})}$      | Propagation delay time, $\overline{\text{RESET}}$ rising edge or RESET command to start of conversion         | 512 |                 |     | 1/f <sub>CLK</sub> |
| $t_{p(\text{PRCM})}$      | Propagation delay time, power-on threshold voltage to ADC communication                                       |     | 2 <sup>16</sup> |     | 1/f <sub>CLK</sub> |
| $t_{p(\text{CMCN})}$      | Propagation delay time, ADC communication to conversion start                                                 | 512 |                 |     | 1/f <sub>CLK</sub> |
| <b>AC EXCITATION</b>      |                                                                                                               |     |                 |     |                    |
| $t_d(\text{ACX})$         | Delay time, phase-to-phase blanking period                                                                    |     | 8               |     | 1/f <sub>CLK</sub> |
| $t_c(\text{ACX})$         | ACX period                                                                                                    | 2   |                 |     | t <sub>STDR</sub>  |
| <b>CONVERSION CONTROL</b> |                                                                                                               |     |                 |     |                    |
| $t_{p(\text{STDR})}$      | Propagation delay time, START high or START command to $\overline{\text{DRDY}}$ high                          |     |                 | 2   | 1/f <sub>CLK</sub> |

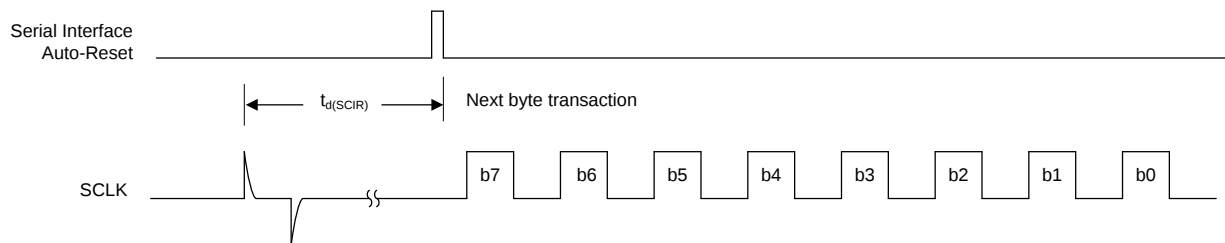


**Figure 1. Serial Interface Timing Requirements**

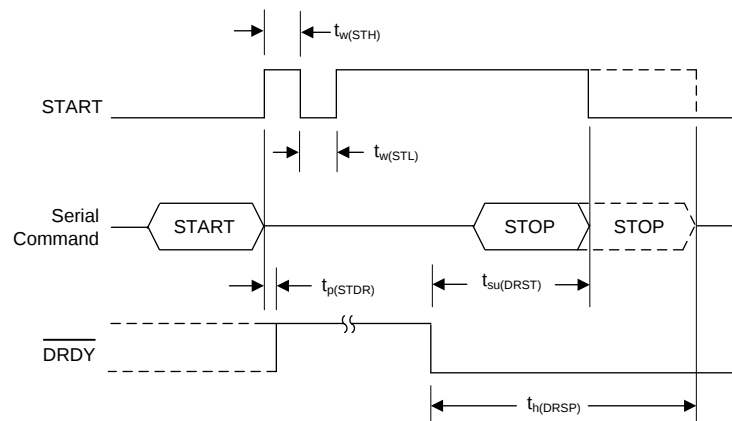


<sup>(1)</sup> Before the first  $\text{SCLK}$  rising edge and after the last  $\text{SCLK}$  falling edge of a command, the function of  $\text{DOUT}/\overline{\text{DRDY}}$  is data ready.

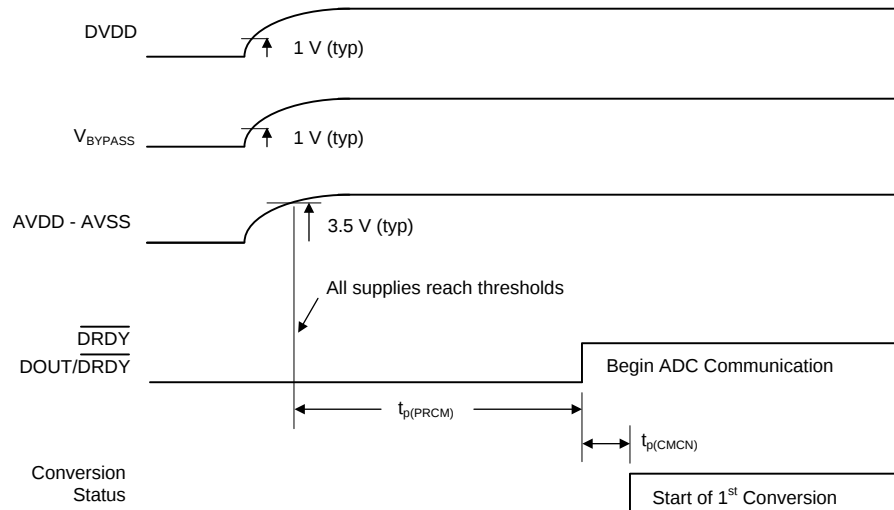
**Figure 2. Serial Interface Switching Characteristics**



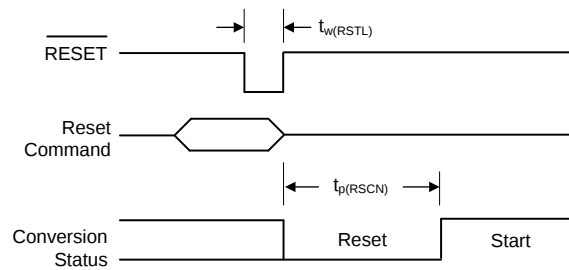
**Figure 3. Serial Interface Auto-Reset Characteristics**



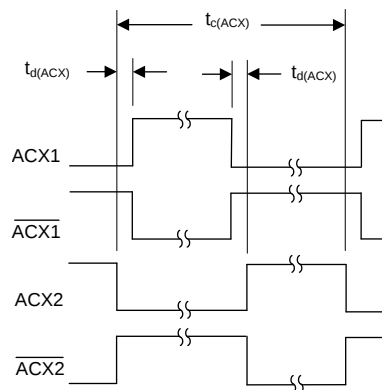
**Figure 4. Conversion Control Timing Requirements**



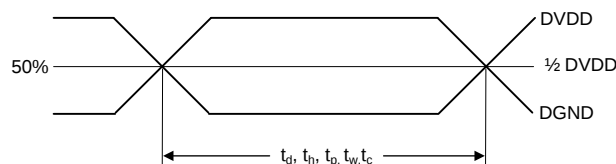
**Figure 5. Power-Up Characteristics**



**Figure 6. RESET pin and RESET Command Timing Requirements**



**Figure 7. AC-Excitation Timing Characteristics**



**Figure 8. Timing Voltage-Level Reference**

## 8.8 Typical Characteristics

at  $T_A = 25^\circ\text{C}$ ,  $AVDD = 5\text{ V}$ ,  $AVSS = 0\text{ V}$ ,  $DVDD = 3.3\text{ V}$ ,  $V_{REF} = 2.5\text{ V}$ , data rate = 20 SPS,  $f_{CLK} = 7.3728\text{ MHz}$  ( $f_{CLK} = 10.24\text{ MHz}$  for data rate = 40 kSPS), and gain = 1 (unless otherwise noted)

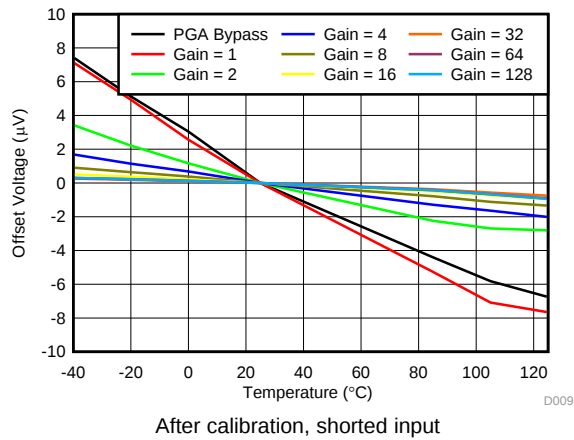


Figure 9. Offset Voltage vs Temperature

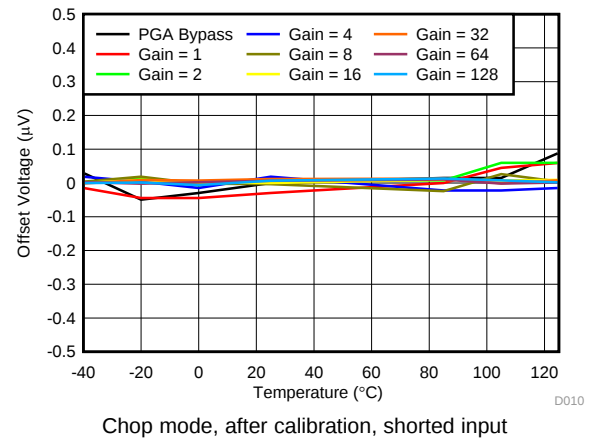


Figure 10. Offset Voltage vs Temperature

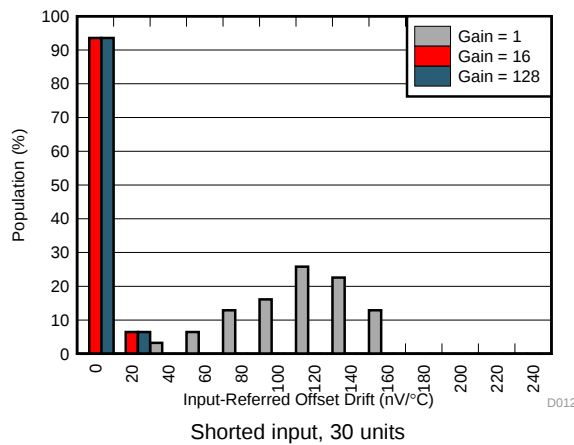


Figure 11. Offset Voltage Drift Distribution

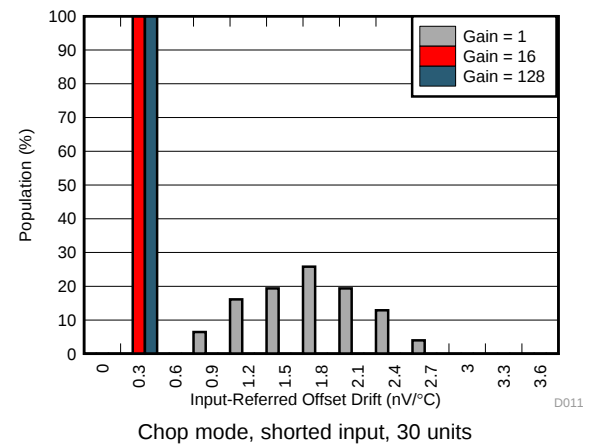


Figure 12. Offset Voltage Drift Distribution

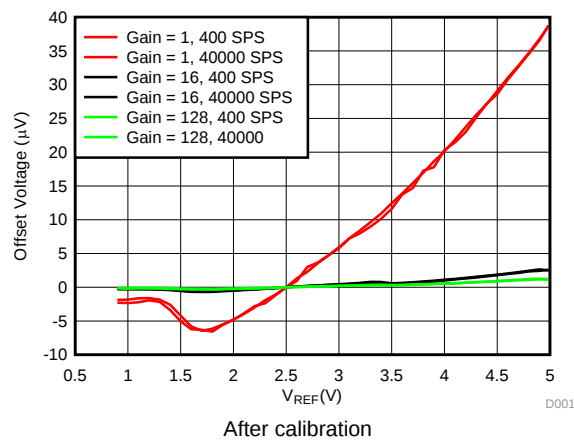


Figure 13. Offset Voltage vs Reference Voltage

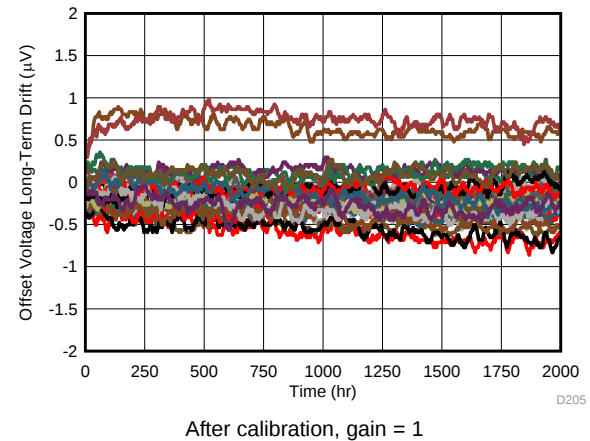


Figure 14. Offset Voltage Long-Term Drift

## Typical Characteristics (continued)

at  $T_A = 25^\circ\text{C}$ ,  $AVDD = 5\text{ V}$ ,  $AVSS = 0\text{ V}$ ,  $DVDD = 3.3\text{ V}$ ,  $V_{REF} = 2.5\text{ V}$ , data rate = 20 SPS,  $f_{CLK} = 7.3728\text{ MHz}$  ( $f_{CLK} = 10.24\text{ MHz}$  for data rate = 40 kSPS), and gain = 1 (unless otherwise noted)

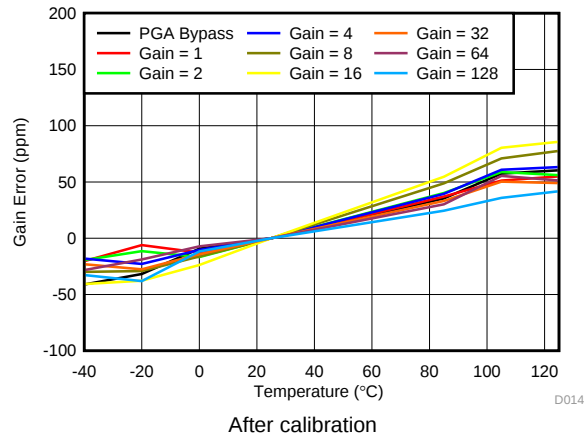


Figure 15. Gain Error vs Temperature

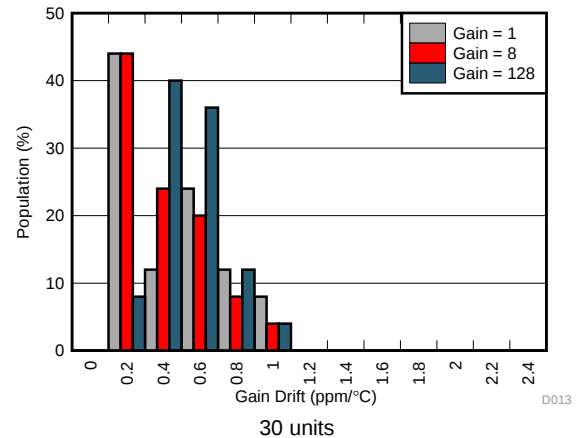


Figure 16. Gain Error Drift Distributions

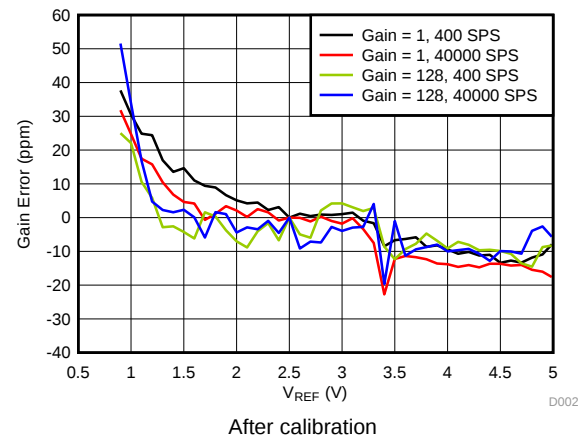


Figure 17. Gain Error vs Reference Voltage

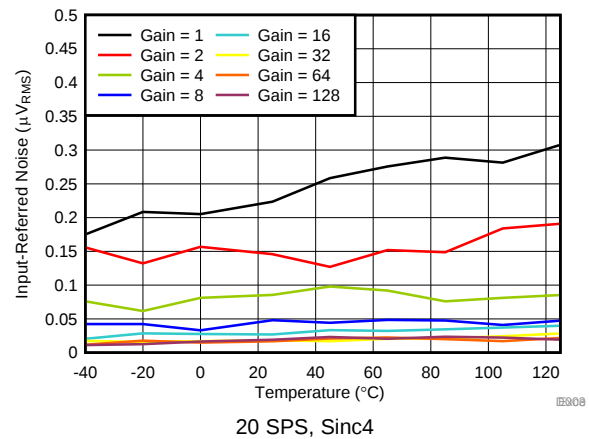


Figure 18. Noise vs Temperature

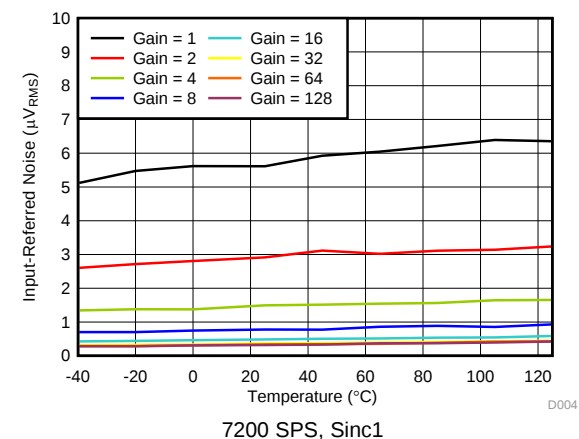


Figure 19. Noise vs Temperature

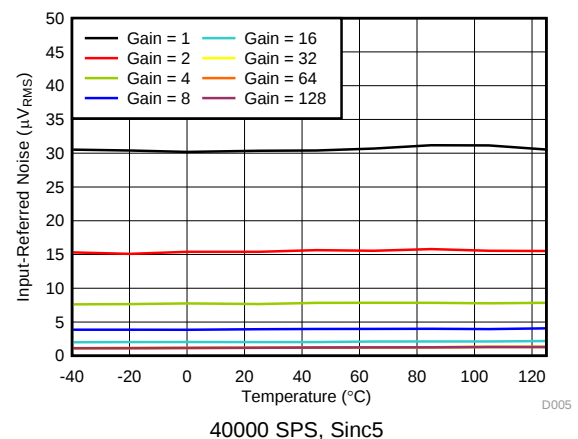


Figure 20. Noise vs Temperature

## Typical Characteristics (continued)

at  $T_A = 25^\circ\text{C}$ ,  $AVDD = 5\text{ V}$ ,  $AVSS = 0\text{ V}$ ,  $DVDD = 3.3\text{ V}$ ,  $V_{REF} = 2.5\text{ V}$ , data rate = 20 SPS,  $f_{CLK} = 7.3728\text{ MHz}$  ( $f_{CLK} = 10.24\text{ MHz}$  for data rate = 40 kSPS), and gain = 1 (unless otherwise noted)

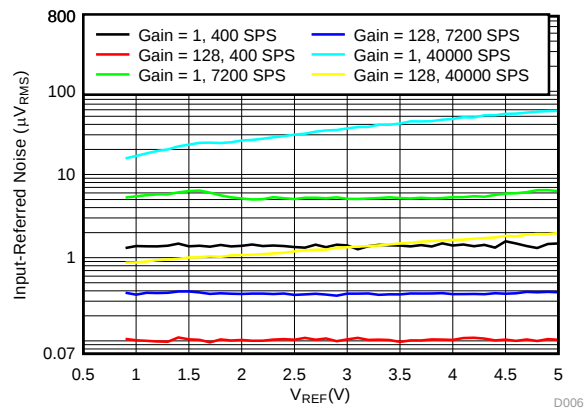


FIG 21. Noise vs Reference Voltage

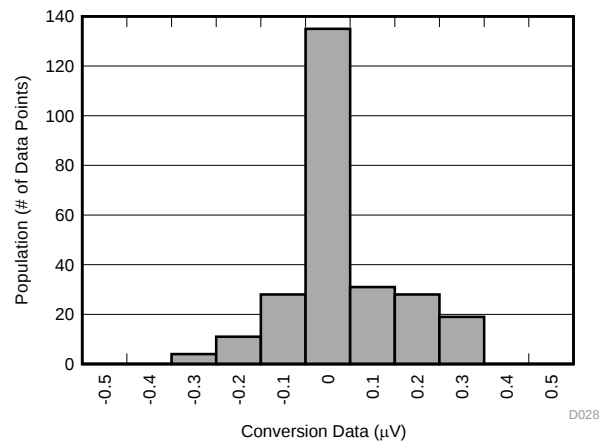


FIG 22. Conversion Data Histogram

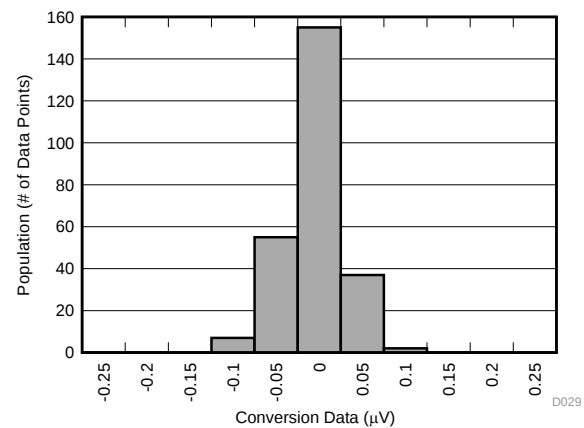


FIG 23. Conversion Data Histogram

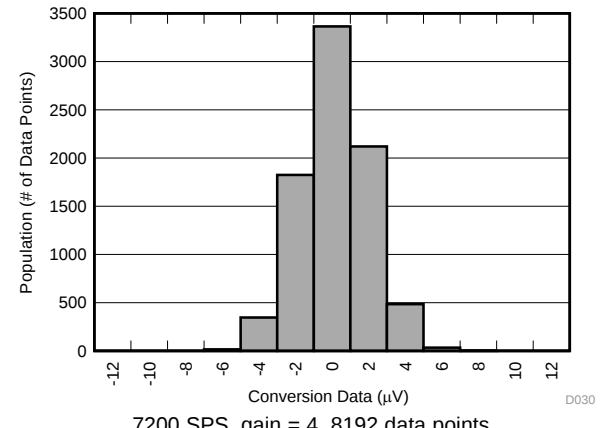


FIG 24. Conversion Data Histogram

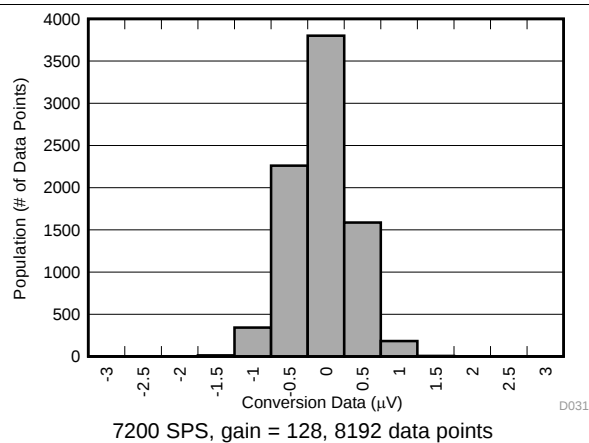


FIG 25. Conversion Data Histogram

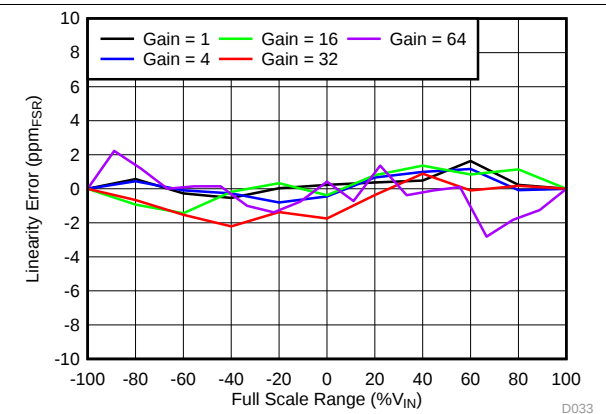


FIG 26. Integral Nonlinearity vs  $V_{IN}$

## Typical Characteristics (continued)

at  $T_A = 25^\circ\text{C}$ ,  $AVDD = 5\text{ V}$ ,  $AVSS = 0\text{ V}$ ,  $DVDD = 3.3\text{ V}$ ,  $V_{REF} = 2.5\text{ V}$ , data rate = 20 SPS,  $f_{CLK} = 7.3728\text{ MHz}$  ( $f_{CLK} = 10.24\text{ MHz}$  for data rate = 40 kSPS), and gain = 1 (unless otherwise noted)

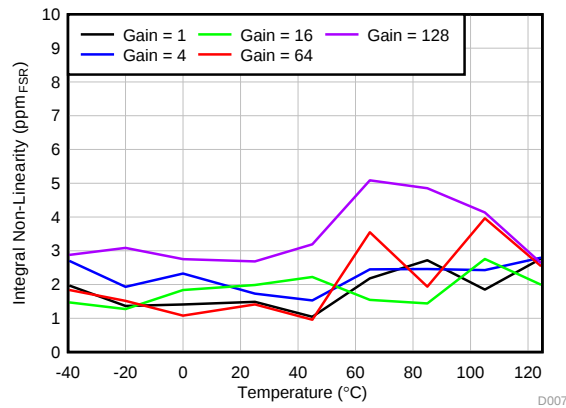


Figure 27. Integral Nonlinearity vs Temperature

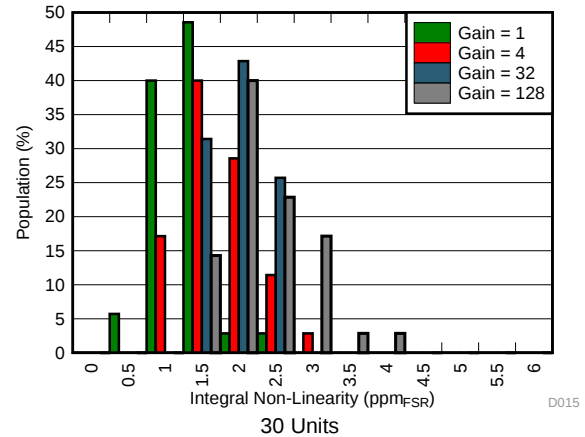


Figure 28. Integral Nonlinearity Distribution

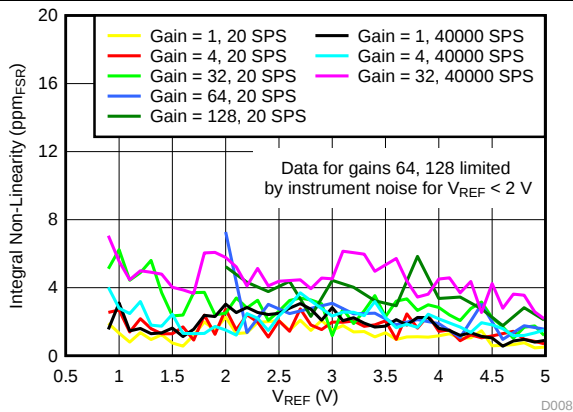
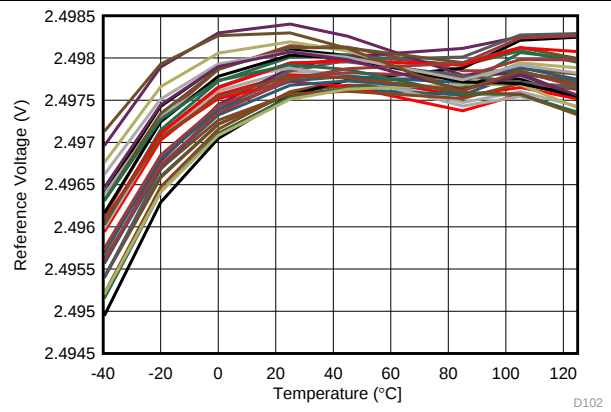
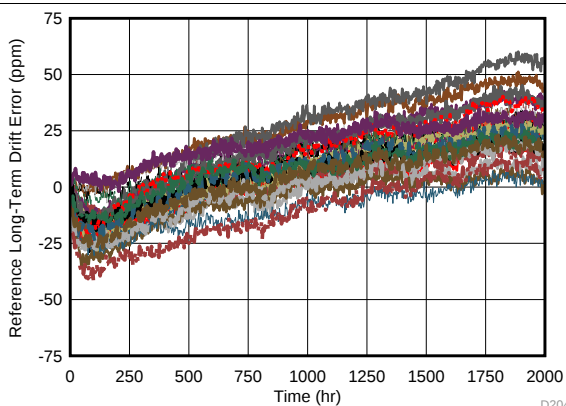


Figure 29. Integral Nonlinearity vs Reference Voltage



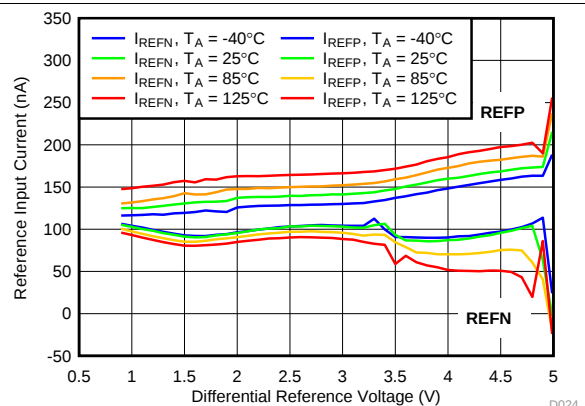
ADS1260B, ADS1261B - 30 units

Figure 30. Voltage Reference vs Temperature



After calibration, 30 units

Figure 31. Voltage Reference Long-Term Drift



$I_{REFP}$  measured with  $V_{REFN} = AVSS$   
 $I_{REFN}$  measured with  $V_{REFP} = AVDD$

Figure 32. Reference Input Current vs Reference Voltage

## Typical Characteristics (continued)

at  $T_A = 25^\circ\text{C}$ ,  $AVDD = 5\text{ V}$ ,  $AVSS = 0\text{ V}$ ,  $DVDD = 3.3\text{ V}$ ,  $V_{REF} = 2.5\text{ V}$ , data rate = 20 SPS,  $f_{CLK} = 7.3728\text{ MHz}$  ( $f_{CLK} = 10.24\text{ MHz}$  for data rate = 40 kSPS), and gain = 1 (unless otherwise noted)

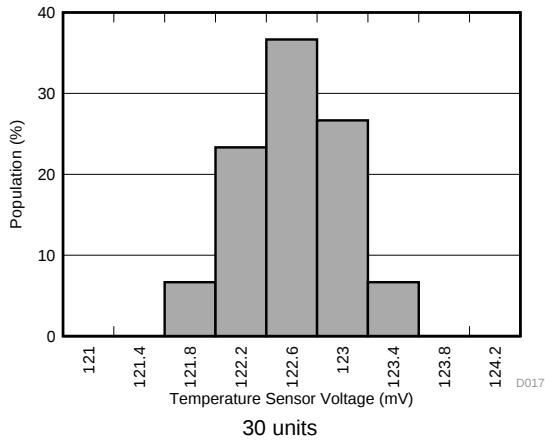


Figure 33. Temperature Sensor Voltage Histogram

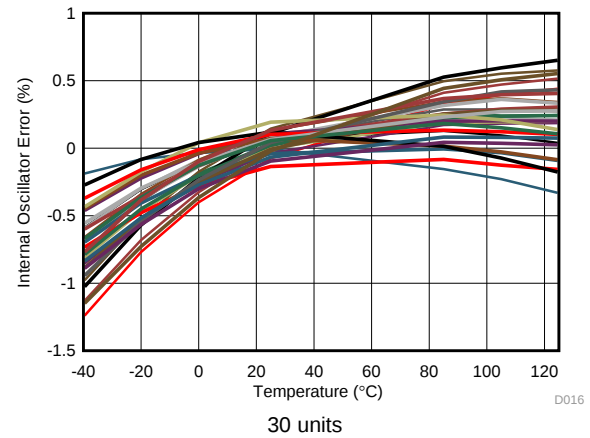


Figure 34. Internal Oscillator vs Temperature

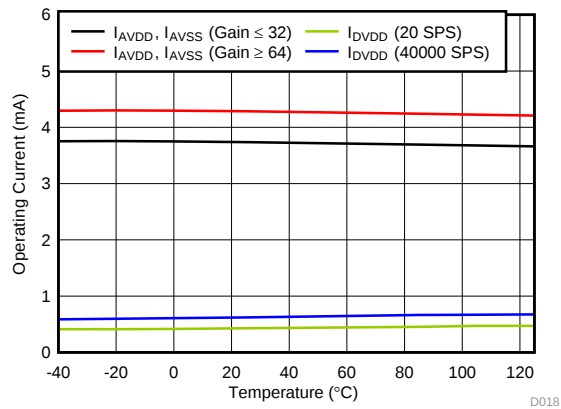


Figure 35. Operating Current vs Temperature

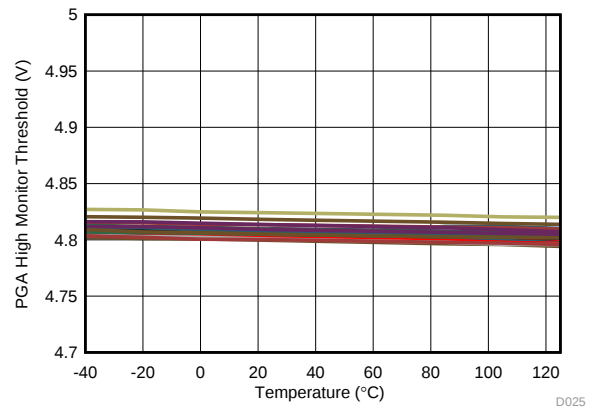


Figure 36. PGA High Monitor Threshold

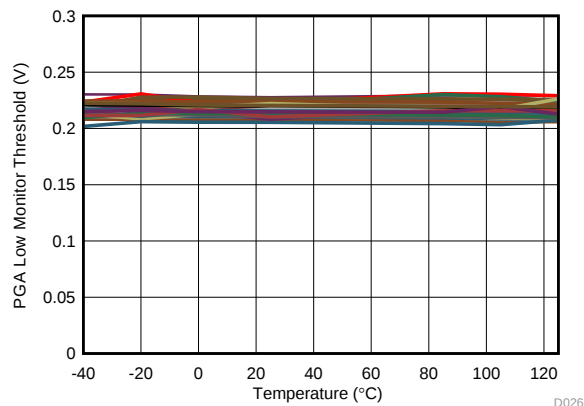


Figure 37. PGA Low Monitor Threshold

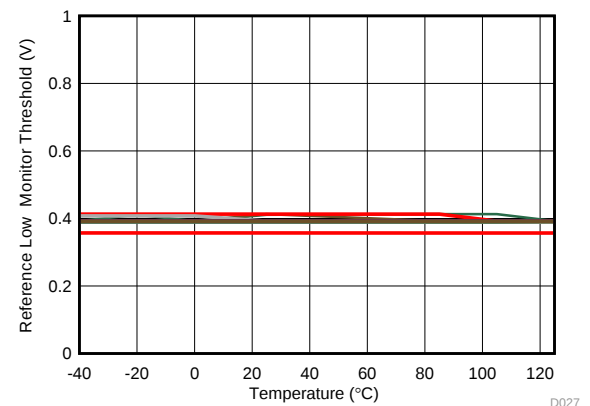


Figure 38. Reference Voltage Low Alarm Threshold

## Typical Characteristics (continued)

at  $T_A = 25^\circ\text{C}$ ,  $AVDD = 5\text{ V}$ ,  $AVSS = 0\text{ V}$ ,  $DVDD = 3.3\text{ V}$ ,  $V_{REF} = 2.5\text{ V}$ , data rate = 20 SPS,  $f_{CLK} = 7.3728\text{ MHz}$  ( $f_{CLK} = 10.24\text{ MHz}$  for data rate = 40 kSPS), and gain = 1 (unless otherwise noted)

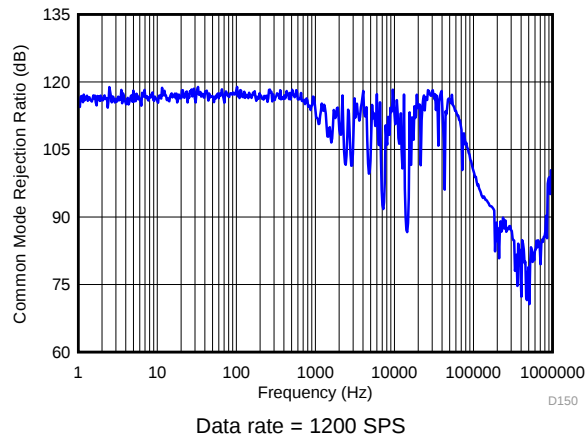


Figure 39. CMRR vs Frequency

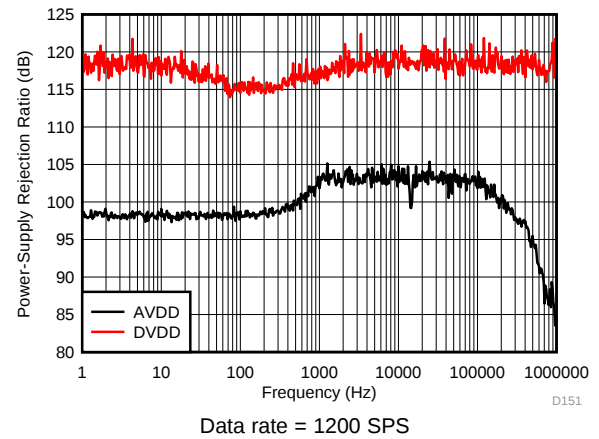


Figure 40. PSRR vs Frequency

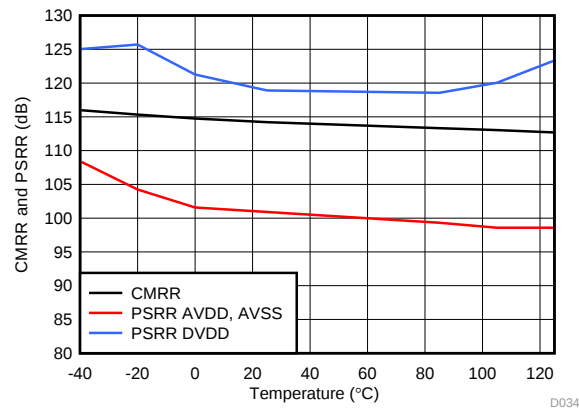


Figure 41. CMRR and PSRR vs Temperature

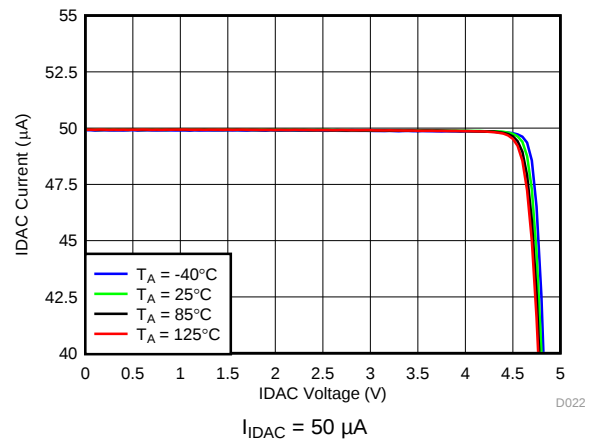


Figure 42. IDAC Current vs IDAC Voltage

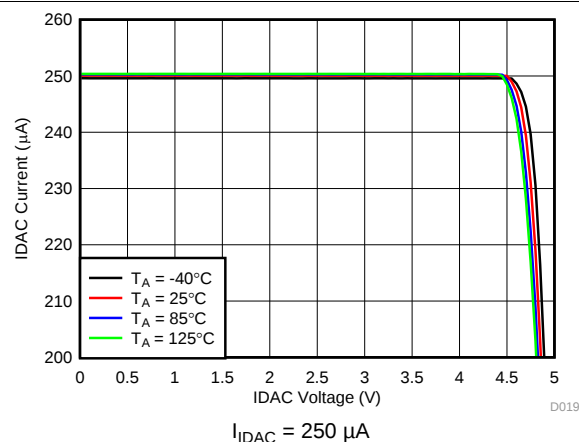


Figure 43. IDAC Current vs IDAC Voltage

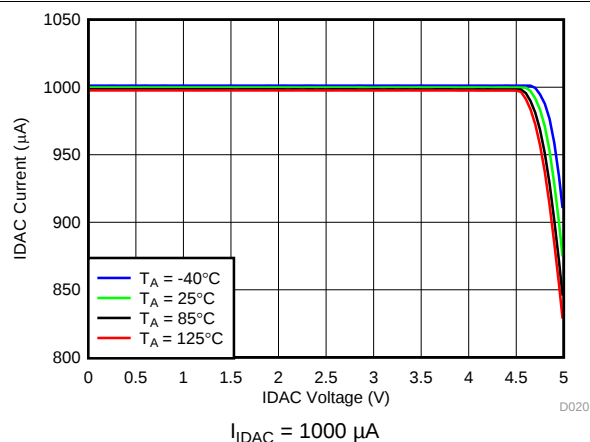


Figure 44. IDAC Current vs IDAC Voltage

## Typical Characteristics (continued)

at  $T_A = 25^\circ\text{C}$ ,  $AVDD = 5\text{ V}$ ,  $AVSS = 0\text{ V}$ ,  $DVDD = 3.3\text{ V}$ ,  $V_{REF} = 2.5\text{ V}$ , data rate = 20 SPS,  $f_{CLK} = 7.3728\text{ MHz}$  ( $f_{CLK} = 10.24\text{ MHz}$  for data rate = 40 kSPS), and gain = 1 (unless otherwise noted)

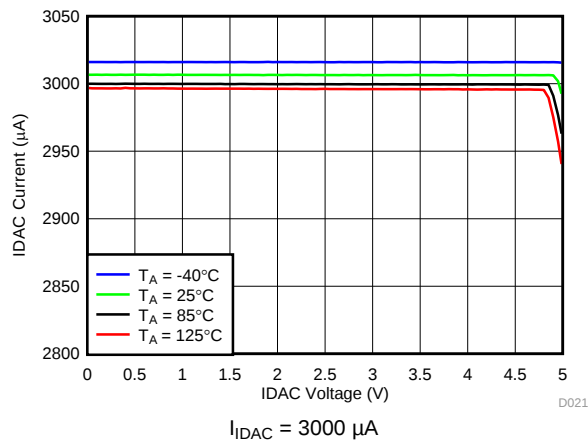


图 45. IDAC Current vs IDAC Voltage

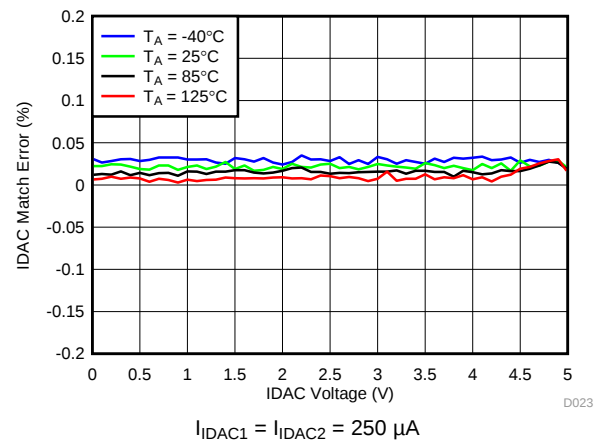


图 46. IDAC Current Match vs IDAC Voltage

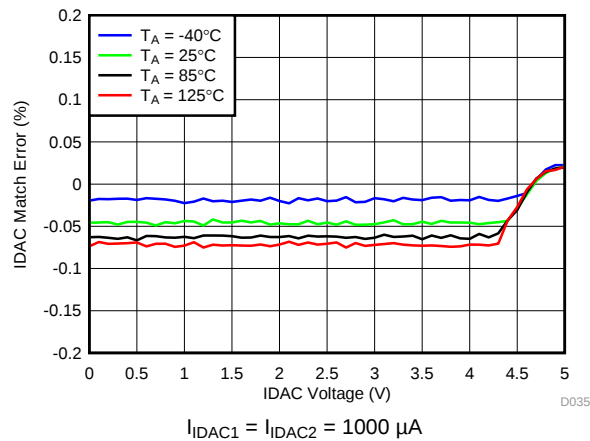


图 47. IDAC Current Match vs IDAC Voltage

## 9 Parameter Measurement Information

### 9.1 Noise Performance

The ADS126x noise performance depends on the ADC configuration: data rate, PGA gain, digital filter configuration, and chop mode. The combination of the parameters affect noise performance. Two significant factors affecting noise performance are data rate and PGA gain. Since the profile of noise is predominantly white (flat vs frequency), decreasing the data rate proportionally decreases bandwidth and therefore, total noise. Since the noise of the PGA is lower than that of the modulator of the ADC, increasing the gain reduces noise when treated as an input-referred quantity. Noise performance also depends on the digital filter and chop mode. As the order of the digital filter increases, the noise bandwidth correspondingly decreases resulting in lower noise. Further, as a result of two-point data averaging in chop mode, noise performance improves by  $\sqrt{2}$  compared to normal operation.

表 1 shows noise performance in units of  $\mu V_{RMS}$  (RMS = root mean square) under the conditions listed. The values in parenthesis are peak-to-peak values. 表 2 shows the noise performance in effective resolution (bits) under the specified conditions. The values shown in parenthesis are the noise-free resolution. Noise-free resolution is the resolution of the ADC with no code flicker. The noise-free resolution data are calculated based on the peak-to-peak noise measurements.

The effective resolution data listed in the tables are calculated using 式 1:

$$\text{Effective Resolution or Noise-Free Resolution} = \ln(\text{FSR} / e_n) / \ln(2)$$

where

- FSR = full scale range =  $2 \cdot V_{REF} / \text{Gain}$  (See [Recommended Operating Conditions](#) for FSR)
- $e_n$  = Input referred voltage noise (RMS value to calculate effective resolution, p-p value to calculate noise-free resolution) (1)

The data shown in the noise performance table represent typical ADC performance at  $T_A = 25^\circ\text{C}$ . The noise-performance data are the standard deviation and peak-to-peak computations of the ADC data. The noise data are acquired with inputs shorted, based on consecutive ADC readings for a period of ten seconds or 8192 data points, whichever occurs first. Because of the statistical nature of noise, repeated noise measurements may yield higher or lower noise performance results.

As a result of the increased full-scale input range provided by 5-V reference operation, effective resolution and noise-free resolution performance are typically optimized using a 5-V reference. The effective resolution and noise-free resolution performance data shown in 表 2 are with external 5-V reference operation.

**表 1. Noise in  $\mu V_{RMS}$  ( $\mu V_{PP}$ ) at  $T_A = 25^\circ\text{C}$  and Internal 2.5-V Reference**

| DATA RATE (SPS) | FILTER | GAIN        |              |               |               |               |               |               |               |
|-----------------|--------|-------------|--------------|---------------|---------------|---------------|---------------|---------------|---------------|
|                 |        | 1           | 2            | 4             | 8             | 16            | 32            | 64            | 128           |
| 2.5             | FIR    | 0.18 (0.6)  | 0.078 (0.28) | 0.046 (0.16)  | 0.025 (0.096) | 0.014 (0.053) | 0.012 (0.045) | 0.01 (0.042)  | 0.01 (0.04)   |
| 2.5             | Sinc1  | 0.15 (0.47) | 0.071 (0.28) | 0.038 (0.14)  | 0.019 (0.075) | 0.012 (0.051) | 0.01 (0.039)  | 0.009 (0.037) | 0.009 (0.037) |
| 2.5             | Sinc2  | 0.14 (0.38) | 0.065 (0.23) | 0.032 (0.096) | 0.018 (0.059) | 0.011 (0.037) | 0.007 (0.028) | 0.007 (0.028) | 0.008 (0.033) |
| 2.5             | Sinc3  | 0.12 (0.38) | 0.062 (0.17) | 0.028 (0.064) | 0.016 (0.053) | 0.01 (0.035)  | 0.008 (0.027) | 0.007 (0.026) | 0.006 (0.023) |
| 2.5             | Sinc4  | 0.1 (0.26)  | 0.059 (0.17) | 0.032 (0.085) | 0.016 (0.059) | 0.010 (0.035) | 0.008 (0.027) | 0.006 (0.025) | 0.006 (0.024) |
| 5               | FIR    | 0.22 (0.89) | 0.11 (0.4)   | 0.058 (0.24)  | 0.032 (0.13)  | 0.021 (0.085) | 0.016 (0.065) | 0.014 (0.061) | 0.015 (0.066) |
| 5               | Sinc1  | 0.18 (0.6)  | 0.093 (0.36) | 0.047 (0.17)  | 0.025 (0.11)  | 0.017 (0.069) | 0.014 (0.061) | 0.012 (0.054) | 0.014 (0.063) |
| 5               | Sinc2  | 0.16 (0.64) | 0.084 (0.32) | 0.043 (0.16)  | 0.023 (0.085) | 0.015 (0.064) | 0.011 (0.047) | 0.010 (0.046) | 0.011 (0.049) |
| 5               | Sinc3  | 0.13 (0.51) | 0.088 (0.32) | 0.036 (0.15)  | 0.024 (0.091) | 0.014 (0.053) | 0.01 (0.043)  | 0.009 (0.045) | 0.009 (0.042) |
| 5               | Sinc4  | 0.13 (0.51) | 0.077 (0.28) | 0.034 (0.12)  | 0.021 (0.075) | 0.013 (0.053) | 0.010 (0.044) | 0.008 (0.038) | 0.009 (0.038) |
| 10              | FIR    | 0.27 (1.4)  | 0.14 (0.72)  | 0.076 (0.4)   | 0.042 (0.21)  | 0.029 (0.15)  | 0.023 (0.12)  | 0.023 (0.11)  | 0.022 (0.11)  |
| 10              | Sinc1  | 0.23 (1.1)  | 0.13 (0.57)  | 0.064 (0.3)   | 0.036 (0.19)  | 0.024 (0.13)  | 0.02 (0.1)    | 0.018 (0.083) | 0.018 (0.089) |
| 10              | Sinc2  | 0.2 (0.89)  | 0.11 (0.51)  | 0.054 (0.24)  | 0.03 (0.14)   | 0.019 (0.093) | 0.015 (0.075) | 0.015 (0.079) | 0.016 (0.077) |
| 10              | Sinc3  | 0.18 (0.81) | 0.097 (0.38) | 0.05 (0.22)   | 0.028 (0.14)  | 0.019 (0.088) | 0.015 (0.063) | 0.013 (0.067) | 0.013 (0.065) |
| 10              | Sinc4  | 0.17 (0.68) | 0.099 (0.45) | 0.049 (0.24)  | 0.024 (0.12)  | 0.018 (0.085) | 0.013 (0.063) | 0.012 (0.061) | 0.012 (0.062) |
| 16.6            | Sinc1  | 0.3 (1.4)   | 0.16 (0.81)  | 0.082 (0.43)  | 0.048 (0.25)  | 0.031 (0.17)  | 0.025 (0.15)  | 0.024 (0.12)  | 0.024 (0.14)  |

**Noise Performance (continued)**
**表 1. Noise in  $\mu V_{RMS}$  ( $\mu V_{PP}$ ) at  $T_A = 25^\circ C$  and Internal 2.5-V Reference (continued)**

| DATA RATE (SPS) | FILTER | GAIN        |             |              |              |              |               |               |               |
|-----------------|--------|-------------|-------------|--------------|--------------|--------------|---------------|---------------|---------------|
|                 |        | 1           | 2           | 4            | 8            | 16           | 32            | 64            | 128           |
| 16.6            | Sinc2  | 0.24 (1.2)  | 0.13 (0.64) | 0.067 (0.34) | 0.038 (0.2)  | 0.026 (0.14) | 0.021 (0.11)  | 0.019 (0.099) | 0.019 (0.098) |
| 16.6            | Sinc3  | 0.22 (0.98) | 0.12 (0.64) | 0.065 (0.3)  | 0.036 (0.18) | 0.024 (0.12) | 0.019 (0.095) | 0.017 (0.092) | 0.018 (0.093) |
| 16.6            | Sinc4  | 0.21 (1.1)  | 0.12 (0.53) | 0.06 (0.29)  | 0.035 (0.18) | 0.022 (0.11) | 0.017 (0.084) | 0.016 (0.085) | 0.016 (0.086) |
| 20              | FIR    | 0.37 (2)    | 0.2 (1.1)   | 0.1 (0.56)   | 0.059 (0.34) | 0.041 (0.22) | 0.034 (0.18)  | 0.029 (0.17)  | 0.03 (0.15)   |
| 20              | Sinc1  | 0.32 (1.8)  | 0.18 (0.92) | 0.091 (0.48) | 0.051 (0.26) | 0.034 (0.2)  | 0.028 (0.15)  | 0.025 (0.14)  | 0.025 (0.14)  |
| 20              | Sinc2  | 0.27 (1.4)  | 0.15 (0.77) | 0.073 (0.35) | 0.042 (0.22) | 0.027 (0.14) | 0.022 (0.13)  | 0.021 (0.11)  | 0.02 (0.11)   |
| 20              | Sinc3  | 0.24 (1.2)  | 0.13 (0.64) | 0.069 (0.35) | 0.039 (0.21) | 0.026 (0.14) | 0.02 (0.11)   | 0.018 (0.099) | 0.018 (0.1)   |
| 20              | Sinc4  | 0.23 (1.1)  | 0.13 (0.66) | 0.066 (0.33) | 0.037 (0.19) | 0.024 (0.12) | 0.018 (0.095) | 0.017 (0.095) | 0.017 (0.099) |
| 50              | Sinc1  | 0.49 (2.9)  | 0.27 (1.6)  | 0.14 (0.83)  | 0.08 (0.5)   | 0.053 (0.31) | 0.043 (0.25)  | 0.039 (0.23)  | 0.038 (0.23)  |
| 50              | Sinc2  | 0.4 (2.3)   | 0.22 (1.3)  | 0.11 (0.69)  | 0.064 (0.38) | 0.043 (0.27) | 0.035 (0.22)  | 0.033 (0.2)   | 0.032 (0.2)   |
| 50              | Sinc3  | 0.37 (2.2)  | 0.2 (1.2)   | 0.11 (0.64)  | 0.058 (0.35) | 0.04 (0.25)  | 0.033 (0.19)  | 0.029 (0.18)  | 0.03 (0.18)   |
| 50              | Sinc4  | 0.34 (2)    | 0.19 (1.1)  | 0.098 (0.61) | 0.056 (0.32) | 0.036 (0.23) | 0.03 (0.17)   | 0.028 (0.17)  | 0.028 (0.17)  |
| 60              | Sinc1  | 0.55 (3.3)  | 0.28 (1.9)  | 0.15 (0.88)  | 0.087 (0.53) | 0.058 (0.34) | 0.047 (0.28)  | 0.044 (0.29)  | 0.042 (0.26)  |
| 60              | Sinc2  | 0.45 (2.7)  | 0.24 (1.4)  | 0.12 (0.71)  | 0.07 (0.45)  | 0.048 (0.32) | 0.039 (0.25)  | 0.036 (0.21)  | 0.035 (0.21)  |
| 60              | Sinc3  | 0.41 (2.7)  | 0.21 (1.3)  | 0.11 (0.68)  | 0.065 (0.4)  | 0.044 (0.25) | 0.036 (0.23)  | 0.032 (0.19)  | 0.031 (0.19)  |
| 60              | Sinc4  | 0.37 (2)    | 0.2 (1.1)   | 0.11 (0.6)   | 0.059 (0.36) | 0.041 (0.25) | 0.033 (0.21)  | 0.03 (0.18)   | 0.03 (0.17)   |
| 100             | Sinc1  | 0.69 (4.5)  | 0.37 (2.4)  | 0.19 (1.3)   | 0.11 (0.73)  | 0.075 (0.5)  | 0.06 (0.39)   | 0.056 (0.37)  | 0.056 (0.38)  |
| 100             | Sinc2  | 0.56 (3.5)  | 0.3 (1.9)   | 0.16 (0.97)  | 0.09 (0.55)  | 0.062 (0.39) | 0.051 (0.32)  | 0.046 (0.31)  | 0.045 (0.29)  |
| 100             | Sinc3  | 0.51 (3.4)  | 0.27 (1.8)  | 0.14 (0.9)   | 0.083 (0.51) | 0.056 (0.36) | 0.045 (0.3)   | 0.041 (0.27)  | 0.041 (0.25)  |
| 100             | Sinc4  | 0.48 (3.3)  | 0.26 (1.6)  | 0.14 (0.87)  | 0.078 (0.48) | 0.053 (0.34) | 0.043 (0.27)  | 0.039 (0.24)  | 0.039 (0.26)  |
| 400             | Sinc1  | 1.4 (9.6)   | 0.72 (5.4)  | 0.38 (2.7)   | 0.22 (1.6)   | 0.15 (1.1)   | 0.12 (0.85)   | 0.11 (0.85)   | 0.11 (0.79)   |
| 400             | Sinc2  | 1.1 (8.2)   | 0.58 (4.2)  | 0.31 (2.3)   | 0.18 (1.3)   | 0.12 (0.9)   | 0.099 (0.74)  | 0.091 (0.65)  | 0.091 (0.69)  |
| 400             | Sinc3  | 1 (7.4)     | 0.53 (3.7)  | 0.28 (2)     | 0.17 (1.2)   | 0.11 (0.8)   | 0.09 (0.66)   | 0.083 (0.61)  | 0.083 (0.59)  |
| 400             | Sinc4  | 0.95 (6.9)  | 0.51 (3.6)  | 0.27 (1.9)   | 0.15 (1.2)   | 0.1 (0.7)    | 0.084 (0.58)  | 0.077 (0.55)  | 0.077 (0.57)  |
| 1200            | Sinc1  | 2.3 (17)    | 1.2 (9.2)   | 0.64 (5)     | 0.37 (2.9)   | 0.25 (1.9)   | 0.2 (1.6)     | 0.19 (1.4)    | 0.19 (1.5)    |
| 1200            | Sinc2  | 1.9 (14)    | 1 (7.6)     | 0.54 (3.9)   | 0.31 (2.4)   | 0.21 (1.6)   | 0.17 (1.3)    | 0.16 (1.2)    | 0.16 (1.2)    |
| 1200            | Sinc3  | 1.8 (13)    | 0.92 (7)    | 0.49 (3.7)   | 0.29 (2.2)   | 0.19 (1.4)   | 0.16 (1.2)    | 0.14 (1.1)    | 0.14 (1.1)    |
| 1200            | Sinc4  | 1.6 (12)    | 0.86 (6.4)  | 0.46 (3.6)   | 0.27 (2)     | 0.18 (1.4)   | 0.15 (1.1)    | 0.13 (1)      | 0.13 (1)      |
| 2400            | Sinc1  | 3.2 (25)    | 1.7 (13)    | 0.88 (6.7)   | 0.51 (3.9)   | 0.35 (2.7)   | 0.28 (2.2)    | 0.26 (2)      | 0.26 (2)      |
| 2400            | Sinc2  | 2.7 (21)    | 1.4 (10)    | 0.76 (5.8)   | 0.44 (3.3)   | 0.3 (2.2)    | 0.24 (1.9)    | 0.22 (1.6)    | 0.22 (1.6)    |
| 2400            | Sinc3  | 2.5 (19)    | 1.3 (9.8)   | 0.69 (5.2)   | 0.4 (3)      | 0.27 (2.1)   | 0.22 (1.7)    | 0.2 (1.6)     | 0.2 (1.5)     |
| 2400            | Sinc4  | 2.3 (17)    | 1.2 (9.4)   | 0.65 (4.9)   | 0.37 (2.8)   | 0.25 (2)     | 0.21 (1.5)    | 0.19 (1.5)    | 0.19 (1.4)    |
| 4800            | Sinc1  | 4.3 (33)    | 2.3 (17)    | 1.2 (9.4)    | 0.69 (5.2)   | 0.46 (3.5)   | 0.37 (2.9)    | 0.34 (2.6)    | 0.34 (2.6)    |
| 4800            | Sinc2  | 3.8 (29)    | 2 (15)      | 1.1 (8.5)    | 0.61 (4.7)   | 0.41 (3.1)   | 0.33 (2.6)    | 0.31 (2.3)    | 0.3 (2.3)     |
| 4800            | Sinc3  | 3.5 (27)    | 1.8 (14)    | 0.97 (7.2)   | 0.56 (4.1)   | 0.38 (3)     | 0.31 (2.4)    | 0.28 (2.1)    | 0.28 (2.2)    |
| 4800            | Sinc4  | 3.3 (25)    | 1.7 (13)    | 0.92 (7.1)   | 0.53 (4.1)   | 0.36 (2.7)   | 0.29 (2.2)    | 0.27 (2.1)    | 0.27 (1.9)    |
| 7200            | Sinc1  | 5 (38)      | 2.6 (20)    | 1.4 (10)     | 0.8 (6)      | 0.53 (4)     | 0.43 (3.2)    | 0.39 (2.9)    | 0.39 (2.9)    |
| 7200            | Sinc2  | 4.6 (35)    | 2.4 (19)    | 1.3 (9.9)    | 0.73 (5.4)   | 0.49 (3.8)   | 0.39 (2.9)    | 0.36 (2.8)    | 0.36 (2.7)    |
| 7200            | Sinc3  | 4.3 (33)    | 2.2 (17)    | 1.2 (9.3)    | 0.68 (5)     | 0.46 (3.6)   | 0.37 (2.8)    | 0.34 (2.5)    | 0.34 (2.6)    |
| 7200            | Sinc4  | 4.1 (31)    | 2.1 (15)    | 1.1 (8.8)    | 0.65 (5)     | 0.44 (3.3)   | 0.35 (2.6)    | 0.33 (2.5)    | 0.32 (2.5)    |
| 14400           | Sinc5  | 6 (47)      | 3.1 (24)    | 1.7 (13)     | 0.93 (7.1)   | 0.61 (4.9)   | 0.49 (3.8)    | 0.45 (3.5)    | 0.45 (3.4)    |
| 19200           | Sinc5  | 8.5 (67)    | 4.3 (34)    | 2.3 (17)     | 1.2 (9.6)    | 0.77 (6)     | 0.57 (4.3)    | 0.54 (4)      | 0.53 (4.1)    |
| 25600           | Sinc5  | 19 (140)    | 9.5 (73)    | 4.8 (37)     | 2.5 (18)     | 1.3 (10)     | 0.83 (6.3)    | 0.8 (6)       | 0.81 (6)      |
| 40000           | Sinc5  | 30 (220)    | 15 (110)    | 7.7 (56)     | 3.9 (29)     | 2 (15)       | 1.2 (9.4)     | 1.2 (8.9)     | 1.2 (9)       |

**表 2. Effective Resolution (Noise-Free Resolution) at  $T_A = 25^\circ\text{C}$  and External 5-V Reference**

| DATA<br>RATE<br>(SPS) | FILTER | GAIN        |             |             |             |             |             |             |             |
|-----------------------|--------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|
|                       |        | 1           | 2           | 4           | 8           | 16          | 32          | 64          | 128         |
| 2.5                   | FIR    | 24 (24)     | 24 (22.8)   | 24 (23.8)   | 24 (23.8)   | 24 (23.8)   | 24 (22.8)   | 24 (22)     | 23 (20.8)   |
| 2.5                   | Sinc1  | 24 (24)     | 24 (22.8)   | 24 (23.8)   | 24 (23.8)   | 24 (22.8)   | 24 (22.8)   | 24 (22.4)   | 23.2 (21.2) |
| 2.5                   | Sinc2  | 24 (24)     | 24 (22.8)   | 24 (23.8)   | 22.8 (23.8) | 21.8 (22.8) | 24 (23.8)   | 24 (22.4)   | 23.9 (22)   |
| 2.5                   | Sinc3  | 24 (24)     | 24 (22.8)   | 24 (23.8)   | 22.8 (23.8) | 24 (23.8)   | 24 (23.8)   | 24 (22.4)   | 23.8 (22)   |
| 2.5                   | Sinc4  | 24 (24)     | 24 (22.8)   | 24 (23.8)   | 22.8 (23.8) | 24 (23.8)   | 24 (23.8)   | 24 (23)     | 23.5 (22)   |
| 5                     | FIR    | 24 (23)     | 24 (22.8)   | 24 (23.8)   | 24 (22.8)   | 24 (22.2)   | 24 (21.8)   | 23.6 (21.7) | 22.5 (20.7) |
| 5                     | Sinc1  | 24 (23.7)   | 24 (23.8)   | 24 (23.8)   | 24 (22.8)   | 24 (22.2)   | 24 (22.8)   | 23.3 (21.4) | 22.8 (20.7) |
| 5                     | Sinc2  | 24 (24)     | 24 (23.8)   | 24 (23.8)   | 24 (23.8)   | 24 (23.8)   | 24 (22.8)   | 23.7 (21.7) | 22.8 (21)   |
| 5                     | Sinc3  | 24 (24)     | 24 (23.8)   | 24 (23.8)   | 24 (23.8)   | 24 (23.8)   | 24 (22.8)   | 23.5 (21.4) | 23.5 (21.7) |
| 5                     | Sinc4  | 24 (24)     | 24 (23.8)   | 24 (23.8)   | 22.8 (23.8) | 24 (23.8)   | 24 (23.8)   | 24 (22)     | 23.3 (21.2) |
| 10                    | FIR    | 24 (22.4)   | 24 (22.8)   | 24 (22.8)   | 24 (22.2)   | 24 (21.8)   | 23.5 (21.2) | 22.8 (20.5) | 22.1 (19.9) |
| 10                    | Sinc1  | 24 (23)     | 24 (22.8)   | 24 (22.8)   | 24 (22.8)   | 24 (22.2)   | 23.6 (21.2) | 23.4 (21.2) | 22.3 (19.8) |
| 10                    | Sinc2  | 24 (23)     | 24 (22.8)   | 24 (22.8)   | 24 (22.8)   | 24 (22.2)   | 24 (22.2)   | 23.2 (21.4) | 22.3 (20.2) |
| 10                    | Sinc3  | 24 (24)     | 24 (22.8)   | 24 (23.8)   | 24 (23.8)   | 24 (22.8)   | 24 (22.2)   | 23.3 (21.2) | 22.7 (20.7) |
| 10                    | Sinc4  | 24 (24)     | 24 (22.8)   | 24 (23.8)   | 24 (22.8)   | 24 (22.8)   | 24 (22.2)   | 23.7 (21.4) | 22.9 (20.8) |
| 16.6                  | Sinc1  | 24 (22)     | 24 (21.8)   | 24 (22.2)   | 24 (21.8)   | 23.7 (21.2) | 23.4 (21)   | 22.5 (20.3) | 21.8 (19.6) |
| 16.6                  | Sinc2  | 24 (22.4)   | 24 (22.8)   | 24 (22.2)   | 24 (22.2)   | 24 (21.8)   | 23.7 (21.2) | 23 (20.7)   | 22 (19.5)   |
| 16.6                  | Sinc3  | 24 (23)     | 24 (22.8)   | 24 (22.2)   | 24 (22.8)   | 24 (22.8)   | 23.9 (21.5) | 23.1 (21)   | 22 (19.8)   |
| 16.6                  | Sinc4  | 24 (23)     | 24 (22.8)   | 24 (22.8)   | 24 (22.8)   | 24 (22.2)   | 24 (21.5)   | 23.4 (20.7) | 22.5 (20.1) |
| 20                    | FIR    | 24 (22)     | 23.8 (21.5) | 23.9 (21.8) | 23.9 (21.5) | 23.5 (21)   | 22.9 (20.5) | 22.2 (19.8) | 21.3 (18.7) |
| 20                    | Sinc1  | 24 (22)     | 24 (22.2)   | 24 (21.8)   | 23.9 (21.8) | 23.7 (21.5) | 23.3 (21)   | 22.6 (20.3) | 21.5 (19.2) |
| 20                    | Sinc2  | 24 (23)     | 24 (22.2)   | 24 (22.2)   | 24 (21.8)   | 24 (21.8)   | 23.6 (21.2) | 22.8 (20.3) | 21.9 (19.6) |
| 20                    | Sinc3  | 24 (22.4)   | 24 (22.8)   | 24 (22.2)   | 24 (22.8)   | 24 (21.8)   | 23.7 (21.5) | 23 (20.7)   | 21.9 (19.4) |
| 20                    | Sinc4  | 24 (23)     | 24 (22.8)   | 24 (22.8)   | 24 (22.2)   | 24 (22.2)   | 23.8 (21.2) | 23.1 (20.7) | 22 (19.4)   |
| 50                    | Sinc1  | 23.9 (21.4) | 23.7 (21.5) | 23.7 (21.2) | 23.5 (20.8) | 23.3 (20.6) | 22.6 (20)   | 21.9 (19.3) | 21 (18.6)   |
| 50                    | Sinc2  | 24 (21.7)   | 23.9 (21.5) | 23.8 (21.2) | 23.7 (21.5) | 23.5 (20.8) | 22.9 (20.2) | 22.1 (19.3) | 21.2 (18.8) |
| 50                    | Sinc3  | 24 (22)     | 23.9 (21.5) | 23.9 (21.5) | 23.8 (21)   | 23.6 (21.2) | 23 (20.5)   | 22.3 (19.8) | 21.3 (18.6) |
| 50                    | Sinc4  | 24 (22)     | 24 (21.8)   | 24 (21.8)   | 23.9 (21.5) | 23.7 (21.2) | 23.2 (20.8) | 22.4 (20)   | 21.5 (18.9) |
| 60                    | Sinc1  | 23.7 (21.4) | 23.6 (21)   | 23.6 (21.2) | 23.4 (20.8) | 23.1 (20.5) | 22.5 (19.9) | 21.8 (19.1) | 20.8 (18.2) |
| 60                    | Sinc2  | 24 (21.4)   | 23.8 (21.5) | 23.7 (21.2) | 23.6 (21.2) | 23.4 (20.8) | 22.7 (20.2) | 22.1 (19.3) | 21.2 (18.5) |
| 60                    | Sinc3  | 24 (21.7)   | 23.9 (21.5) | 23.9 (21.5) | 23.7 (21.2) | 23.5 (20.8) | 22.9 (20.5) | 22.2 (19.5) | 21.2 (18.8) |
| 60                    | Sinc4  | 24 (22)     | 24 (21.8)   | 23.9 (21.5) | 23.7 (21.2) | 23.4 (20.6) | 23 (20.2)   | 22.2 (19.5) | 21.2 (18.7) |
| 100                   | Sinc1  | 23.6 (21)   | 23.4 (20.6) | 23.3 (20.5) | 23.1 (20.4) | 22.8 (20)   | 22.1 (19.4) | 21.4 (18.8) | 20.5 (17.7) |
| 100                   | Sinc2  | 23.8 (21)   | 23.6 (21)   | 23.6 (21)   | 23.4 (21)   | 23 (20.2)   | 22.4 (19.7) | 21.7 (19.1) | 20.8 (18)   |
| 100                   | Sinc3  | 23.8 (21.2) | 23.6 (21.2) | 23.6 (21)   | 23.5 (21)   | 23.2 (20.5) | 22.5 (19.9) | 21.8 (19)   | 20.8 (17.9) |
| 100                   | Sinc4  | 23.9 (21.4) | 23.7 (21.2) | 23.7 (21.2) | 23.6 (21)   | 23.3 (20.6) | 22.6 (19.7) | 21.9 (19.4) | 21 (18.1)   |
| 400                   | Sinc1  | 22.8 (19.8) | 22.5 (19.7) | 22.5 (19.6) | 22.3 (19.6) | 21.9 (19)   | 21.2 (18.2) | 20.4 (17.6) | 19.5 (16.6) |
| 400                   | Sinc2  | 23.1 (20.3) | 22.8 (20.1) | 22.8 (20)   | 22.6 (19.6) | 22.1 (19.2) | 21.4 (18.6) | 20.7 (17.9) | 19.8 (17.1) |
| 400                   | Sinc3  | 23.1 (20.4) | 22.9 (20)   | 22.8 (19.9) | 22.7 (20)   | 22.3 (19.4) | 21.5 (18.7) | 20.8 (17.8) | 19.9 (17)   |
| 400                   | Sinc4  | 23.2 (20.3) | 23 (20.2)   | 22.9 (20.1) | 22.7 (20.1) | 22.3 (19.5) | 21.7 (18.9) | 21 (18)     | 20 (17.2)   |
| 1200                  | Sinc1  | 22.1 (19.2) | 21.8 (19.1) | 21.7 (18.9) | 21.6 (18.7) | 21.1 (18.3) | 20.4 (17.5) | 19.7 (16.8) | 18.8 (15.7) |
| 1200                  | Sinc2  | 22.3 (19.5) | 22.1 (19.3) | 22 (19.1)   | 21.8 (18.9) | 21.4 (18.4) | 20.6 (17.7) | 20 (17.1)   | 19 (16)     |
| 1200                  | Sinc3  | 22.4 (19.6) | 22.2 (19.2) | 22.1 (19.2) | 21.9 (19)   | 21.5 (18.5) | 20.8 (18)   | 20.1 (17.2) | 19.2 (16.2) |
| 1200                  | Sinc4  | 22.5 (19.6) | 22.3 (19.6) | 22.2 (19.2) | 22 (19.1)   | 21.6 (18.7) | 20.9 (18)   | 20.2 (17.3) | 19.2 (16.4) |
| 2400                  | Sinc1  | 21.6 (18.7) | 21.4 (18.3) | 21.3 (18.4) | 21.1 (18.1) | 20.7 (17.7) | 19.9 (17.1) | 19.2 (16.2) | 18.3 (15.4) |
| 2400                  | Sinc2  | 21.8 (18.8) | 21.6 (18.6) | 21.5 (18.6) | 21.3 (18.5) | 20.9 (18)   | 20.2 (17.3) | 19.5 (16.6) | 18.5 (15.6) |

**表 2. Effective Resolution (Noise-Free Resolution) at  $T_A = 25^\circ\text{C}$  and External 5-V Reference (continued)**

| DATA<br>RATE<br>(SPS) | FILTER | GAIN        |             |             |             |             |             |             |             |
|-----------------------|--------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|
|                       |        | 1           | 2           | 4           | 8           | 16          | 32          | 64          | 128         |
| 2400                  | Sinc3  | 21.9 (19.1) | 21.7 (18.8) | 21.6 (18.6) | 21.4 (18.6) | 21 (18.1)   | 20.3 (17.5) | 19.6 (16.7) | 18.7 (15.7) |
| 2400                  | Sinc4  | 22 (19.1)   | 21.8 (19)   | 21.8 (19)   | 21.6 (18.6) | 21.1 (18)   | 20.4 (17.5) | 19.7 (16.7) | 18.8 (15.9) |
| 4800                  | Sinc1  | 21.1 (18.1) | 20.9 (17.9) | 20.9 (17.9) | 20.6 (17.7) | 20.2 (17.2) | 19.5 (16.6) | 18.8 (15.8) | 17.9 (14.9) |
| 4800                  | Sinc2  | 21.3 (18.4) | 21.1 (18.1) | 21 (18.1)   | 20.8 (17.9) | 20.4 (17.4) | 19.7 (16.6) | 19 (16.1)   | 18 (14.9)   |
| 4800                  | Sinc3  | 21.4 (18.4) | 21.2 (18.3) | 21.1 (18.3) | 21 (18)     | 20.5 (17.6) | 19.8 (16.8) | 19.1 (16.3) | 18.2 (15.1) |
| 4800                  | Sinc4  | 21.5 (18.6) | 21.3 (18.4) | 21.2 (18.2) | 21.1 (18.1) | 20.6 (17.7) | 19.9 (17)   | 19.2 (16.3) | 18.2 (15.3) |
| 7200                  | Sinc1  | 20.9 (17.8) | 20.7 (17.7) | 20.6 (17.4) | 20.4 (17.5) | 20 (17)     | 19.3 (16.4) | 18.6 (15.7) | 17.7 (14.7) |
| 7200                  | Sinc2  | 21 (18.1)   | 20.8 (17.9) | 20.7 (17.9) | 20.6 (17.6) | 20.2 (17.2) | 19.4 (16.4) | 18.7 (15.9) | 17.8 (14.9) |
| 7200                  | Sinc3  | 21.1 (18.1) | 20.9 (18.1) | 20.8 (17.9) | 20.6 (17.8) | 20.2 (17.2) | 19.5 (16.5) | 18.8 (15.9) | 17.9 (14.9) |
| 7200                  | Sinc4  | 21.2 (18.1) | 21 (18)     | 20.9 (18.1) | 20.7 (18)   | 20.3 (17.2) | 19.6 (16.7) | 18.9 (15.9) | 18 (15)     |
| 14400                 | Sinc5  | 20.5 (17.7) | 20.3 (17.5) | 20.2 (17.3) | 20.1 (17.1) | 19.8 (16.9) | 19.1 (16.1) | 18.4 (15.4) | 17.5 (14.5) |
| 19200                 | Sinc5  | 19.7 (16.8) | 19.5 (16.5) | 19.4 (16.5) | 19.4 (16.3) | 19.2 (16.2) | 18.8 (15.9) | 18 (15.1)   | 17 (14.2)   |
| 25600                 | Sinc5  | 18.2 (15.2) | 18 (14.9)   | 18 (15.2)   | 17.9 (14.7) | 17.9 (15.1) | 17.8 (14.8) | 17 (14.2)   | 16 (13.2)   |
| 40000                 | Sinc5  | 17.4 (14.6) | 17.2 (14.2) | 17.2 (14.2) | 17.2 (14.3) | 17.2 (14.2) | 17.1 (14.3) | 16.3 (13.4) | 15.3 (12.5) |

## 10 Detailed Description

### 10.1 Overview

The ADS1260 and ADS1261 are 5-channel and 10-channel, precision 24-bit, delta-sigma ( $\Delta\Sigma$ ) ADCs with an integrated analog front end (AFE) and voltage reference. The low-noise and low-drift architecture make the ADCs suitable for precision measurement of low signal level sensors, such as strain-gauge bridges, pressure transducers and temperature sensors.

Key features of the ADC are:

- Very low noise, 1-G $\Omega$  input impedance PGA
- High-precision, 24-bit  $\Delta\Sigma$  ADC
- Internal oscillator
- 2.5-V voltage reference
- Signal and voltage reference monitors
- Excitation current sources
- Input level-shift voltage
- Sensor burn-out current sources
- Temperature sensor
- Cyclic redundancy check (CRC) communication error detection
- Two voltage reference inputs ( ADS1261)
- Four GPIO with AC-excitation ( ADS1261)

The analog inputs (AINx) connect to the input multiplexer (MUX). The ADC supports three (five) differential or five (ten) single-ended input configurations for the ADS1260 and ADS1261, respectively.

The programmable gain amplifier (PGA) follows the input multiplexer. The PGA is suitable for direct connection to low-level sensors. The gain is programmable from 1 to 128. The PGA bypass option connects the analog inputs directly to the precharge buffered modulator, extending the input voltage range to the power supplies. The PGA output connects to pins CAPP and CAPN. The ADC antialias filter is provided at the PGA output with an external capacitor.

The PGA is monitored to verify linear operation. Alarm bits in the status register set if the linear range of the PGA is exceeded.

A delta-sigma modulator measures the input voltage relative to the reference voltage to produce the 24-bit conversion result. The differential input range of the ADC is  $\pm V_{REF} / \text{Gain}$ .

The digital filter averages and decimates the modulator output data to yield the final, down-sampled conversion result. The sinc filter is programmable (sinc1 through sinc5) allowing optimization of conversion time, conversion noise and line-cycle rejection. The finite impulse response (FIR) filter mode provides single-cycle settled data with simultaneous rejection of 50-Hz and 60-Hz at data rates of 20 SPS or less.

The ADC reference is either 2.5-V internal, external or the 5-V analog power supply. The REFOUT pin provides the buffered reference voltage output. The external reference is monitored for low or missing voltage. The ADS1261 provides two voltage reference inputs, multiplexed with the analog inputs.

The ADC includes two current sources that provide excitation to resistive sensors (RTD). Additionally, the ADS1261 provides four GPIO control lines. The GPIOs are used for input and output of general-purpose logic signals, as well as providing drive signals for AC-excited bridges. The GPIOs are multiplexed to the analog inputs.

The temperature sensor and the power supply voltages are read through the multiplexer. The programmable burn-out test currents connect to the multiplexer output. The currents detect failed sensors or faults in the sensor connection. The level-shift voltage on AINCOM provides the bias for floating sensors.

The SPI-compatible serial interface is used to read the conversion data and also to configure and control the ADC. Data communication errors are detected by CRC. The serial interface consists of four signals:  $\overline{CS}$ , SCLK, DIN and DOUT/ $\overline{DRDY}$ . The dual function DOUT/ $\overline{DRDY}$  provides data output and also the data ready signal. The ADC serial interface can be implemented with as little as three pins by tying  $\overline{CS}$  low.

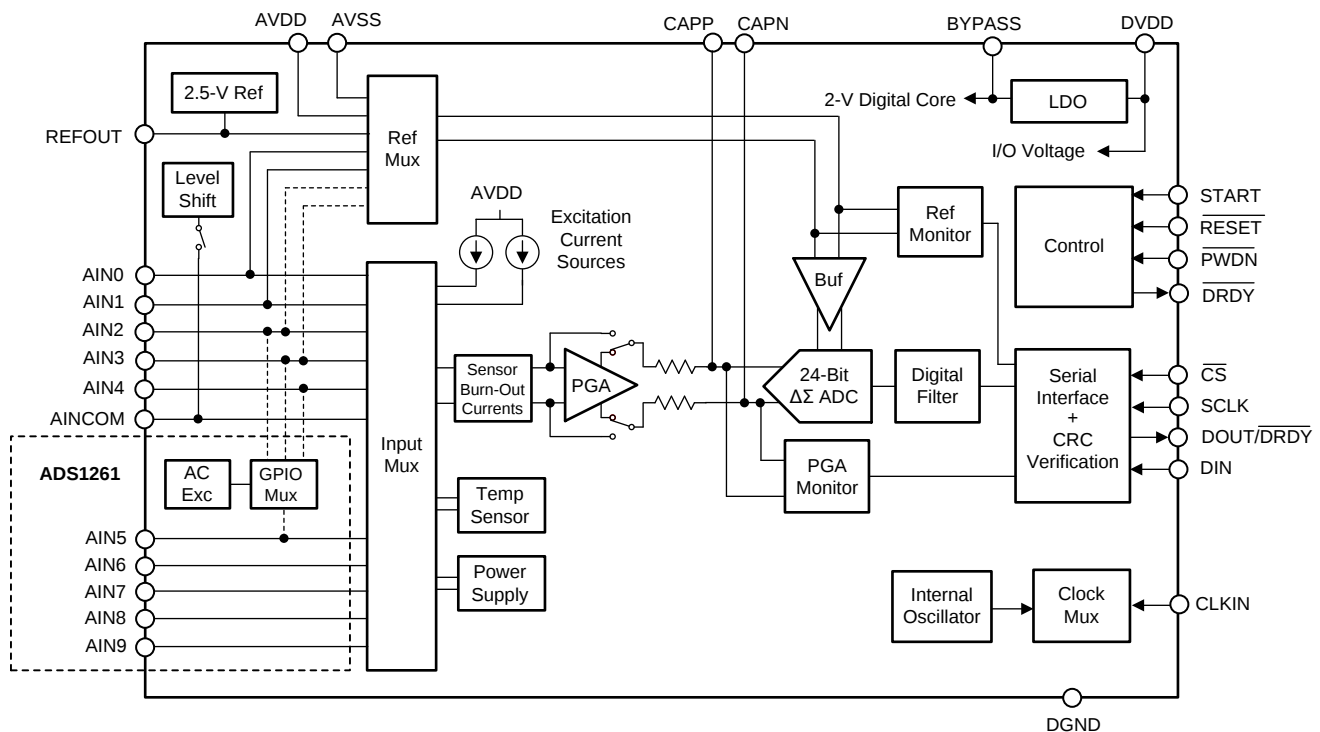
## Overview (continued)

The ADC clock is either internal or external. The ADC detects the external clock automatically. The nominal clock frequency is 7.3728 MHz (10.24 MHz for 40-kSPS operation).

ADC conversions are controlled by the START pin or by the START command. The ADC is programmable for continuous or one-shot conversions. The DRDY or DOUT/DRDY pin provides the conversion data ready signal. When taken low, the RESET pin resets the ADC. The ADC is powered down by the PWDN pin or is powered down in software mode.

The ADC operates in either bipolar analog supply configuration ( $\pm 2.5$  V), or in a single 5-V supply configuration. The digital power supply range is 2.7 V to 5 V. The BYPASS pin is the internal subregulator output used for the ADC digital core.

## 10.2 Functional Block Diagram



## 10.3 Feature Description

The following sections describe the functional blocks of the ADC.

### 10.3.1 Analog Inputs

Figure 48 shows the analog input circuit consist of ESD-protection diodes, the input multiplexer and sensor burn-out current sources. The ADS1260 has six analog inputs to support five single-ended measurement channels. The ADS1261 has 11 analog inputs to support 10 single-ended measurement channels. Both devices have four internal (system) measurements, and an option where no inputs are connected.

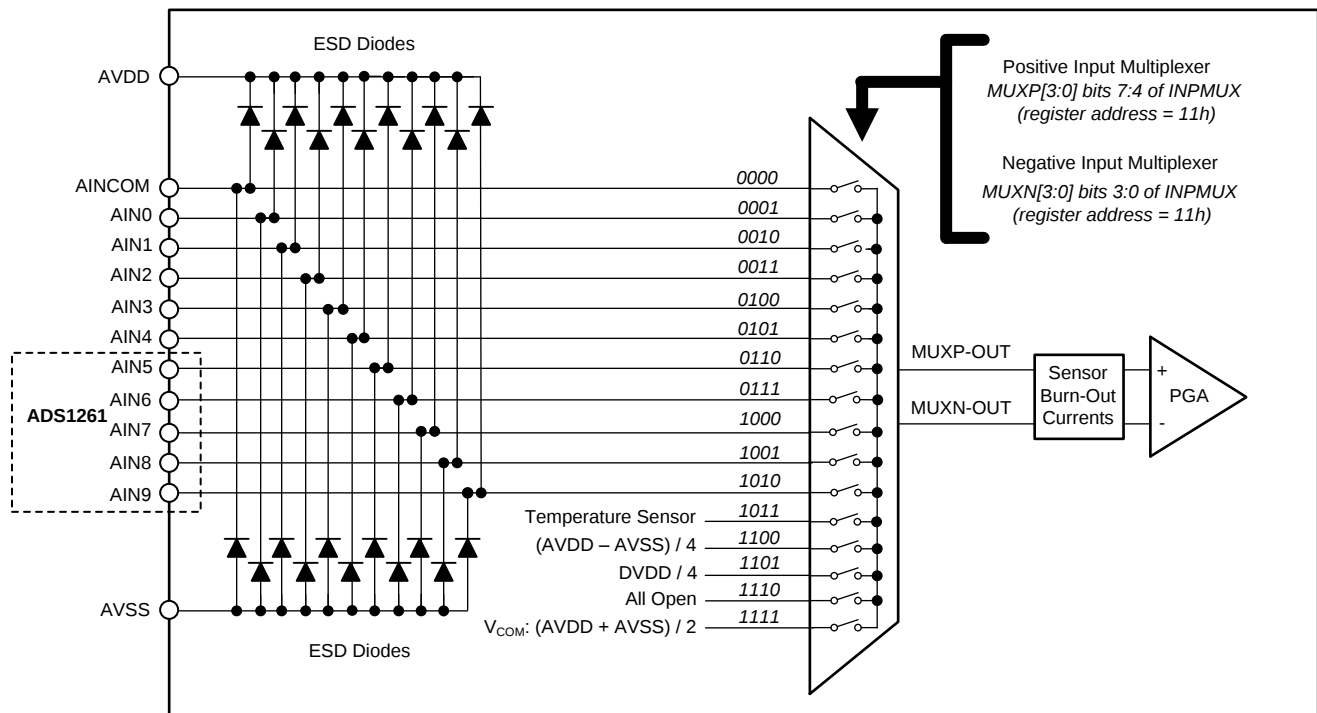


Figure 48. Analog Input Block Diagram

#### 10.3.1.1 ESD Diodes

ESD diodes are incorporated to protect the ADC inputs from possible ESD events occurring during the manufacturing process and during PCB assembly when manufactured in an ESD-controlled environment. For system-level ESD protection, consider the use of external ESD protection devices for pins that are exposed to ESD, including the analog inputs.

If either input is driven below  $AVSS - 0.3\text{ V}$ , or above  $AVDD + 0.3\text{ V}$ , the internal protection diodes may conduct. If these conditions are possible, use external clamp diodes, series resistors, or both to limit the input current to the specified maximum value.

#### 10.3.1.2 Input Multiplexer

The input multiplexer selects the signal for measurement. The multiplexer consists of independent positive and negative sections. See Figure 48 for multiplexer register settings. The multiplexers select any input as positive and any input as negative for the PGA. Because the level-shift voltage connects to AINCOM (only), AINCOM is suitable as the common input for single-ended signals that require a level-shift voltage.

The switching sequence of the multiplexer is break-before-make in order to reduce charge injection into the next measurement channel. Be aware that over-driving unused channels beyond the power supplies can effect conversions taking place on active channels. See the [Input Overload](#) section for more information.

## Feature Description (continued)

### 10.3.1.3 Temperature Sensor

The ADC has an internal temperature sensor. The temperature sensor is comprised of two internal diodes with one diode having 80 times the current density of the other. The difference in current density of the diodes yields a differential output voltage that is proportional to absolute temperature. The temperature sensor reading is converted by the ADC. See [Figure 48](#) for register settings to select the temperature sensor for measurement.

[Equation 2](#) shows how to convert the temperature sensor reading to degrees Celsius (°C):

$$\text{Temperature (}^{\circ}\text{C)} = [(\text{Temperature Reading (}\mu\text{V)} - 122,400) / 420 \mu\text{V/}^{\circ}\text{C}] + 25^{\circ}\text{C} \quad (2)$$

Measure the temperature sensor with PGA on, gain = 1, burn-out current sources disabled and AC-excitation mode disabled. As a result of the low package-to-PCB thermal resistance, the internal temperature closely tracks the PCB temperature. Be aware that device self-heating increases the internal temperature relative to the surrounding PCB.

### 10.3.1.4 Power-Supply Readback

Read the power-supply voltage by the appropriate input multiplexer selection. The supply voltages are divided to reduce the voltage levels to within the ADC input range. The analog and digital supply readback levels are scaled by [Equation 3](#) and [Equation 4](#), respectively:

$$\text{Analog supply (V)} = (\text{AVDD} - \text{AVSS}) / 4 \quad (3)$$

$$\text{Digital supply (V)} = \text{DVDD} / 4 \quad (4)$$

Measure the power supply voltages with either the internal or an external reference. If using an external reference, the minimum reference voltage is 1.5 V. Perform the measurement with PGA enabled, gain = 1, burn-out current sources disabled and AC-excitation mode disabled. See [Figure 48](#) for register settings to measure the supply voltages.

### 10.3.1.5 Inputs Open

This configuration opens all inputs. Use this configuration to test the functionality of the sensor burn-out current sources, and the PGA output monitors. When the inputs are open, the current sources drive the PGA inputs to full scale, resulting in an PGA monitor alarm and clipped conversion data. See [Figure 48](#) for register settings to open all inputs.

### 10.3.1.6 Internal $V_{\text{COM}}$ Connection

For this multiplexer configuration, all inputs are open and the PGA inputs are connected to an internal  $V_{\text{COM}}$  voltage as defined:  $(\text{AVDD} + \text{AVSS}) / 2$ . Use this mode to measure the ADC noise performance and offset voltage, or to short the inputs for offset calibration. See [Figure 48](#) for register settings of the internal  $V_{\text{COM}}$  connection.

## Feature Description (continued)

### 10.3.1.7 Alternate Functions

The ADC has several alternate functions that are multiplexed with the analog inputs. The alternate functions are reference input, current source output, GPIO, AC-excitation and level-shift voltage output. The functions are enabled by programming of the associated registers. The analog inputs retain measurement ability if the alternate functions are programmed. 表 3 summarizes the alternate functions.

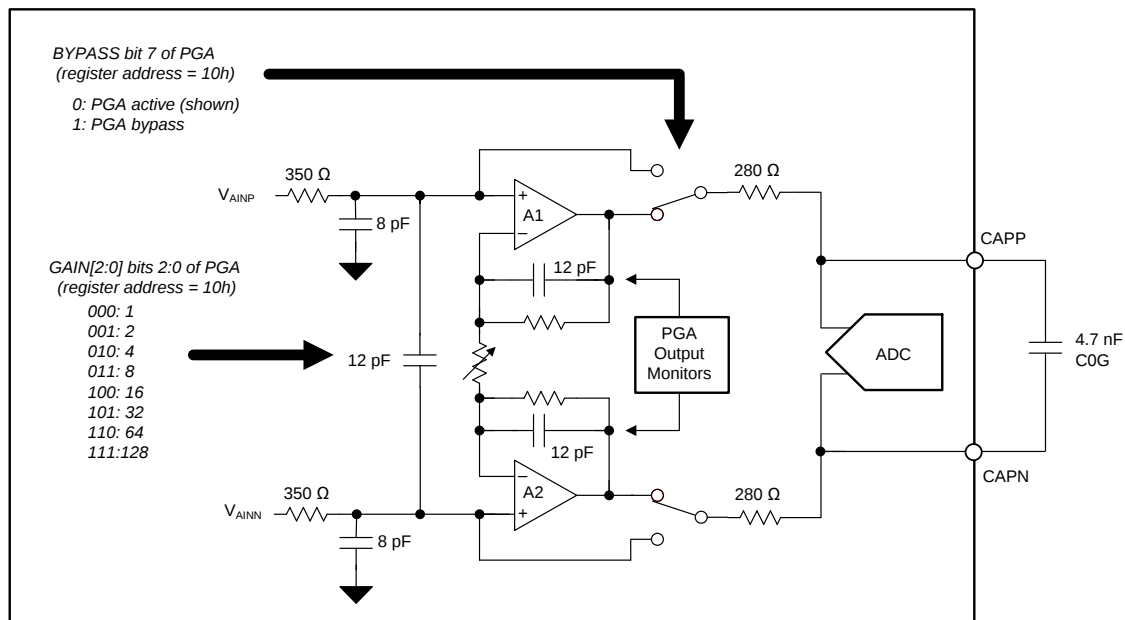
**表 3. Analog Input Alternate Functions**

| ANALOG INPUTS |         | REFERENCE INPUTS     | CURRENT SOURCES | GPIO/AC-EXCITATION <sup>(1)</sup> | LEVEL-SHIFT VOLTAGE |
|---------------|---------|----------------------|-----------------|-----------------------------------|---------------------|
| ADS1260       | ADS1261 |                      |                 |                                   |                     |
| AINCOM        | AINCOM  | —                    | Yes             | —                                 | Yes                 |
| AIN0          | AIN0    | REFP0                | Yes             | —                                 | —                   |
| AIN1          | AIN1    | REFN0                | Yes             | —                                 | —                   |
| AIN2          | AIN2    | REFP1 <sup>(1)</sup> | Yes             | GPIO0/ACX1                        | —                   |
| AIN3          | AIN3    | REFN1 <sup>(1)</sup> | Yes             | GPIO1/ACX2                        | —                   |
| AIN4          | AIN4    | —                    | Yes             | GPIO2/ACX1                        | —                   |
| —             | AIN5    | —                    | Yes             | GPIO3/ACX2                        | —                   |
| —             | AIN6    | —                    | Yes             | —                                 | —                   |
| —             | AIN7    | —                    | Yes             | —                                 | —                   |
| —             | AIN8    | —                    | Yes             | —                                 | —                   |
| —             | AIN9    | —                    | Yes             | —                                 | —                   |

(1) ADS1261 and ADS1261B only.

### 10.3.2 PGA

The PGA is a low-noise, CMOS differential-input, differential-output amplifier. The PGA extends the dynamic range of the ADC, important when used with low level sensors. The PGA provides gains of 1 through 32 and the ADC provides additional gains of 2 and 4. The combined gains are 1 through 128. Gain is controlled by the GAIN[2:0] register bits as shown in 图 49. In PGA bypass mode, the input voltage range extends to the analog supplies. The PGA is powered down in bypass mode.



**图 49. PGA Block Diagram**

The PGA consists of two chopper-stabilized amplifiers (A1 and A2), and a resistor network that determines the PGA gain. The resistor network is precision matched, providing low drift performance. The PGA integrates noise filters to reduce sensitivity to electromagnetic-interference (EMI). The PGA output is monitored to indicate when the operating headroom is exceeded.

Pins CAPP and CAPN are the PGA positive and negative outputs, respectively. Connect an external 4.7-nF capacitor (type C0G) as shown in [图 49](#). The capacitor filters the modulator sample pulses and with the internal resistors, forms the antialias filter. Place the capacitor as close as possible to the pins using short traces. Avoid running clock traces or other digital traces close to these pins.

The full-scale differential input voltage range of the ADC is determined by the reference voltage and gain. [表 4](#) shows the differential input voltage range versus gain for  $V_{REF} = 2.5$  V.

**表 4. Full-Scale Voltage Range**

| GAIN[2:0] BITS | GAIN | FULL-SCALE DIFFERENTIAL INPUT RANGE <sup>(1)</sup> |
|----------------|------|----------------------------------------------------|
| 000            | 1    | ±2.500 V                                           |
| 001            | 2    | ±1.250 V                                           |
| 010            | 4    | ±0.625 V                                           |
| 011            | 8    | ±0.312 V                                           |
| 100            | 16   | ±0.156 V                                           |
| 101            | 32   | ±0.078 V                                           |
| 110            | 64   | ±0.039 V                                           |
| 111            | 128  | ±0.0195 V                                          |

(1)  $V_{REF} = 2.5$  V. Full scale differential input voltage range is proportional to  $V_{REF}$ .

As with many amplifiers, the PGA has an input voltage range limitation that must not be exceeded in order to maintain linear operation. The specified input voltage range is expressed as the absolute voltage at the positive and negative inputs. As specified in [式 5](#), the specified absolute input voltage depends on gain, the expected maximum differential voltage, and the minimum analog power-supply voltage.

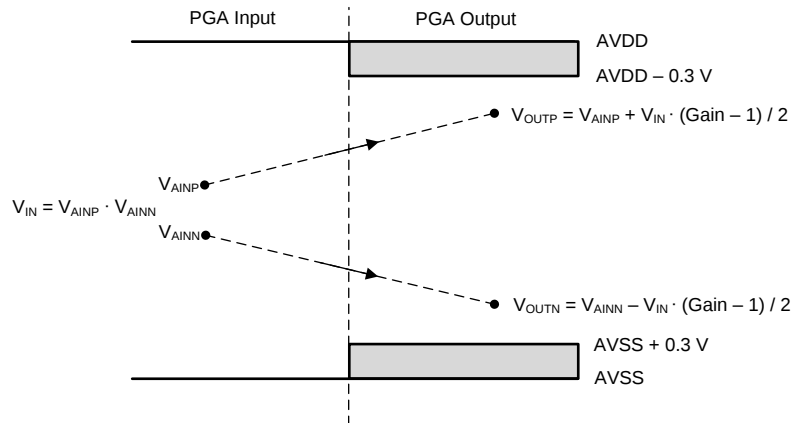
$$AVSS + 0.3 \text{ V} + V_{IN} \cdot (\text{Gain} - 1) / 2 < V_{AINP} \text{ and } V_{AINN} < AVDD - 0.3 \text{ V} - V_{IN} \cdot (\text{Gain} - 1) / 2$$

where

- $V_{AINP}$ ,  $V_{AINN}$  = absolute input voltage
- $V_{IN}$  = maximum differential input voltage =  $V_{AINP} - V_{AINN}$
- Gain (for gains = 64 and 128, use gain = 32 in the calculation)
- AVDD = minimum AVDD voltage
- AVSS = maximum AVSS voltage

(5)

The relationship of the PGA input to the PGA output is shown graphically in [Figure 50](#). The PGA output voltages ( $V_{OUTP}$ ,  $V_{OUTN}$ ) depend on the respective absolute input voltage, the differential input voltage, and the PGA gain. To maintain the PGA within the linear operating range, the PGA output voltages must not exceed either  $AVDD - 0.3\text{ V}$  or  $AVSS + 0.3\text{ V}$ . The diagram depicts a positive differential input voltage that results in a positive differential output voltage.



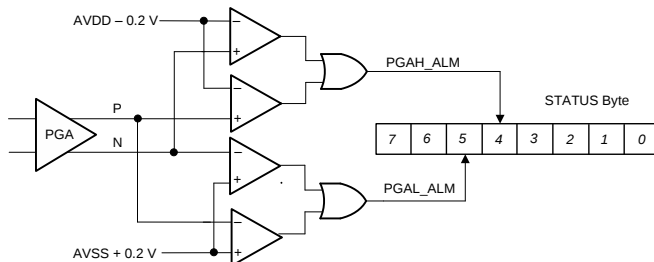
**Figure 50. PGA Input/Output Range**

### 10.3.2.1 PGA Bypass Mode

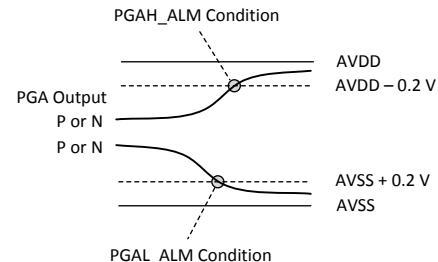
Bypass the PGA to extend the input voltage range up to the analog power supply voltages. In bypass mode, the PGA is bypassed and the analog inputs are connected directly to the precharge buffers of the modulator, thereby extending the input voltage range. Be aware of the increased analog input current in bypass mode. See the [Recommended Operating Conditions](#) for the bypass-mode input voltage range specification, and see the [Electrical Characteristics](#) for the input current specification.

### 10.3.2.2 PGA Voltage Monitor

The PGA has voltage monitors to provide indication when the PGA is overloaded. In overload condition, the conversion data are no longer valid. If either the PGA positive or negative output exceeds  $AVDD - 0.2\text{ V}$ , the high alarm bit is set (PGAH\_ALM). Similarly, if either PGA positive or negative output is less than  $AVSS + 0.2\text{ V}$ , the low alarm bit is set (PGAL\_ALM). The monitor alarm state is read in the STATUS byte. The monitor alarm is read-only and automatically resets at the start of the next conversion cycle after the overload condition is cleared. The monitor diagram and threshold values are shown in [Figure 51](#) and [Figure 52](#).



**Figure 51. PGA Monitor Diagram**

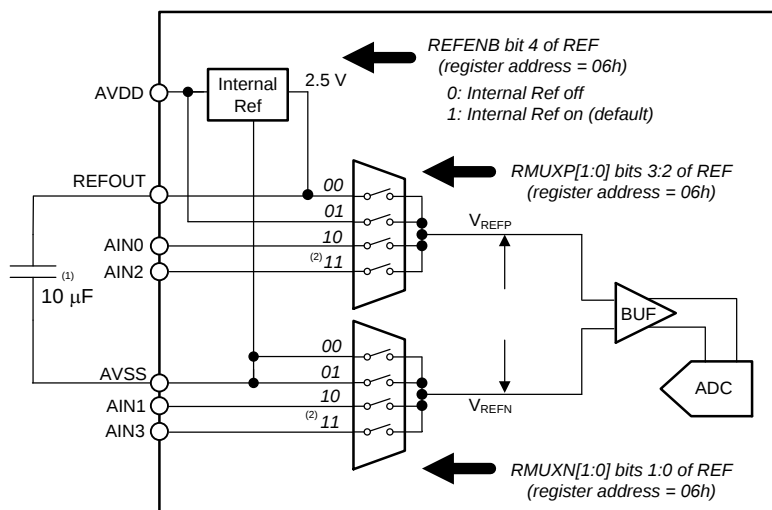


**Figure 52. PGA Monitor Thresholds**

The PGA monitors consist of fast-responding voltage comparators. Comparator operation is disabled during multiplexer changes to minimize the false triggering during these input switching events. However, it is possible the monitors can detect other transient overload conditions that may occur after gain changes, sensor connection changes, and so on.

### 10.3.3 Reference Voltage

The ADC requires a reference voltage for operation. The reference voltage options are 2.5-V internal, one or two external inputs (ADS1260 or ADS1261, respectively) or the 5-V analog power supply. The reference voltage is selected by independent positive and negative reference multiplexers for the reference positive and reference negative voltages, respectively. The default reference is the 5-V analog power supply (AVDD – AVSS). [Figure 53](#) shows the block diagram of the reference multiplexer.



- (1) The internal reference requires a 10-µF capacitor connected to pins REFOUT and AVSS.
- (2) ADS1261 only.

**Figure 53. Reference Input Diagram**

Program the RMUXP[1:0] and RMUXN[1:0] bits of the REF register to select the positive and negative reference voltages, respectively. The positive reference selections are internal positive, AIN0, AIN2, or AVDD. The negative reference input selections are internal negative, AIN1, AIN3, or AVSS. The reference low-voltage monitor is located after the reference multiplexer. See the [Reference Monitor](#) section for more information.

#### 10.3.3.1 Internal Reference

The ADC incorporates a 2.5-V reference that is enabled by the REFENB bit of the REF register (default = off). Program the reference multiplexer bits RMUXP[1:0] and RMUXN[1:0] to 00b to select the internal reference. A 10-µF capacitor is required between pins REFOUT and AVSS to filter reference noise. REFOUT is the reference output and AVSS is the reference return. Use a star-layout connection or plane connection for the reference return, connecting close to the AVSS pin. When the reference is enabled, be aware of the settling time before beginning conversions. Also be aware of the reference inrush current that may result in a transient droop of the AVDD voltage. Enable the internal reference for sensor excitation current source operation.

#### 10.3.3.2 External Reference

Use an external reference by applying the reference voltage to the designated analog inputs. The reference inputs are differential with positive and negative inputs. Program the reference multiplexer bits RMUXP[1:0] and RMUXN[1:0] to 10b or 11b to select inputs AIN0/AIN1 or AIN2/AIN3, respectively (AIN2/AIN3 is available only for the ADS1261). For application that use multiple references, it is possible to connect the reference grounds together and use a single input pin for ground. Follow the specified absolute and differential reference voltage operating conditions, as specified in the [Recommended Operating Conditions](#). Connect a 100-nF capacitor across the reference input pins to filter noise. Be aware of the reference input current if reference impedances are present. Consider the error to the overall system accuracy.

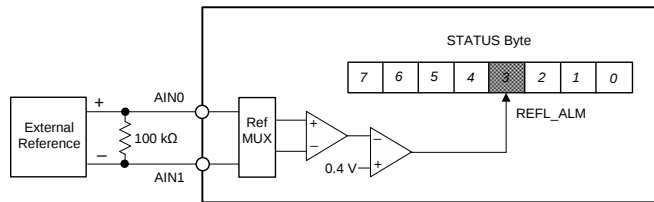
### 10.3.3.3 AVDD - AVSS Reference (Default)

A third reference option is the 5-V analog power supply (AVDD - AVSS). Select this reference option by setting the reference multiplexer bits RMUXP[1:0] and RMUXN[1:0] to 01b. For a 6-wire load cell application that uses excitation sense lines, or for AC-excitation operation, connect the excitation sense lines to the analog input reference inputs and program the ADC for external reference operation.

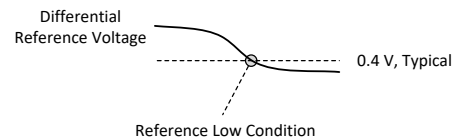
### 10.3.3.4 Reference Monitor

The ADC incorporates a reference monitor that detects an invalid reference voltage. As shown in [Figure 54](#) and [Figure 55](#), if the reference voltage ( $V_{REF} = V_{REFP} - V_{REFN}$ ) is below 0.4 V, the REFL\_ALM bit is set in the STATUS byte. The alarm is read-only and resets at the next conversion after the low reference condition is cleared.

Use the reference monitor to detect a missing or failed reference voltage. To implement detection of a missing reference, use a 100-k $\Omega$  resistor across the reference inputs. If either input is unconnected, the resistor biases the differential reference input towards 0 V so that the missing reference can be detected.



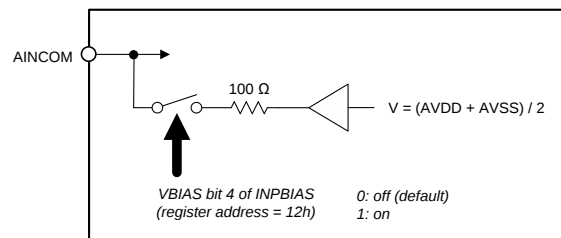
**Figure 54. Reference Monitor**



**Figure 55. Reference Monitor Threshold**

### 10.3.4 Level-Shift Voltage (VBIAS)

The ADC integrates a level-shift voltage that can be connected to the AINCOM pin by an internal switch. As shown in [Figure 56](#), the level-shift voltage is the mid-voltage between AVDD and AVSS. The purpose of the voltage is to shift the signal level of floating sensors to within the input range of the ADC. Isolated thermocouples and piezoelectric sensors are examples of sensors that are suitable for connection to the level-shift voltage. For these sensors, connect the negative lead to the AINCOM pin and enable the level-shift voltage.



**Figure 56. Level-Shift Voltage Diagram**

The turn-on time of the level-shift voltage depends on the total external capacitance connected from the AINCOM pin to ground or AVSS. [Table 5](#) lists the level-shift voltage settling times for various load capacitance. Be certain the level-shift voltage is fully settled before starting a conversion.

**Table 5. Level-Shift Enable Time**

| LOAD CAPACITANCE | LEVEL-SHIFT VOLTAGE SETTLING TIME |
|------------------|-----------------------------------|
| 0.1 $\mu$ F      | 0.22 ms                           |
| 1 $\mu$ F        | 2.2 ms                            |
| 10 $\mu$ F       | 22 ms                             |

### 10.3.5 Burn-Out Current Sources

The burn-out current sources are used to detect the occurrence of sensor burn-out or break. If the sensor or sensor connection is open, the currents drive either or both positive and negative PGA inputs to opposite supply voltages where the occurrence of an open sensor is detected by the PGA monitors or detected by the host for out-of-range (or clipped) conversion data.

Figure 57 shows the burn-out currents connect at the output of the analog input multiplexer. The currents sink and source, and are configurable in pullup or pulldown mode. In pullup mode, the sourcing current connects to the positive input channel and the sinking current connects to the negative input channel. In this configuration, an open circuit pulls the inputs to positive full scale. The currents are Off, 0.050  $\mu\text{A}$ , 0.2  $\mu\text{A}$ , 1  $\mu\text{A}$ , and 10  $\mu\text{A}$ . See the [Burn-Out Current Source](#) section for application information.

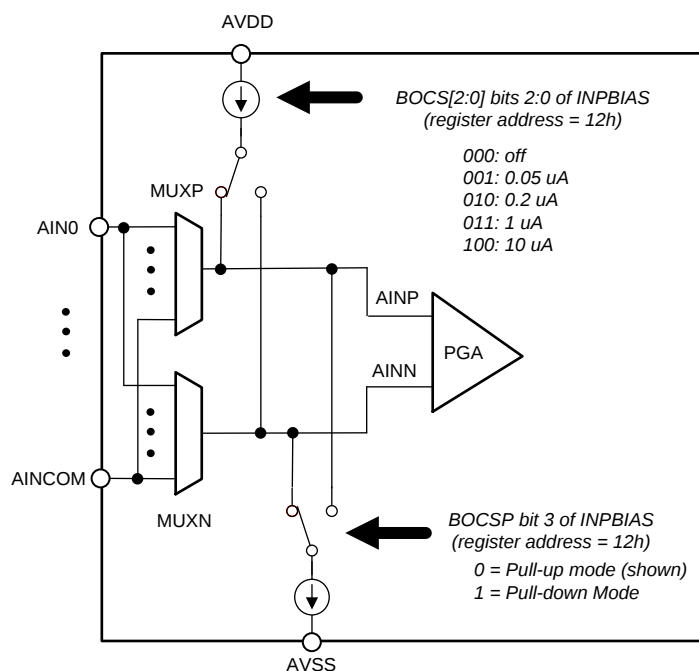
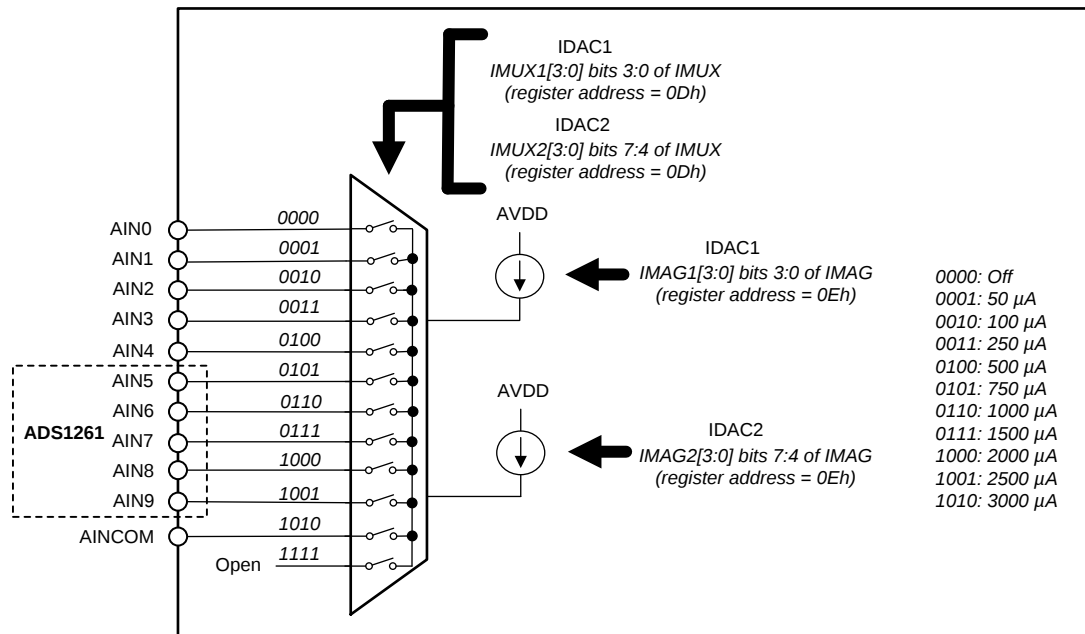


Figure 57. Burn-Out Current Sources

### 10.3.6 Sensor-Excitation Current Sources (IDAC1 and IDAC2)

The ADC incorporates two current sources that are used to provide excitation current to a resistive temperature device (RTD), thermistor, diode and other sensor type that require constant current biasing. The currents are programmable over the 50  $\mu$ A to 3000  $\mu$ A range and are internally multiplexed to all analog input pins. The current source multiplexer is shown in [Figure 58](#). The IMUX1 and IMUX2 register bits connect the corresponding current source to the analog inputs. The IMAG1 and IMAG2 register bits program the corresponding current magnitude.

Enable the internal reference for current source operation. The current source value can be doubled or an intermediate value produced by connecting the current sources to the same analog input. Take care not to exceed the current source compliance voltage range. That is, when the current source is loaded by resistance, the voltage at the pin increases and must not exceed specification; otherwise the specified current source accuracy is not met.

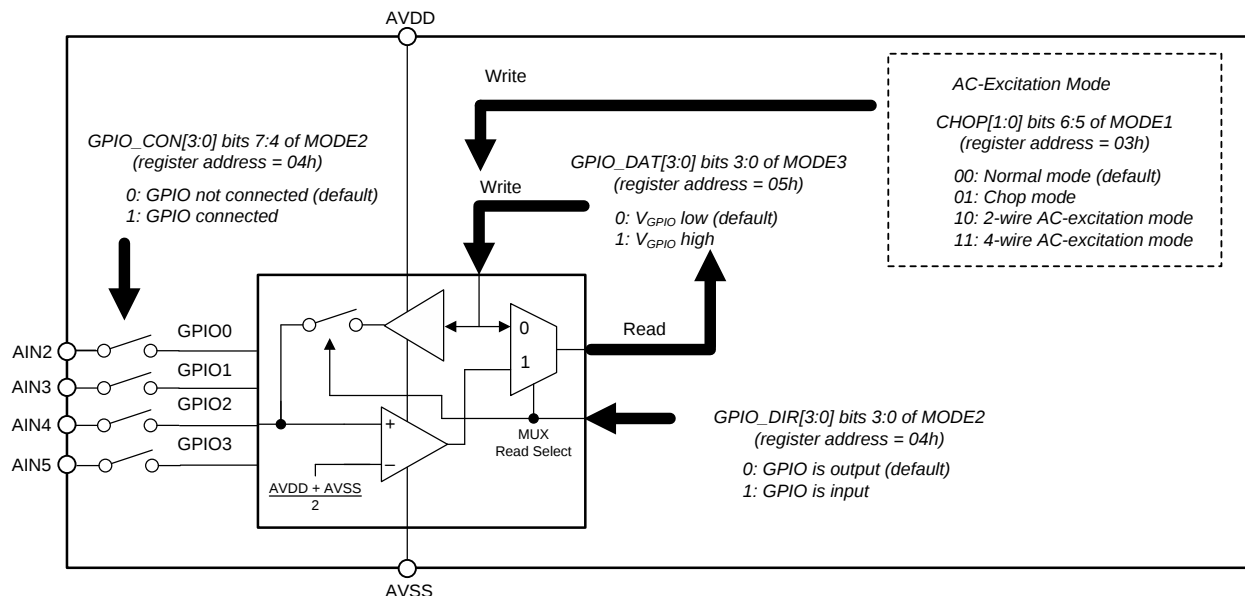


**Figure 58. Current Source Connection**

### 10.3.7 General-Purpose Input/Outputs (GPIOs)

The ADS1261 and ADS1261B devices provide four GPIO pins, GPIO0 through GPIO3. The GPIOs are digital inputs/outputs that are referenced to analog AVDD and AVSS. The GPIOs are read and written by the GPIO\_DAT bits of register MODE3. The GPIOs are multiplexed with analog inputs AIN2 to AIN5. As shown in [Figure 59](#), the GPIOs have a series of programming registers. Bits GPIO\_CON[3:0] connect the GPIOs to the associated pin (1 = connect). Bits GPIO\_DIR program the direction of the GPIOs; (0 = output, 1 = input). The input voltage threshold is the voltage value between AVDD and AVSS. Bits GPIO\_DAT[3:0] are the data values for the GPIOs. Observe that if a GPIO pin is programmed as an output, the value read is the value previously written to the register data, not the actual state of the pin.

The GPIOs also provide the AC-excitation drive signals. AC-excitation mode override the GPIO register data values. See the [AC-Excitation Mode](#) section for details.



**Figure 59. GPIO Block Diagram**

### 10.3.8 Oversampling

The ADC operates on the principle of oversampling, defined as the ratio of the sample rate of the modulator to that of the ADC output data rate. Oversampling improves ADC noise by digital bandwidth limiting (low-pass filtering) of the data. The digital filter also performs data rate reduction (decimation) in order to reduce the data rate proportional with the amount of data filtering.

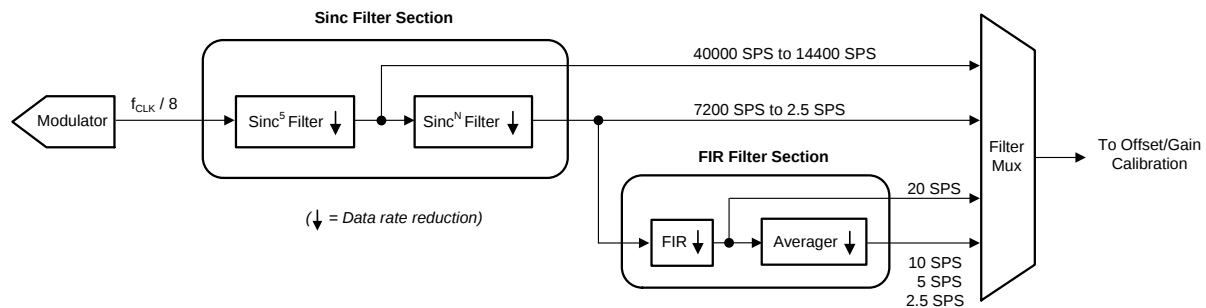
### 10.3.9 Modulator

The modulator is an inherently stable, fourth-order,  $2 + 2$  pipelined  $\Delta\Sigma$  modulator. The modulator samples the analog input voltage at a high sample rate ( $f_{MOD} = f_{CLK} / 8$ ) and converts the analog input to a ones-density bit-stream given by the ratio of the input signal to the reference voltage. The modulator shapes the noise of the converter to high frequency, where the noise is removed by the digital filter.

### 10.3.10 Digital Filter

The digital filter receives the modulator output data and produces a high-resolution conversion result. The digital filter low-pass filters and decimates the modulator data (data rate reduction), yielding the final data output. By adjusting the type of filtering, tradeoffs are made between resolution, data throughput and line cycle rejection.

The digital filter has two selectable modes:  $\sin(x)/x$  (sinc) mode and finite impulse response (FIR) mode (see [Figure 60](#)). The sinc mode provides data rates of 2.5 SPS through 40000 SPS with variable sinc orders of 1 through 5. The FIR filter provides simultaneous rejection of 50-Hz and 60-Hz frequencies with data rates 2.5 SPS through 20 SPS while providing single-cycle settled conversions.



**Figure 60. Digital Filter Block Diagram**

#### 10.3.10.1 Sinc Filter

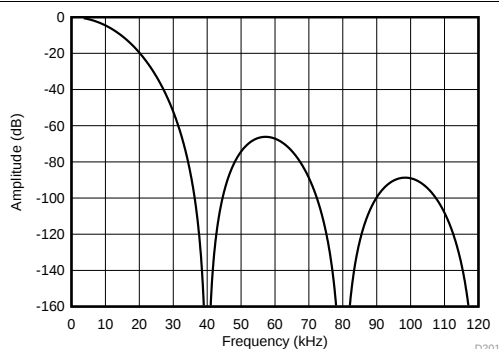
The sinc filter is composed of two stages: a variable-decimation sinc5 filter, followed by a variable-decimation, variable-order sinc filter. The first stage filters and down-samples the modulator data to yield data rates of 40000 SPS, 25600 SPS, 19200 SPS, and 14400 SPS. These data rates bypass the second stage and as a result have a sinc5 characteristic filter response. The second stage receives data from the first stage at a fixed rate of 14400 SPS. The data rate is reduced to the range 7200 SPS to 2.5 SPS, with programmable orders of sinc.

The data rate is programmed by the DR[4:0] bits of register MODE0. The filter mode is programmed by the FILTER[2:0] bits of register MODE0 (see [Table 32](#)).

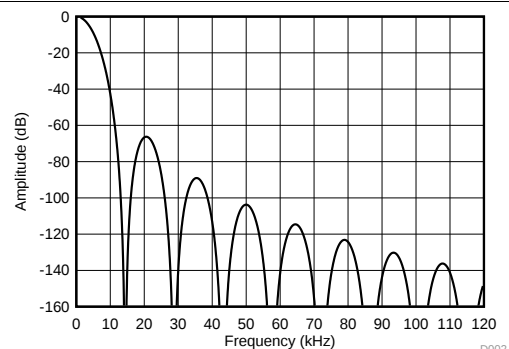
##### 10.3.10.1.1 Sinc Filter Frequency Response

The characteristic of the sinc filter is low pass. The filter reduces noise present in the signal and noise present within the ADC. Changing the data rate and filter order changes the filter bandwidth.

As shown in [Figure 61](#) and [Figure 62](#), the first-stage sinc5 filter has frequency response nulls occurring at  $N \cdot f_{DATA}$ , where  $N = 1, 2, 3$  and so on. At the null frequencies, the filter has zero gain. Data rates of 25600 SPS and 19200 SPS have similar frequency response.

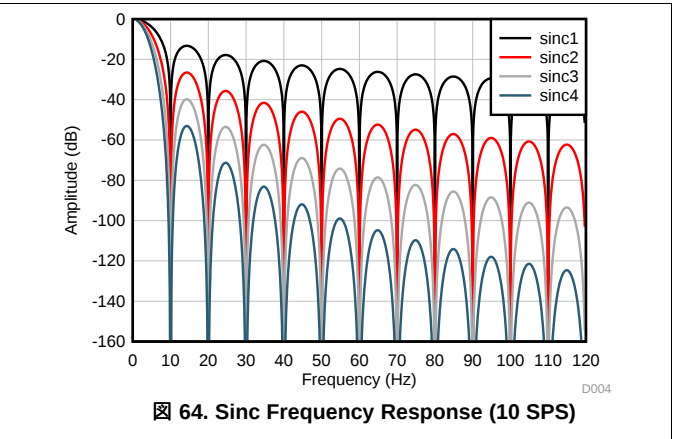
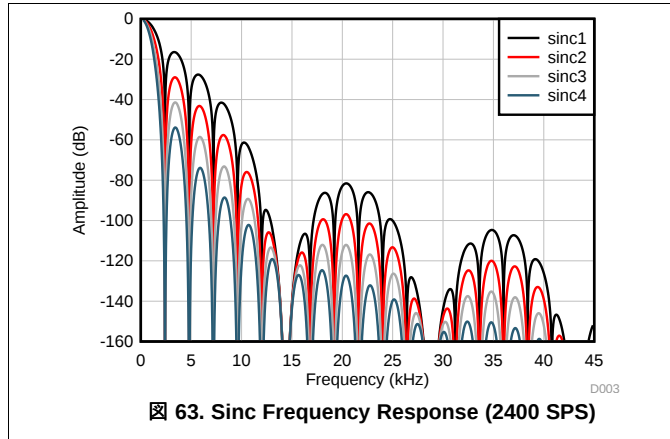


**Figure 61. Frequency Response (40000 SPS)**

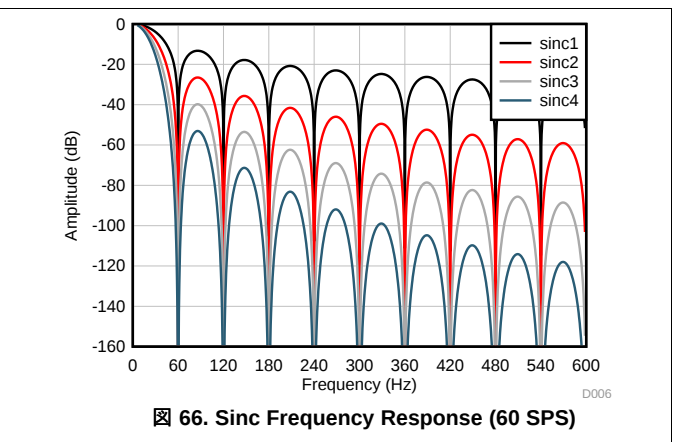
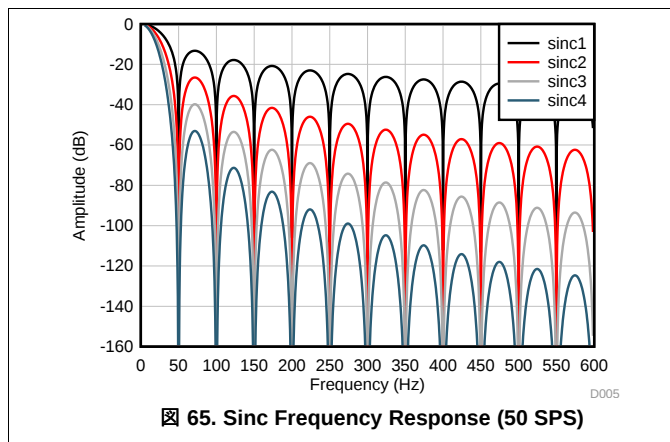


**Figure 62. Frequency Response (14400 SPS)**

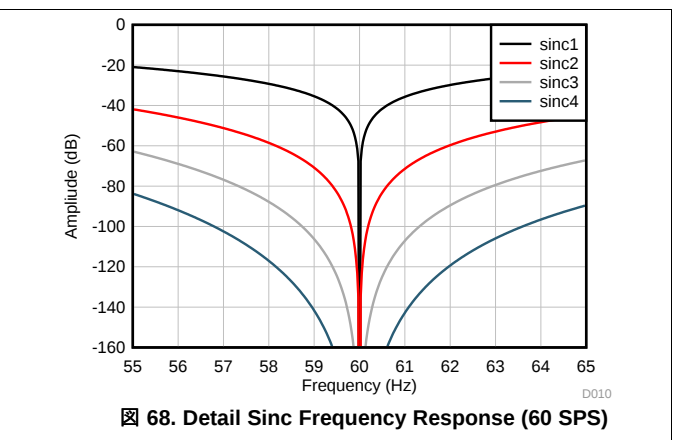
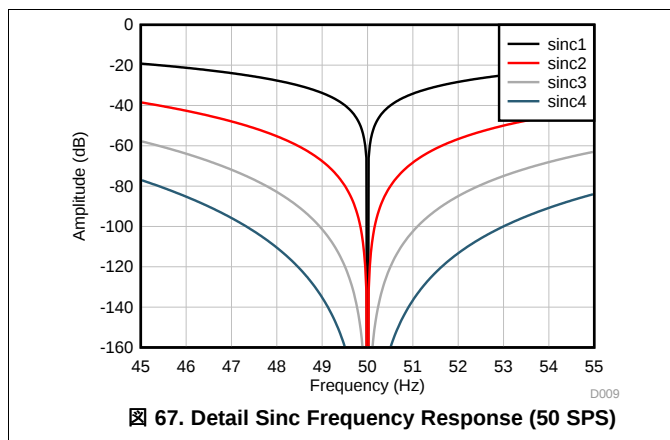
The second stage superimposes frequency response nulls to the nulls of the first stage 14400 SPS output. The first of the superimposed response nulls occurs at the data rate, followed by nulls occurring at multiples of the data rate. [Figure 63](#) illustrates the frequency response for various orders of sinc at data rate of 2400 SPS. This data rate has five nulls between the larger nulls at multiples of 14400 Hz. This frequency response is similar to that of data rates 2.5 SPS to 7200 SPS. [Figure 64](#) shows the frequency response nulls for 10 SPS.



[Figure 65](#) and [Figure 66](#) show the frequency response of data rates 50 SPS and 60 SPS, respectively. Increase the attenuation at 50 Hz or 60 Hz and harmonics by increasing the order of the sinc filter, as shown in the figures.



[Figure 67](#) and [Figure 68](#) show the detailed frequency response at 50 SPS and 60 SPS, respectively.

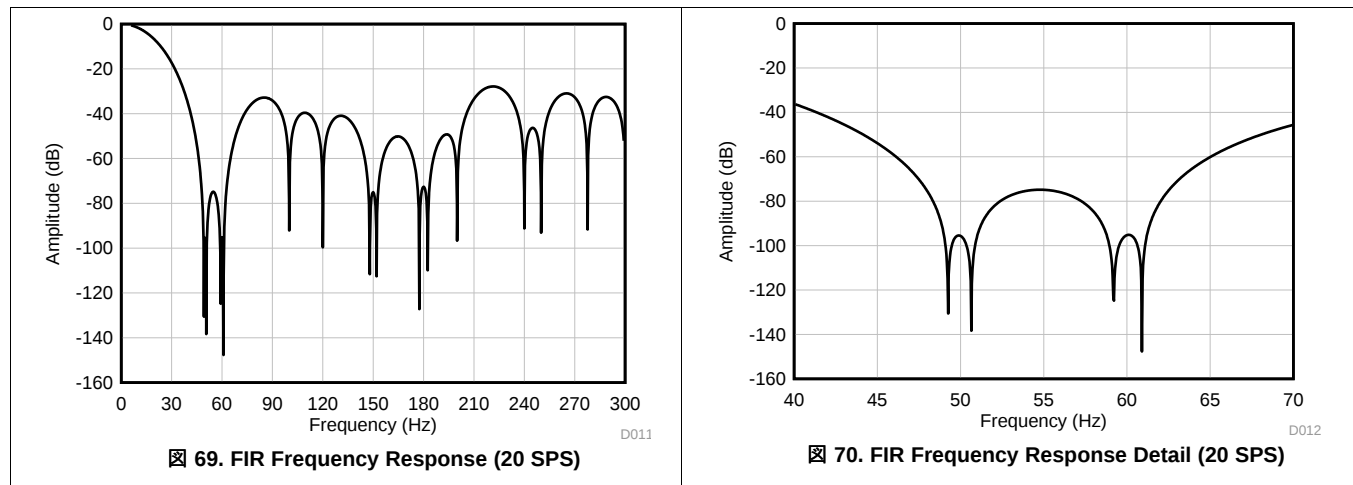


### 10.3.10.2 FIR Filter

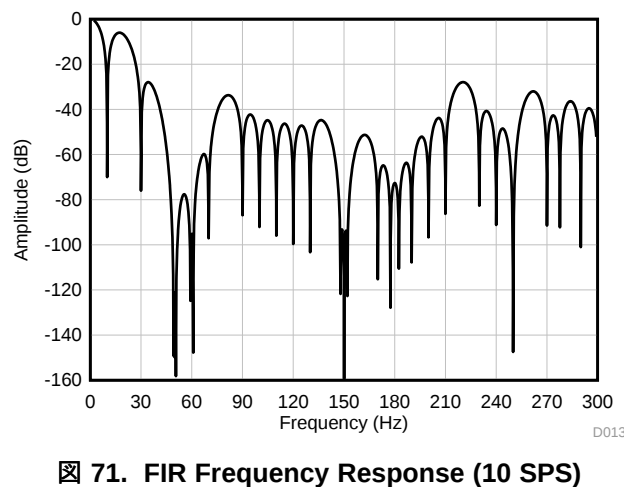
The finite impulse response (FIR) filter is a coefficient based filter architecture that provides an overall low-pass filter response. The filter provides simultaneous attenuation of 50 Hz and 60 Hz and harmonics at data rates of 20 SPS to 2.5 SPS. The conversion latency time of the FIR filter data rates are single-cycle. As shown in [Figure 60](#), the FIR filter receives pre-filtered data from the sinc filter. The FIR filter decimates the data to yield the output data rates of 20 SPS. A variable averager (sinc1) provides data rates of 10 SPS, 5 SPS, and 2.5 SPS. [Table 6](#) lists the bandwidth of the data rates in FIR filter mode.

#### 10.3.10.2.1 FIR Filter Frequency Response

[Figure 69](#) and [Figure 70](#) show the FIR filter frequency attenuates 50 Hz and 60 Hz by a series of response nulls placed close to these frequencies. The response nulls are repeated at harmonics of 50 Hz and 60 Hz.



[Figure 71](#) is the FIR filter response at 10 SPS. As a result of the variable averager, new frequency nulls are superimposed. The first null appears at the data rate. Additional nulls occur at frequencies folded around multiples of 20 Hz.



### 10.3.10.3 Filter Bandwidth

The bandwidth of the filter depends on the data rate and the filter mode. Be aware that the bandwidth of the entire system is the combined response of the filter, the antialias filter and external filters. 表 6 lists the bandwidth versus data rate and filter mode. 表 6 also lists the filter modes available for each data rate.

**表 6. Filter Bandwidth**

| DATA RATE<br>(SPS) | -3-dB BANDWIDTH (Hz) |       |       |       |       |       |
|--------------------|----------------------|-------|-------|-------|-------|-------|
|                    | FIR                  | SINC1 | SINC2 | SINC3 | SINC4 | SINC5 |
| 2.5                | 1.2                  | 1.10  | 0.80  | 0.65  | 0.58  | —     |
| 5                  | 2.4                  | 2.23  | 1.60  | 1.33  | 1.15  | —     |
| 10                 | 4.7                  | 4.43  | 3.20  | 2.62  | 2.28  | —     |
| 16.6               | —                    | 7.38  | 5.33  | 4.37  | 3.80  | —     |
| 20                 | 13                   | 8.85  | 6.38  | 5.25  | 4.63  | —     |
| 50                 | —                    | 22.1  | 16.0  | 13.1  | 11.4  | —     |
| 60                 | —                    | 26.6  | 19.1  | 15.7  | 13.7  | —     |
| 100                | —                    | 44.3  | 31.9  | 26.2  | 22.8  | —     |
| 400                | —                    | 177   | 128   | 105   | 91.0  | —     |
| 1200               | —                    | 525   | 381   | 314   | 273   | —     |
| 2400               | —                    | 1015  | 751   | 623   | 544   | —     |
| 4800               | —                    | 1798  | 1421  | 1214  | 1077  | —     |
| 7200               | —                    | 2310  | 1972  | 1750  | 1590  | —     |
| 14400              | —                    | —     | —     | —     | —     | 2940  |
| 19200              | —                    | —     | —     | —     | —     | 3920  |
| 25600              | —                    | —     | —     | —     | —     | 5227  |
| 40000              | —                    | —     | —     | —     | —     | 8167  |

#### 10.3.10.4 50-Hz and 60-Hz Normal Mode Rejection

To reduce 50-Hz and 60-Hz noise interference, configure the conversion period to reject the noise at 50 Hz and 60 Hz. 50-Hz and 60-Hz noise rejection depends on the filter type. 表 7 summarizes the 50-Hz and 60-Hz noise rejection versus data rate and filter type. The table values are based on 2% and 6% tolerance of noise frequency to ADC clock frequency. For the sinc filter mode, noise rejection is increased by increasing the order of the filter. Common mode noise is also rejected at these frequencies.

**表 7. 50-Hz and 60-Hz Normal Mode Rejection**

| DATA RATE (SPS) | FILTER TYPE | DIGITAL FILTER RESPONSE (dB) |                 |                 |                 |
|-----------------|-------------|------------------------------|-----------------|-----------------|-----------------|
|                 |             | 50 Hz $\pm 2\%$              | 60 Hz $\pm 2\%$ | 50 Hz $\pm 6\%$ | 60 Hz $\pm 6\%$ |
| 2.5             | FIR         | -113                         | -99             | -88             | -80             |
| 2.5             | Sinc1       | -36                          | -37             | -40             | -37             |
| 2.5             | Sinc2       | -72                          | -74             | -80             | -74             |
| 2.5             | Sinc3       | -108                         | -111            | -120            | -111            |
| 2.5             | Sinc4       | -144                         | -148            | -160            | -148            |
| 5               | FIR         | -111                         | -95             | -77             | -76             |
| 5               | Sinc1       | -34                          | -34             | -30             | -30             |
| 5               | Sinc2       | -68                          | -68             | -60             | -60             |
| 5               | Sinc3       | -102                         | -102            | -90             | -90             |
| 5               | Sinc4       | -136                         | -136            | -120            | -120            |
| 10              | FIR         | -111                         | -94             | -73             | -68             |
| 10              | Sinc1       | -34                          | -34             | -25             | -25             |
| 10              | Sinc2       | -68                          | -68             | -50             | -50             |
| 10              | Sinc3       | -102                         | -102            | -75             | -75             |
| 10              | Sinc4       | -136                         | -136            | -100            | -100            |
| 16.6            | Sinc1       | -34                          | -21             | -24             | -21             |
| 16.6            | Sinc2       | -68                          | -42             | -48             | -42             |
| 16.6            | Sinc3       | -102                         | -63             | -72             | -63             |
| 16.6            | Sinc4       | -136                         | -84             | -96             | -84             |
| 20              | FIR         | -95                          | -94             | -66             | -66             |
| 20              | Sinc1       | -18                          | -34             | -18             | -24             |
| 20              | Sinc2       | -36                          | -68             | -36             | -48             |
| 20              | Sinc3       | -54                          | -102            | -54             | -72             |
| 20              | Sinc4       | -72                          | -136            | -72             | -96             |
| 50              | Sinc1       | -34                          | -15             | -24             | -15             |
| 50              | Sinc2       | -68                          | -30             | -48             | -30             |
| 50              | Sinc3       | -102                         | -45             | -72             | -45             |
| 50              | Sinc4       | -136                         | -60             | -96             | -60             |
| 60              | Sinc1       | -13                          | -34             | -12             | -24             |
| 60              | Sinc2       | -27                          | -68             | -24             | -48             |
| 60              | Sinc3       | -40                          | -102            | -36             | -72             |
| 60              | Sinc4       | -53                          | -136            | -48             | -96             |

## 10.4 Device Functional Modes

### 10.4.1 Conversion Control

Conversions are controlled by either the START pin or by the START command. If using commands to control conversions, keep the START pin low to avoid contentions between pin and commands. Commands take affect on the 16th falling SCLK edge (CRC mode disabled) or on the 32nd falling SCLK edge (CRC mode enabled). See [Figure 4](#) for conversion-control timing details.

The ADC provides two conversion modes: continuous and pulse. The continuous-conversion mode performs conversions indefinitely until stopped by the user. Pulse-conversion mode performs one conversion and then stops. The conversion mode is programmed by the CONVRT bit (bit 4 of register MODE0).

#### 10.4.1.1 Continuous-Conversion Mode

This conversion mode performs continuous conversions until stopped by the user. To start conversions, take the START pin high or send the START command.  $\overline{\text{DRDY}}$  is driven high at the time the conversion is initiated.  $\overline{\text{DRDY}}$  is driven low when the conversion data are ready. Conversion data are available to read at that time. Conversions are stopped by taking the START pin low or by sending the STOP command. When conversions are stopped, the conversion in progress runs to completion. To restart a conversion that is in progress, toggle the START pin low-then-high or send a new START command.

#### 10.4.1.2 Pulse-Conversion Mode

In pulse-conversion mode, the ADC performs one conversion when START is taken high or when the START command is sent. When the conversion completes, further conversions stop. The  $\overline{\text{DRDY}}$  output is driven high to indicate the conversion is in progress, and is driven low when the conversion data are ready. Conversion data are available to read at that time. To restart a conversion in progress, toggle the START pin low-then-high or send a new START command. Driving START low or sending the STOP command does not interrupt the current conversion.

#### 10.4.1.3 Conversion Latency

The digital filter averages data from the modulator in order to produce the conversion result. The stages of the digital filter must have settled data in order to provide fully-settled output data. The order and the decimation ratio of the digital filter determine the amount of data averaged, and in turn, affect the latency of the conversion data. The FIR and sinc1 filter modes are zero latency because the ADC provides the conversion result in one conversion cycle. Latency time is an important consideration for the data throughput rate in multiplexed applications.

[Table 8](#) lists the conversion latency values of the ADC. Conversion latency is defined as the time from the start of the first conversion, by taking the START pin high or sending the START command, to the time when the conversion data are ready. If the input signal is settled, then the ADC provides fully settled data under this condition. The conversion latency values listed in the table are with the start-conversion delay parameter = 50  $\mu\text{s}$ , and include the overhead time needed to process the data. After the first conversion completes (in continuous conversion mode), the period of the following conversions are equal to  $1/f_{\text{DATA}}$ . The first conversion latency in chop and AC-excitation modes are twice the values listed in the table. Also when operating in these modes, the period of the following conversions are equal to the values listed in the table.

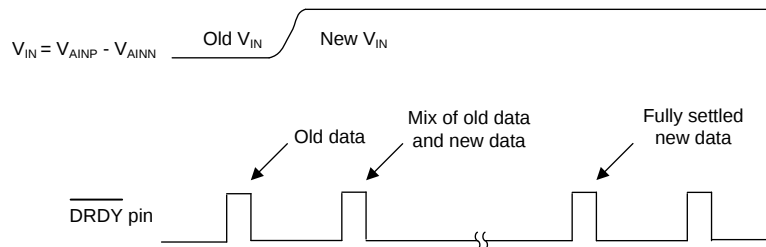
## Device Functional Modes (continued)

**表 8. Conversion Latency**

| DATA RATE<br>(SPS) | CONVERSION LATENCY - $t_{(STDR)}^{(1)}$ (ms) |       |       |       |       |       |
|--------------------|----------------------------------------------|-------|-------|-------|-------|-------|
|                    | FIR                                          | SINC1 | SINC2 | SINC3 | SINC4 | SINC5 |
| 2.5                | 402.2                                        | 400.4 | 800.4 | 1,200 | 1,600 | —     |
| 5                  | 202.2                                        | 200.4 | 400.4 | 600.4 | 800.4 | —     |
| 10                 | 102.2                                        | 100.4 | 200.4 | 300.4 | 400.4 | —     |
| 16.6               | —                                            | 60.43 | 120.4 | 180.4 | 240.4 | —     |
| 20                 | 52.23                                        | 50.43 | 100.4 | 150.4 | 200.4 | —     |
| 50                 | —                                            | 20.43 | 40.43 | 60.43 | 80.43 | —     |
| 60                 | —                                            | 17.09 | 33.76 | 50.43 | 67.09 | —     |
| 100                | —                                            | 10.43 | 20.43 | 30.43 | 40.43 | —     |
| 400                | —                                            | 2.925 | 5.425 | 7.925 | 10.43 | —     |
| 1200               | —                                            | 1.258 | 2.091 | 2.925 | 3.758 | —     |
| 2400               | —                                            | 0.841 | 1.258 | 1.675 | 2.091 | —     |
| 4800               | —                                            | 0.633 | 0.841 | 1.050 | 1.258 | —     |
| 7200               | —                                            | 0.564 | 0.702 | 0.841 | 0.980 | —     |
| 14400              | —                                            | —     | —     | —     | —     | 0.423 |
| 19200              | —                                            | —     | —     | —     | —     | 0.336 |
| 25600              | —                                            | —     | —     | —     | —     | 0.271 |
| 40000              | —                                            | —     | —     | —     | —     | 0.179 |

(1) Chop mode off, conversion-start delay = 50  $\mu$ s (DELAY[3:0] = 0001)

If the input signal changes while free-running conversions, the conversion data are a mix of old and new data, as shown in [图 72](#). After an input change, the number of conversion periods required for fully settled data are determined by dividing the conversion latency by the period of the data rate, plus add one conversion period to the result. In chop mode and AC-excitation mode, use twice the latency values listed in the table.



**图 72. Input Change During Conversions**

### 10.4.1.4 Start-Conversion Delay

Some applications may require a delay at the start of a conversion in order to allow settling time for the PGA output antialias filter or to allow time after input and configuration changes. The ADC provides a user programmable delay time that delays the start of a new conversion. The default value is 50  $\mu$ s. This allows for settling of the antialiasing filter. Use additional delay time as needed to provide settling time for external components. The delay time increases the conversion latency values listed in [表 8](#). As an alternative to the programmable start-conversion delay, manually delay the start of conversion after input and configuration changes.

Start-conversion delay is an important consideration for operation in AC-excitation mode. In this mode, the reference inputs to the bridge, and therefore, the bridge output signals are reversed for each conversion. As a result, time delay is required to allow for settling of external filter components after reversal. As a general guideline, set the start-conversion delay parameter to a minimum of 15 times the R-C time constant of the signal input and reference input filters.

### 10.4.2 Chop Mode

The PGA and modulator are chopper-stabilized at high frequency in order to reduce offset voltage, offset voltage drift and 1/f noise. The offset and noise artifacts are modulated to high frequency and are removed by the digital filter. Although chopper stabilization is designed to remove all offset, a small offset voltage may remain. The optional *global* chop mode removes the remaining offset errors, providing exceptional offset voltage drift performance.

Chop mode alternates the signal polarity of consecutive conversions. The ADC subtracts consecutive, alternate-phase conversions to yield the final conversion data. The result of subtraction removes the offset.

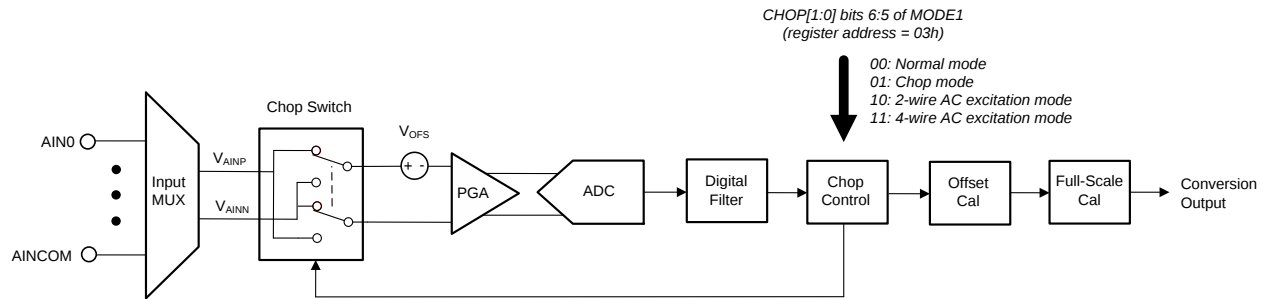


FIG 73. ADC Chop Mode

As shown in FIG 73, the internal chop switch reverses the signal after the input multiplexer.  $V_{OFS}$  models the internal offset voltage. The operational sequence of chop mode is as follows:

**Conversion C1:**  $V_{AINP} - V_{AINN} - V_{OFS} \rightarrow$  First conversion withheld after start

**Conversion C2:**  $V_{AINN} - V_{AINP} - V_{OFS} \rightarrow$  Output 1 =  $(C1 - C2) / 2 = V_{AINP} - V_{AINN}$

**Conversion C3:**  $V_{AINP} - V_{AINN} - V_{OFS} \rightarrow$  Output 2 =  $(C3 - C2) / 2 = V_{AINP} - V_{AINN}$

The sequence repeats for all conversions. Because of the internal mathematical operations, the chop mode data rate is reduced. The chop mode data rate is proportional to the order of the sinc filter. Referring to 表 8, the new data rate is equal to  $1 / \text{latency values}$  and the first conversion latency is  $2 \times \text{latency values}$ . Because of the two-point data averaging arising from the mathematical operations, noise is reduced by  $\sqrt{2}$ . For chop mode, divide the noise data values shown in 表 1 by  $\sqrt{2}$  to derive the new noise performance data. The null frequencies of the digital filter are not changed in chop-mode operation. However, new null frequencies appear at multiples of  $f_{DATA} / 2$ .

### 10.4.3 AC-Excitation Mode

Resistive bridge sensors are excited by DC or AC voltages; for DC or AC currents. DC voltage excitation is the most common type of excitation. AC excitation reverses the polarity of the voltage by the use of external switching components. Similar in concept to chop mode, the result of the voltage reversal removes offset voltage in the connections leading from the bridge to the ADC inputs. This removal includes the offset voltage of the ADC itself. The ADS1261 and ADS1261B devices provide the signals necessary to drive the external switching components in order to reverse the bridge voltage.

The timing of the drive signals is synchronized to the ADC conversion phase. During one conversion phase, the voltage polarity is normal. For the alternate conversion phase, the voltage polarity is reversed. The ADC compensates the reversed polarity conversion by internal reversal of the reference voltage. The ADC subtracts the data corresponding to the normal and reverse phases in order to remove offset voltage from the input.

The ADC output drive signals do not overlap in order to avoid bridge cross-conduction that can otherwise occur during excitation voltage reversal. The switch rate of the AC-excitation drive signals are at the data rate to avoid unnecessary fast switching. See FIG 7 for output drive timing.

表 9 shows the AC-excitation drive signals and the associated GPIO pins. Program the AC-excitation mode using the CHOP[1:0] bits in register MODE1. AC excitation can be programmed for two-wire or four-wire drive mode. For two-wire operation, two drive signals are provided on the GPIOs. If needed, use two external inverters to derive four signals to drive discrete transistors. The GPIO drive levels are referred to the 5-V analog supply. Be aware that the AC-excitation mode changes the nominal data rate, depending on the order of the sinc filter. See the [Chop Mode](#) section for details of the effective data rate.

**表 9. AC-Excitation Drive Pins**

| DEVICE PIN | GPIO  | 2-WIRE MODE (CHOP[1:0] = 10) | 4-WIRE MODE (CHOP[1:0] = 11) |
|------------|-------|------------------------------|------------------------------|
| AIN2       | GPIO0 | $\overline{\text{ACX1}}$     | $\overline{\text{ACX1}}$     |
| AIN3       | GPIO1 | $\overline{\text{ACX2}}$     | $\overline{\text{ACX2}}$     |
| AIN4       | GPIO2 | —                            | ACX1                         |
| AIN5       | GPIO3 | —                            | ACX2                         |

#### 10.4.4 ADC Clock Mode

Operate the ADC with an external clock or with the internal oscillator. The clock frequency is 7.3728 MHz, except for  $f_{\text{DATA}} = 40000$  SPS then  $f_{\text{CLK}} = 10.24$  MHz (internal or external). For external clock operation, apply the clock signal to CLKIN. For internal-clock operation, connect CLKIN to DGND. The internal oscillator begins operation immediately at power-up. The ADC automatically selects the clock mode of operation. Read the clock mode bit in the STATUS register to determine the clock mode.

#### 10.4.5 Power-Down Mode

The ADC has two power-down modes: hardware and software. In both power-down modes, the digital outputs remain driven. The digital inputs must be maintained at  $V_{\text{IH}}$  or  $V_{\text{IL}}$  levels (do not float the digital inputs). The internal low-dropout regulator remains on, drawing 25  $\mu\text{A}$  (typical) from DVDD.

##### 10.4.5.1 Hardware Power-Down

Take the  $\overline{\text{PWDN}}$  pin low to engage hardware power-down mode. Except for the internal LDO, all ADC functions are disabled. To exit hardware power-down mode (wake-up) take the  $\overline{\text{PWDN}}$  pin high. The register values are not reset at wake-up. The internal reference is shut down in this mode; therefore, be sure to accommodate the start-up time of the internal reference before starting conversions.

##### 10.4.5.2 Software Power-Down

Set the PWDN bit (bit 7 of register MODE3) to engage software power-down mode. Similar to the operation of hardware power-down mode, software mode powers down the internal functions except the serial interface remains powered, and the internal reference bias is unchanged (On or Off). Exit the software power-down mode by clearing the PWDN bit. The register values are not reset.

#### 10.4.6 Reset

The ADC is reset in three ways: at power-on, by the  $\overline{\text{RESET}}$  pin, and by the RESET command. When reset, the serial interface, conversion-control logic, digital filter, and register values are reset. The RESET bit of the STATUS byte is set to indicate a device reset has occurred by any of the three reset methods. Clear the bit to detect the next device reset. If the START pin is high after reset, the ADC begins conversions.

##### 10.4.6.1 Power-on Reset

At power-on, after the supply voltages cross the reset-voltage thresholds, the ADC is reset and  $2^{16} f_{\text{CLK}}$  cycles later the ADC is ready for communication. Until this time,  $\overline{\text{DRDY}}$  is held low.  $\overline{\text{DRDY}}$  is driven high to indicate when the ADC is ready for communication. If the START pin is high, the conversion cycle starts  $512 / f_{\text{CLK}}$  cycle after  $\overline{\text{DRDY}}$  asserts high. [Figure 5](#) shows the power-on reset behavior.

##### 10.4.6.2 Reset by Pin

Reset the ADC by taking the  $\overline{\text{RESET}}$  pin low and then returning the pin high. After reset, the conversion starts  $512 / f_{\text{CLK}}$  cycles later. See [Figure 6](#) for RESET timing.

### 10.4.6.3 Reset by Command

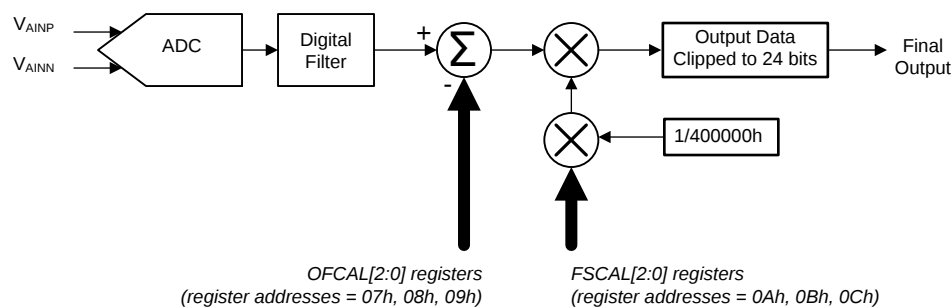
Reset the ADC by the RESET command. Toggle  $\overline{\text{CS}}$  high to make sure the serial interface resets before sending the command. For applications that tie CS low, see the [Serial Interface Auto-Reset](#) section for information on how to reset the serial interface. After reset, the conversion starts 512 /  $f_{\text{CLK}}$  cycles later. See [Figure 6](#) for timing details.

### 10.4.7 Calibration

The ADC incorporates calibration registers and associated commands to calibrate offset and full-scale errors. Calibrate by using calibration commands, or calibrate by writing to the calibration registers directly (user calibration). To calibrate by command, send the offset or full-scale calibration commands. To user calibrate, write values to the calibration registers based on calculations of the conversion data. Perform offset calibration before full-scale calibration.

#### 10.4.7.1 Offset and Full-Scale Calibration

Use the offset and full-scale (gain) registers to correct offset or full-scale errors, respectively. As shown in [Figure 74](#), the offset calibration register is subtracted from the output data before multiplication by the full-scale register, which is divided by 400000h. After the calibration operation, the final output data are clipped to 24 bits.



**图 74. Calibration Block Diagram**

[Figure 6](#) shows the internal calibration.

$$\text{Final Output Data} = (\text{Filter Output} - \text{OFCAL}[2:0]) \cdot \text{FSCAL}[2:0] / 400000h \quad (6)$$

#### 10.4.7.1.1 Offset Calibration Registers

The offset calibration word is 24 bits, consisting of three 8-bit registers, as listed in [Table 10](#). The offset value is subtracted from the conversion result. The offset value is in two's complement format with a maximum positive value equal to 7FFFFFFh, and a maximum negative value equal to 800000h. A register value equal to 000000h has no offset correction. Although the offset calibration register provides a wide range of possible offset values, the input signal after calibration cannot exceed  $\pm 106\%$  of the pre-calibrated range; otherwise, the ADC is overranged. [Table 11](#) lists example values of the offset register.

**表 10. Offset Calibration Registers**

| REGISTER | BYTE ORDER | ADDRESS | BIT ORDER |     |     |     |     |     |     |          |
|----------|------------|---------|-----------|-----|-----|-----|-----|-----|-----|----------|
| OFCAL0   | LSB        | 07h     | B7        | B6  | B5  | B4  | B3  | B2  | B1  | B0 (LSB) |
| OFCAL1   | MID        | 08h     | B15       | B14 | B13 | B12 | B11 | B10 | B9  | B8       |
| OFCAL2   | MSB        | 09h     | B23 (MSB) | B22 | B21 | B20 | B19 | B18 | B17 | B16      |

**表 11. Offset Calibration Register Values**

| OFCAL[2:0] REGISTER VALUE | IDEAL OUTPUT VALUE <sup>(1)</sup> |
|---------------------------|-----------------------------------|
| 000001h                   | FFFFFFh                           |
| 000000h                   | 000000h                           |
| FFFFFFh                   | 000001h                           |

(1) Output value with no offset error

#### 10.4.7.1.2 Full-Scale Calibration Registers

The full-scale calibration word is 24 bits consisting of three 8-bit registers, as listed in 表 12. The full-scale calibration value is in straight-binary format, normalized to a unity-gain factor at a value of 400000h. 表 13 lists register values for selected gain factors. Gain errors greater than unity are corrected by using full-scale values less than 400000h. Although the full-scale register provides a wide range of possible values, the input signal after calibration must not exceed  $\pm 106\%$  of the precalibrated input range; otherwise, the ADC is overranged.

**表 12. Full-Scale Calibration Registers**

| REGISTER | BYTE ORDER | ADDRESS | BIT ORDER |     |     |     |     |     |     |          |
|----------|------------|---------|-----------|-----|-----|-----|-----|-----|-----|----------|
| FSCAL0   | LSB        | 0Ah     | B7        | B6  | B5  | B4  | B3  | B2  | B1  | B0 (LSB) |
| FSCAL1   | MID        | 0Bh     | B15       | B14 | B13 | B12 | B11 | B10 | B9  | B8       |
| FSCAL2   | MSB        | 0Ch     | B23 (MSB) | B22 | B21 | B20 | B19 | B18 | B17 | B16      |

**表 13. Full-Scale Calibration Register Values**

| FSCAL[2:0] REGISTER VALUE | GAIN FACTOR |
|---------------------------|-------------|
| 433333h                   | 1.05        |
| 400000h                   | 1.00        |
| 3CCCCCh                   | 0.95        |

#### 10.4.7.2 Offset Self-Calibration (SFOCAL)

The offset self-calibration command corrects offset errors internal to the ADC. When the offset self-calibration command is sent, the ADC disconnects the external inputs, shorts the inputs to the PGA, and then averages 16 conversion results to compute the calibration value. Averaging the data reduces conversion noise to improve calibration accuracy. When calibration is complete, the ADC restores the user input and performs one conversion using the new calibration value.

#### 10.4.7.3 Offset System-Calibration (SYOCAL)

The offset system-calibration command corrects system offset errors. For this type of calibration, the user shorts the inputs to either the ADC or to the system. When the command is sent, the ADC averages 16 conversion results to compute the calibration value. Averaging the data reduces conversion noise to improve calibration accuracy. When calibration is complete, the ADC performs one conversion using the new calibration value.

#### 10.4.7.4 Full-Scale Calibration (GANCAL)

The full-scale calibration command corrects gain error. To calibrate, apply a positive full-scale calibration voltage to the ADC, wait for the signal to settle, and then send the calibration command. The ADC averages 16 conversion results to compute the calibration value. Averaging the data reduces conversion noise to improve calibration accuracy. The ADC computes the full-scale calibration value so that the calibration voltage is scaled to positive full scale output code. When calibration is complete, the ADC performs one new conversion using the new calibration value.

### 10.4.7.5 Calibration Command Procedure

Use the following procedure to calibrate using commands. The register-lock mode must be UNLOCK for all calibration commands. After power-on, make sure the reference voltage has stabilized before calibrating. Perform offset calibration before full-scale calibration.

1. Configure the ADC as required.
2. Apply the appropriate calibration signal (zero or full-scale)
3. Take the START pin high or send the START command to start conversions.  $\overline{\text{DRDY}}$  is driven high.
4. Before the conversion cycle completes, send the calibration command. Keep  $\overline{\text{CS}}$  low otherwise the command is cancelled. Send no other commands during the calibration period.
5. Calibration time depends on the data rate and digital filter mode. See 表 14.  $\overline{\text{DRDY}}$  asserts low when calibration is complete. The offset or full-scale calibration registers are updated with new values. At calibration completion, new conversion data are ready using the new calibration value.

**表 14. Calibration Time (ms)**

| DATA RATE<br>(SPS) | FILTER MODE <sup>(1)</sup> |       |       |       |       |       |
|--------------------|----------------------------|-------|-------|-------|-------|-------|
|                    | FIR                        | SINC1 | SINC2 | SINC3 | SINC4 | SINC5 |
| 2.5                | 6805                       | 6801  | 7601  | 8401  | 9201  | —     |
| 5                  | 3405                       | 3401  | 3801  | 4201  | 4601  | —     |
| 10                 | 1705                       | 1701  | 1901  | 2101  | 2301  | —     |
| 16.6               | —                          | 1021  | 1141  | 1261  | 1381  | —     |
| 20                 | 854.5                      | 850.9 | 951.0 | 1051  | 1151  | —     |
| 50                 | —                          | 340.9 | 380.9 | 420.9 | 460.9 | —     |
| 60                 | —                          | 284.2 | 317.5 | 350.9 | 384.2 | —     |
| 100                | —                          | 170.9 | 190.9 | 210.9 | 230.9 | —     |
| 400                | —                          | 43.36 | 48.36 | 53.36 | 58.36 | —     |
| 1200               | —                          | 15.02 | 16.69 | 18.36 | 20.02 | —     |
| 2400               | —                          | 7.938 | 8.772 | 9.605 | 10.44 | —     |
| 4800               | —                          | 4.397 | 4.813 | 5.230 | 5.647 | —     |
| 7200               | —                          | 3.216 | 3.494 | 3.772 | 4.050 | —     |
| 14400              | —                          | —     | —     | —     | —     | 1.892 |
| 19200              | —                          | —     | —     | —     | —     | 1.458 |
| 25600              | —                          | —     | —     | —     | —     | 1.133 |
| 40000              | —                          | —     | —     | —     | —     | 0.738 |

(1) Nominal clock frequency. Chop and AC-excitation modes disabled.

### 10.4.7.6 User Calibration Procedure

To user calibrate, apply the calibration voltage, acquire conversion data, and compute the calibration value. The computed value is written to the corresponding calibration registers. Before starting calibration, preset the offset and full-scale registers to 000000h and 400000h, respectively.

To offset calibrate, short the ADC inputs (or inputs to the system) and average n number of the conversion results. Averaging conversion data reduces noise to improve calibration accuracy. Write the averaged value of the conversion data to the offset registers.

To gain calibrate using a full scale calibration voltage, temporarily reduce the full scale register 95% to avoid output clipped codes (set FSCAL[2:0] to 3CCCCCh). Acquire n number of conversions and average the conversions to reduce noise to improve calibration accuracy. Compute the full-scale calibration value as shown in 式 7:

$$\text{Full-Scale Calibration Value} = \text{Expected Code} / \text{Actual Code} \cdot 400000\text{h}$$

where

- Expected code = 799998h using full scale calibration signal and 95% scale factor (7)

## 10.5 Programming

### 10.5.1 Serial Interface

The serial interface is SPI-compatible and is used to read conversion data, configure registers, and control the ADC. The serial interface consists of four control lines:  $\overline{\text{CS}}$ , SCLK, DIN, and DOUT/DRDY. Most microcontroller SPI peripherals can operate with the ADC. The interface operates in SPI mode 1, where CPOL = 0 and CPHA = 1. In SPI mode 1, SCLK idles low and data are updated or changed on SCLK rising edges; data are latched or read on SCLK falling edges. Timing details of the SPI protocol are found in [Figure 1](#) and [Figure 2](#).

#### 10.5.1.1 Chip Select ( $\overline{\text{CS}}$ )

$\overline{\text{CS}}$  is an active-low input that selects the serial interface for communication.  $\overline{\text{CS}}$  must be low during the entire data transaction. When  $\overline{\text{CS}}$  is taken high, the serial interface resets, SCLK input activity is ignored (blocking commands), and DOUT/DRDY enters the high-impedance state. The operation of DRDY is not effected by  $\overline{\text{CS}}$ . If the ADC is a single device connected to the serial bus,  $\overline{\text{CS}}$  can be tied low in order to reduce the serial interface to three lines.

#### 10.5.1.2 Serial Clock (SCLK)

SCLK is the serial clock input that shifts data into and out of the ADC. Output data are updated on the rising edge of SCLK and input data are latched on the falling edge of SCLK. Return SCLK low after the data operation is completed. SCLK is a Schmidt-triggered input designed to improve noise immunity. Even though SCLK is noise resistant, keep SCLK as noise-free as possible to avoid unintentional SCLK transitions. Avoid ringing and overshoot on the SCLK input. Place a series termination resistor close to the SCLK drive pin to reduce ringing.

#### 10.5.1.3 Data Input (DIN)

DIN is the serial data input to the ADC. DIN is used to input commands and register data to the ADC. Data are latched on the falling edge of SCLK.

#### 10.5.1.4 Data Output/Data Ready (DOUT/DRDY)

The DOUT/DRDY pin is a dual-function output. The functions of this pin are data output and data ready. The functionality changes automatically based on whether a read data operation is in progress. During a read data operation, the functionality is data output. After the read operation is complete, the functionality changes to data ready.

In data output mode, data are updated on the SCLK rising edge, therefore the host latches the data on the falling edge of SCLK. In data-ready mode, the pin functions the same as DRDY (if  $\overline{\text{CS}}$  is low) by asserting low when data are ready. Therefore, monitor either DOUT/DRDY or DRDY to determine when data are ready. When  $\overline{\text{CS}}$  is high, the DOUT/DRDY pin is in the high-impedance mode (tri-state).

#### 10.5.1.5 Serial Interface Auto-Reset

The serial interface is reset by taking  $\overline{\text{CS}}$  high. Applications that tie  $\overline{\text{CS}}$  low do not have the ability to reset the serial interface by  $\overline{\text{CS}}$ . If a false SCLK occurs (for example, caused by a noise pulse or clocking glitch), the serial interface may inadvertently advance one or more bit positions, resulting in loss of synchronization to the host. If loss of synchronization occurs, the ADC interface does not respond correctly until the interface is reset.

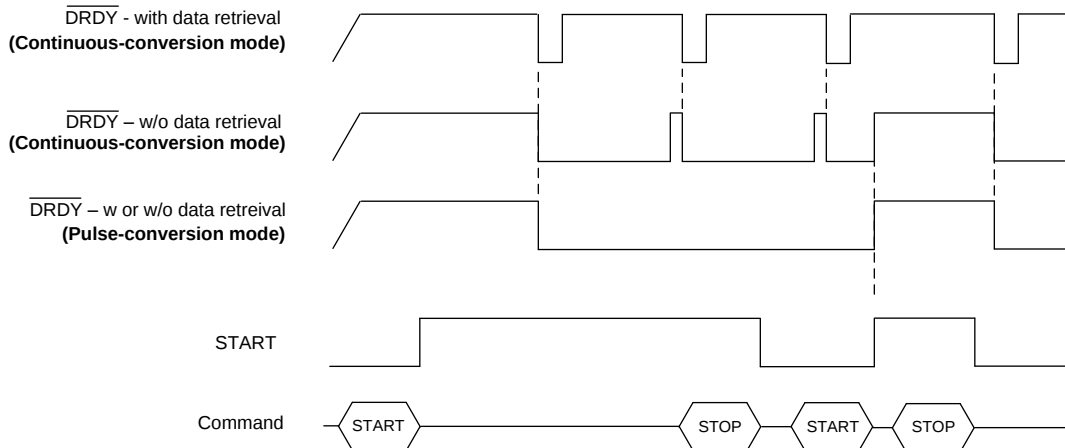
For applications that tie  $\overline{\text{CS}}$  low, the serial interface auto-reset feature recovers the interface in the event that an unintentional SCLK glitch occurs. When the first SCLK low-to-high transition occurs (either caused by a glitch or by normal SCLK activity), seven SCLK transitions must occur within  $65536 f_{\text{CLK}}$  cycles (8.9 ms) to complete the byte transaction, otherwise the serial interface resets. After reset, the interface is ready to begin the next byte transaction. If the byte transaction is completed within the  $65536 f_{\text{CLK}}$  cycles, the serial interface does not reset. The cycle of SCLK detection re-starts at the next rising edge of SCLK. The serial interface is reset by holding SCLK low for a minimum  $65536 f_{\text{CLK}}$  cycles.

The auto-reset function is enabled by the SPITIM bit (default is off). See [Figure 3](#) for timing details.

## Programming (continued)

### 10.5.2 Data Ready ( $\overline{\text{DRDY}}$ )

$\overline{\text{DRDY}}$  is an output that asserts low when conversion data are ready. After power-up,  $\overline{\text{DRDY}}$  also indicates when the ADC is ready for communication. The operation of  $\overline{\text{DRDY}}$  depends on the conversion mode (continuous or pulse) and whether the conversion data are retrieved or not. [Figure 75](#) shows  $\overline{\text{DRDY}}$  operation with and without data retrieval in the two modes of conversion.



**Figure 75.  $\overline{\text{DRDY}}$  Operation**

#### 10.5.2.1 $\overline{\text{DRDY}}$ in Continuous-Conversion Mode

In continuous-conversion mode,  $\overline{\text{DRDY}}$  is driven high when conversions are started and is driven low when conversion data are ready. During data readback,  $\overline{\text{DRDY}}$  returns high at the end of the read operation. If the conversion data are not read,  $\overline{\text{DRDY}}$  pulses high 16  $f_{\text{CLK}}$  cycles prior to the next falling edge.

To read conversion data before the next conversion is ready, send the complete read-data command 16  $f_{\text{CLK}}$  cycles before the next  $\overline{\text{DRDY}}$  falling edge. If the readback command is sent less than 16  $f_{\text{CLK}}$  cycles before the  $\overline{\text{DRDY}}$  falling edge, either old or new conversion data are provided, depending on the timing of when the command is sent. In the case that old conversion data are provided,  $\overline{\text{DRDY}}$  driven low is delayed until after the read data operation is completed. In this case, the  $\overline{\text{DRDY}}$  bit of the STATUS byte is cleared to indicate the same data have been read. If new conversion data are provided,  $\overline{\text{DRDY}}$  transitions low at the normal period of the data rate. In this case, the  $\overline{\text{DRDY}}$  bit of the STATUS byte is set to indicate that new data have been read. To make sure new data are read back, wait until  $\overline{\text{DRDY}}$  asserts low before starting the data read operation.

#### 10.5.2.2 $\overline{\text{DRDY}}$ in Pulse-Conversion Mode

$\overline{\text{DRDY}}$  is driven high at conversion start and is driven low when the conversion data are ready. During the data read operation  $\overline{\text{DRDY}}$  remains low until a new conversion is started.

#### 10.5.2.3 Data Ready by Software Polling

Use software polling of data ready in lieu of hardware polling of  $\overline{\text{DRDY}}$  or  $\text{DOUT}/\overline{\text{DRDY}}$ . To software poll, read the STATUS register and poll the  $\overline{\text{DRDY}}$  bit. In order to not skip conversion data in continuous conversion mode, poll the bit at least as often as the period of the data rate. If the  $\overline{\text{DRDY}}$  bit is set, then conversion data are new since the previous data read operation. If the bit is cleared, conversion data are not new since the previous data read operation. In this case, the previous conversion data are returned.

### 10.5.3 Conversion Data

Conversion data are read by the RDATA command. To read data, take  $\overline{\text{CS}}$  low and issue the read data command. The data field response consists of the optional STATUS byte, three data bytes, and the optional CRC byte. The CRC is computed over the combination of status byte and conversion data bytes. See the [RDATA Command](#) section for details to read conversion data.

## Programming (continued)

### 10.5.3.1 Status byte (STATUS)

The status byte contains information on the operating state of the ADC. The STATUS byte is included with the conversion data by enabling bit STATENB of register MODE3. Optionally, read the STATUS register directly to read status information without the need to read conversion data. See [Figure 81](#) for details.

### 10.5.3.2 Conversion Data Format

The conversion data are 24 bits, in two's-complement format to represent positive and negative values. The data output begins with the most significant bit (sign bit) first. The data are scaled so that  $V_{IN} = 0$  V results in an uncalibrated code value of 000000h; positive full scale equals 7FFFFFFh and negative full scale equals 800000h; see [Table 15](#) for the uncalibrated code values. The data are clipped to 7FFFFFFh (positive full scale) and 800000h (negative full scale) during positive and negative signal overdrive, respectively.

**表 15. ADC Conversion Data Codes**

| DESCRIPTION         | INPUT SIGNAL (V)                                         | 24-BIT CONVERSION DATA <sup>(1)</sup> |
|---------------------|----------------------------------------------------------|---------------------------------------|
| Positive full scale | $\geq V_{REF} / \text{Gain} \cdot (2^{23} - 1) / 2^{23}$ | 7FFFFFFh                              |
| 1 LSB               | $V_{REF} / (\text{Gain} \cdot 2^{23})$                   | 000001h                               |
| Zero scale          | 0                                                        | 000000h                               |
| -1 LSB              | $-V_{REF} / (\text{Gain} \cdot 2^{23})$                  | FFFFFFh                               |
| Negative full scale | $\leq -V_{REF} / \text{Gain}$                            | 800000h                               |

(1) Ideal (calibrated) conversion data.

### 10.5.4 CRC

Cyclic redundancy check (CRC) is an error checking code that detects communication errors to and from the host. CRC is the division remainder of the data payload bytes by a fixed polynomial. The data payload is 1, 2, 3 or 4 bytes depending on the data operation. The CRC mode is optional and is enabled by the CRCENB bit. See [Table 35](#) to program the CRC mode.

The user computes the CRC corresponding to the two command bytes and appends the CRC to the command string (3rd byte). A 4th, zero-value byte completes the command field. The ADC repeats the CRC calculation and compares the calculation to the received CRC. If the user and repeated CRC values match, the command executes and the ADC responds by transmitting the repeated CRC during the 4th byte of the command. If the operation is conversion data or register data read, the ADC responds with a 2nd CRC that is computed over the requested data payload bytes. The response data payload is 1, 3, or 4 bytes depending on the data operation.

If the user and repeated CRC values do not match, the command does not execute and the ADC responds with an inverted CRC for the actual received command bytes. The inverted CRC is intended to signal the host of the failed operation. The user terminates transmission of the command bytes to match the action of ADC termination. The CRCERR bit is set in the STATUS register when a CRC error is detected. The ADC is ready to accept the next command after a CRC error occurs at the end of the 4th byte.

The CRC data byte is the 8-bit remainder of the bitwise exclusive-OR (XOR) operation of the argument by a CRC polynomial. The CRC polynomial is based on the CRC-8-ATM (HEC):  $X^8 + X^2 + X^1 + 1$ . The nine binary polynomial coefficients are: 100000111. The CRC calculation is preset with "1" data values.

The CRC mnemonics apply to the following command sections.

- CRC-2: Input CRC of command bytes 1 and 2. Except for WREG command, the value of byte 2 is arbitrary
- Out CRC-1: Output CRC of one register data byte
- Out CRC-2: Output CRC of two command bytes, inverted value if input CRC error detected
- Out CRC-3: Output CRC of three conversion data bytes
- Out CRC-4: Output CRC of three conversion data bytes plus STATUS byte
- Echo Byte 1: Echo of received input byte 1
- Echo Byte 2: Echo of received input byte 2

### 10.5.5 Commands

Commands read conversion data, control the ADC, and read and write register data. See [表 16](#) for the list of commands. Send only the commands that are listed in [表 16](#). The ADC executes commands at completion of the 2nd byte (no CRC verification) or at completion of the 4th byte (with CRC verification). Follow the two byte or four byte format according to the CRC mode. Except for register write commands, the value of the second command byte is arbitrary but the value is included in the CRC calculation (total of two-byte CRC). If a CRC error is detected, the ADC does not execute the command. Taking  $\overline{CS}$  high before the command is completed results in termination of the command. When  $\overline{CS}$  is taken low, the communication frame is reset to start a new command.

**表 16. Command Byte Summary**

| MNEMONIC                    | DESCRIPTION               | BYTE 1                   | BYTE 2        | BYTE 3<br>(CRC Mode Only) | BYTE 4<br>(CRC Mode only) |
|-----------------------------|---------------------------|--------------------------|---------------|---------------------------|---------------------------|
| <b>Control Commands</b>     |                           |                          |               |                           |                           |
| NOP                         | No operation              | 00h                      | Arbitrary     | CRC-2                     | 00h                       |
| RESET                       | Reset                     | 06h                      | Arbitrary     | CRC-2                     | 00h                       |
| START                       | Start conversion          | 08h                      | Arbitrary     | CRC-2                     | 00h                       |
| STOP                        | Stop conversion           | 0Ah                      | Arbitrary     | CRC-2                     | 00h                       |
| <b>Read Data Command</b>    |                           |                          |               |                           |                           |
| RDATA                       | Read conversion data      | 12h                      | Arbitrary     | CRC-2                     | 00h                       |
| <b>Calibration Commands</b> |                           |                          |               |                           |                           |
| SYOCAL                      | System offset calibration | 16h                      | Arbitrary     | CRC-2                     | 00h                       |
| GANCAL                      | Gain calibration          | 17h                      | Arbitrary     | CRC-2                     | 00h                       |
| SFOCAL                      | Self offset calibration   | 19h                      | Arbitrary     | CRC-2                     | 00h                       |
| <b>Register Commands</b>    |                           |                          |               |                           |                           |
| RREG                        | Read register data        | 20h + rrr <sup>(1)</sup> | Arbitrary     | CRC-2                     | 00h                       |
| WREG                        | Write register data       | 40h + rrr <sup>(1)</sup> | Register data | CRC-2                     | 00h                       |
| <b>Protection Commands</b>  |                           |                          |               |                           |                           |
| LOCK                        | Register lock             | F2h                      | Arbitrary     | CRC-2                     | 00h                       |
| UNLOCK                      | Register unlock           | F5h                      | Arbitrary     | CRC-2                     | 00h                       |

(1) rrr = 5-bit register address.

#### 10.5.5.1 NOP Command

This command is no operation. Use the NOP command to validate the CRC response byte and error detection without affecting normal operation. [表 17](#) shows the NOP command byte sequence.

**表 17. NOP Command**

| DIRECTION               | BYTE 1 | BYTE 2      | BYTE 3      | BYTE 4    |
|-------------------------|--------|-------------|-------------|-----------|
| <b>No CRC mode</b>      |        |             |             |           |
| DIN                     | 00h    | Arbitrary   |             |           |
| DOUT/ $\overline{DRDY}$ | FFh    | Echo byte 1 |             |           |
| <b>CRC mode</b>         |        |             |             |           |
| DIN                     | 00h    | Arbitrary   | CRC-2       | 00h       |
| DOUT/ $\overline{DRDY}$ | FFh    | Echo byte 1 | Echo byte 2 | Out CRC-2 |

#### 10.5.5.2 RESET Command

The RESET command resets ADC operation and resets the registers to default values. See the [Reset by Command](#) section for details. [表 18](#) shows the RESET command byte sequence.

**表 18. RESET Command**

| DIRECTION          | BYTE 1 | BYTE 2 | BYTE 3 | BYTE 4 |
|--------------------|--------|--------|--------|--------|
| <b>No CRC mode</b> |        |        |        |        |

**表 18. RESET Command (continued)**

| DIRECTION                      | BYTE 1 | BYTE 2      | BYTE 3      | BYTE 4    |
|--------------------------------|--------|-------------|-------------|-----------|
| DIN                            | 06h    | Arbitrary   |             |           |
| DOUT/ $\overline{\text{DRDY}}$ | FFh    | Echo byte 1 |             |           |
| <b>CRC mode</b>                |        |             |             |           |
| DIN                            | 06h    | Arbitrary   | CRC-2       | 00H       |
| DOUT/ $\overline{\text{DRDY}}$ | FFh    | Echo byte 1 | Echo byte 2 | Out CRC-2 |

### 10.5.5.3 START Command

This command starts conversions. See the [Conversion Control](#) section for details. 表 19 shows the START command byte sequence.

**表 19. START Command**

| DIRECTION                      | BYTE 1 | BYTE 2      | BYTE 3      | BYTE 4    |
|--------------------------------|--------|-------------|-------------|-----------|
| <b>No CRC mode</b>             |        |             |             |           |
| DIN                            | 08h    | Arbitrary   |             |           |
| DOUT/ $\overline{\text{DRDY}}$ | FFh    | Echo byte 1 |             |           |
| <b>CRC mode</b>                |        |             |             |           |
| DIN                            | 08h    | Arbitrary   | CRC-2       | 00h       |
| DOUT/ $\overline{\text{DRDY}}$ | FFh    | Echo byte 1 | Echo byte 2 | Out CRC-2 |

### 10.5.5.4 STOP Command

This command stops conversions. See the [Conversion Control](#) section for details. 表 20 shows the STOP command byte sequence.

**表 20. STOP Command**

| DIRECTION                      | BYTE 1 | BYTE 2      | BYTE 3      | BYTE 4    |
|--------------------------------|--------|-------------|-------------|-----------|
| <b>No CRC mode</b>             |        |             |             |           |
| DIN                            | 0Ah    | Arbitrary   |             |           |
| DOUT/ $\overline{\text{DRDY}}$ | FFh    | Echo byte 1 |             |           |
| <b>CRC mode</b>                |        |             |             |           |
| DIN                            | 0Ah    | Arbitrary   | CRC-2       | 00h       |
| DOUT/ $\overline{\text{DRDY}}$ | FFh    | Echo byte 1 | Echo byte 2 | Out CRC-2 |

### 10.5.5.5 RDATA Command

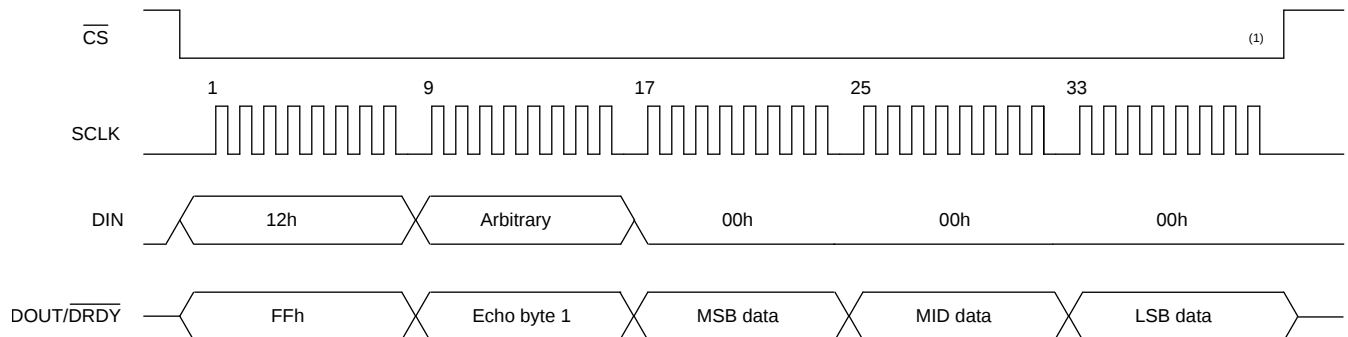
This command reads conversion data. Because the data are buffered, the data can be read at any time during the conversion phase. If data are read near the completion of the next conversion, old or new conversion data are returned. See the [Data Ready \( \$\overline{\text{DRDY}}\$ \)](#) section for details.

The response of conversion data varies in length from 3 to 5 bytes depending if the STATUS byte and CRC bytes are included. See the [Conversion Data Format](#) section for the numeric data format. See 表 21, 図 76 (minimum configuration) and 図 77 (maximum configuration) for operation of the RDATA command.

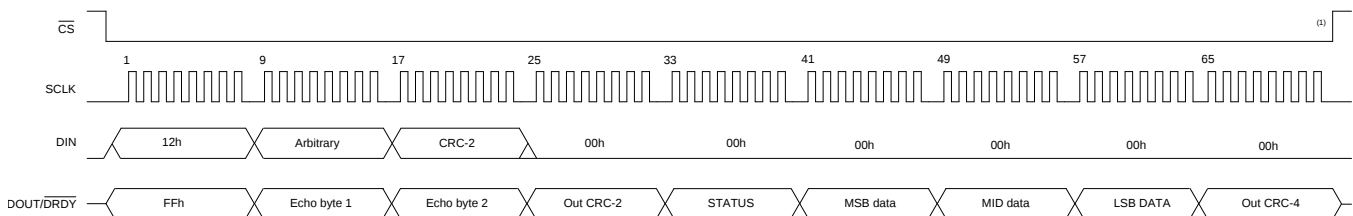
**表 21. RDATA Command**

| DIRECTION                      | BYTE 1 | BYTE 2      | BYTE 3                | BYTE 4    | BYTE 5                | BYTE 6   | BYTE 7   | BYTE 8   | BYTE 9                 |
|--------------------------------|--------|-------------|-----------------------|-----------|-----------------------|----------|----------|----------|------------------------|
| <b>No CRC mode</b>             |        |             |                       |           |                       |          |          |          |                        |
| DIN                            | 12h    | Arbitrary   | 00h                   | 00h       | 00h                   | 00h      |          |          |                        |
| DOUT/ $\overline{\text{DRDY}}$ | FFh    | Echo byte 1 | STATUS <sup>(1)</sup> | MSB data  | MID data              | LSB data |          |          |                        |
| <b>CRC mode</b>                |        |             |                       |           |                       |          |          |          |                        |
| DIN                            | 12h    | Arbitrary   | CRC-2                 | 00h       | 00h                   | 00h      | 00h      | 00h      | 00h                    |
| DOUT/ $\overline{\text{DRDY}}$ | FFh    | Echo byte 1 | Echo byte 2           | Out CRC-2 | STATUS <sup>(1)</sup> | MSB data | MID data | LSB data | Out CRC-3 or Out CRC-4 |

(1) Optional STATUS byte.



NOTE:  $\overline{\text{CS}}$  can be tied low.

**图 76. Conversion Data Read Operation (STATUS Byte and CRC Mode Disabled)**


NOTE:  $\overline{\text{CS}}$  can be tied low.

**图 77. Conversion Data Read Operation (STATUS Byte and CRC Mode Enabled)**

### 10.5.5.6 SYOCAL Command

This command is used for system offset calibration. See the [Offset System-Calibration \(SYOCAL\)](#) section for details. 表 22 shows the SYOCAL command byte sequence.

**表 22. SYOCAL Command**

| DIRECTION                      | BYTE 1 | BYTE 2      | BYTE 3      | BYTE 4    |
|--------------------------------|--------|-------------|-------------|-----------|
| <b>No CRC mode</b>             |        |             |             |           |
| DIN                            | 16h    | Arbitrary   |             |           |
| DOUT/ $\overline{\text{DRDY}}$ | FFh    | Echo byte 1 |             |           |
| <b>CRC mode</b>                |        |             |             |           |
| DIN                            | 16h    | Arbitrary   | CRC-2       | 00h       |
| DOUT/ $\overline{\text{DRDY}}$ | FFh    | Echo byte 1 | Echo Byte 2 | Out CRC-2 |

### 10.5.5.7 GANCAL Command

This command is for gain calibration. See the [Full-Scale Calibration \(GANCAL\)](#) section for details. 表 23 shows the GANCAL command byte sequence.

表 23. GANCAL Command

| DIRECTION          | BYTE 1 | BYTE 2      | BYTE 3      | BYTE 4    |
|--------------------|--------|-------------|-------------|-----------|
| <b>No CRC mode</b> |        |             |             |           |
| DIN                | 17h    | Arbitrary   |             |           |
| DOUT/DRDY          | FFh    | Echo byte 1 |             |           |
| <b>CRC mode</b>    |        |             |             |           |
| DIN                | 17h    | Arbitrary   | CRC-2       | 00h       |
| DOUT/DRDY          | FFh    | Echo byte 1 | Echo Byte 2 | Out CRC-2 |

### 10.5.5.8 SFOCAL Command

This command is used for *self* offset calibration. See the [Offset Self-Calibration \(SFOCAL\)](#) section for details. 表 24 shows the SFOCAL command byte sequence.

表 24. SFOCAL Command

| DIRECTION          | BYTE 1 | BYTE 2      | BYTE 3      | BYTE 4    |
|--------------------|--------|-------------|-------------|-----------|
| <b>No CRC mode</b> |        |             |             |           |
| DIN                | 19h    | Arbitrary   |             |           |
| DOUT/DRDY          | FFh    | Echo byte 1 |             |           |
| <b>CRC mode</b>    |        |             |             |           |
| DIN                | 19h    | Arbitrary   | CRC-2       | 00h       |
| DOUT/DRDY          | FFh    | Echo byte 1 | Echo Byte 2 | Out CRC-2 |

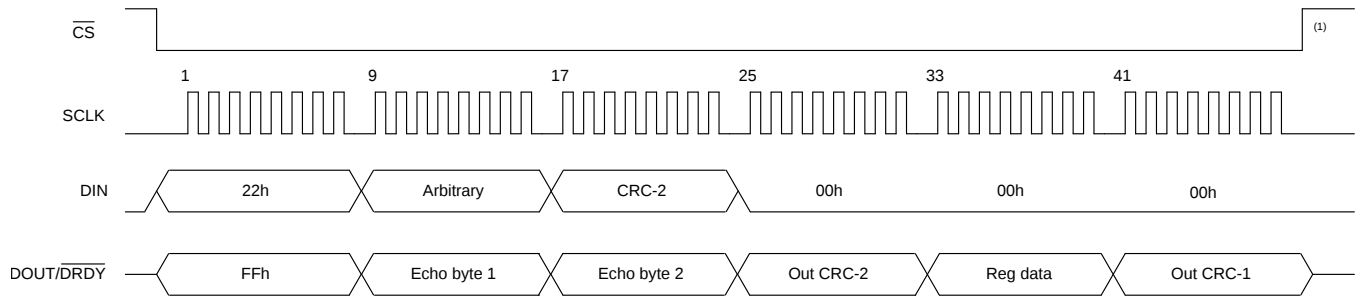
### 10.5.5.9 RREG Command

Use the RREG command to read register data. The register data are read one byte at a time by issuing the RREG command for each operation. Add the register address (rrh) to the base opcode (20h) to construct the command byte (20h + rrh). 表 25 illustrates the command byte sequence. The ADC responds with the register data byte, most significant bit first. The response to registers outside the valid address range is 00h. 图 78 depicts an example of the register read operation. The Out CRC-1 byte is the CRC calculated for the register data byte.

表 25. RREG Command

| DIRECTION          | BYTE 1                   | BYTE 2      | BYTE 3        | BYTE 4    | BYTE 5        | BYTE 6    |
|--------------------|--------------------------|-------------|---------------|-----------|---------------|-----------|
| <b>No CRC mode</b> |                          |             |               |           |               |           |
| DIN                | 20h + rrh <sup>(1)</sup> | Arbitrary   | 00h           |           |               |           |
| DOUT/DRDY          | FFh                      | Echo byte 1 | Register data |           |               |           |
| <b>CRC mode</b>    |                          |             |               |           |               |           |
| DIN                | 20h + rrh                | Arbitrary   | CRC-2         | 00h       | 00h           | 00h       |
| DOUT/DRDY          | FFh                      | Echo byte 1 | Echo byte 2   | Out CRC-2 | Register data | Out CRC-1 |

(1) rrh = 5-bit register address.



NOTE:  $\overline{CS}$  can be tied low.

**图 78. Register Read Operation (address = 02h, CRC Mode Enabled)**

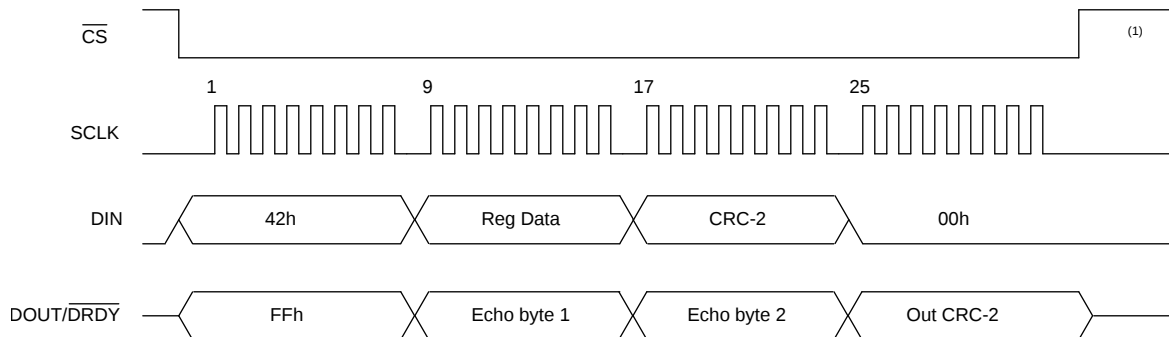
#### 10.5.5.10 WREG Command

Use the WREG command to write register data. The register data are written one byte at a time by issuing the WREG command for each operation. Add the register address (rrh) to the base opcode (40h) to construct the command byte (40h + rrh). 表 26 shows the command byte sequence. 图 79 shows an example of the WREG operation. Be aware that writing to certain registers results in conversion restart. 表 29 lists the registers that restart an ongoing conversion when written to. Do not write to registers outside the address range.

**表 26. WREG Command**

| DIRECTION          | BYTE 1                   | BYTE 2        | BYTE 3      | BYTE 4    |
|--------------------|--------------------------|---------------|-------------|-----------|
| <b>No CRC mode</b> |                          |               |             |           |
| DIN                | 40h + rrh <sup>(1)</sup> | Register data |             |           |
| DOUT/DRDY          | FFh                      | Echo byte 1   |             |           |
| <b>CRC mode</b>    |                          |               |             |           |
| DIN                | 40h + rrh                | Register data | CRC-2       | 00h       |
| DOUT/DRDY          | FFh                      | Echo byte 1   | Echo byte 2 | Out CRC-2 |

(1) rrh = 5-bit register address.



NOTE:  $\overline{CS}$  can be tied low.

**图 79. Register Write Operation (address = 02h, CRC Mode Enabled)**

### 10.5.5.11 LOCK Command

The LOCK command locks-out write access to the registers including the calibration registers that are changed by calibration commands. The default mode is UNLOCK. Read access is allowed in LOCK mode. 表 27 shows the LOCK command byte sequence.

**表 27. LOCK Command**

| DIRECTION                      | BYTE 1 | BYTE 2      | BYTE 3     | BYTE 4    |
|--------------------------------|--------|-------------|------------|-----------|
| <b>No CRC mode</b>             |        |             |            |           |
| DIN                            | F2h    | Arbitrary   |            |           |
| DOUT/ $\overline{\text{DRDY}}$ | FFh    | Echo byte 1 |            |           |
| <b>CRC mode</b>                |        |             |            |           |
| DIN                            | F2h    | Arbitrary   | CRC-2      | 00h       |
| DOUT/ $\overline{\text{DRDY}}$ | FFh    | Echo byte 1 | Echo Byte2 | out CRC-2 |

### 10.5.5.12 UNLOCK Command

The UNLOCK command allows register write access, including access to the contents of the calibration registers that can be changed by the calibration commands. 表 28 shows the UNLOCK command byte sequence.

**表 28. UNLOCK Command**

| DIRECTION                      | BYTE 1 | BYTE 2      | BYTE 3     | BYTE 4    |
|--------------------------------|--------|-------------|------------|-----------|
| <b>No CRC mode</b>             |        |             |            |           |
| DIN                            | F5h    | Arbitrary   |            |           |
| DOUT/ $\overline{\text{DRDY}}$ | FFh    | Echo byte 1 |            |           |
| <b>CRC mode</b>                |        |             |            |           |
| DIN                            | F5h    | Arbitrary   | CRC-2      | 00h       |
| DOUT/ $\overline{\text{DRDY}}$ | FFh    | Echo byte 1 | Echo Byte2 | Out CRC-2 |

## 10.6 Register Map

The register map consists of 19, one-byte registers. Collectively, the registers are used to configure the ADC to the desired operating mode. Access the registers by using the RREG and WREG (read-register and write-register) commands. Register data are accessed one register byte at a time for each command operation. At power-on or device reset, the registers are reset to the default values, as shown in the *Default* column of 表 29. Writing new data to certain registers causes the ADC conversion in progress to restart. These registers are listed in the *Restart* column in 表 29.

Register-write access is enabled or disabled by the UNLOCK and LOCK commands, respectively. The default mode is register UNLOCK. See the [LOCK Command](#) section for more details.

**表 29. Register Map Summary**

| (rrh) | REGISTER | DEFAULT | RESTART | BIT 7         | BIT 6     | BIT 5    | BIT 4    | BIT 3         | BIT 2       | BIT 1      | BIT 0 |
|-------|----------|---------|---------|---------------|-----------|----------|----------|---------------|-------------|------------|-------|
| 00h   | ID       | xxh     |         | DEV_ID[3:0]   |           |          |          | REV_ID[3:0]   |             |            |       |
| 01h   | STATUS   | 01h     |         | LOCK          | CRCERR    | PGAL_ALM | PGAH_ALM | REFL_ALM      | DRDY        | CLOCK      | RESET |
| 02h   | MODE0    | 24h     | Yes     | DR[4:0]       |           |          |          |               | FILTER[2:0] |            |       |
| 03h   | MODE1    | 01h     | Yes     | 0             | CHOP[1:0] |          | CONVRT   | DELAY[3:0]    |             |            |       |
| 04h   | MODE2    | 00h     |         | GPIO_CON[3:0] |           |          |          | GPIO_DIR[3:0] |             |            |       |
| 05h   | MODE3    | 00h     |         | PWDN          | STATENB   | CRCENB   | SPITIM   | GPIO_DAT[3:0] |             |            |       |
| 06h   | REF      | 05h     | Yes     | 0             | 0         | 0        | REFENB   | RMUXP[1:0]    |             | RMUXN[1:0] |       |
| 07h   | OFCAL0   | 00h     |         | OFC[7:0]      |           |          |          |               |             |            |       |
| 08h   | OFCAL1   | 00h     |         | OFC[15:8]     |           |          |          |               |             |            |       |
| 09h   | OFCAL2   | 00h     |         | OFC[23:16]    |           |          |          |               |             |            |       |
| 0Ah   | FSCAL0   | 00h     |         | FSC[7:0]      |           |          |          |               |             |            |       |
| 0Bh   | FSCAL1   | 00h     |         | FSC[15:8]     |           |          |          |               |             |            |       |
| 0Ch   | FSCAL2   | 40h     |         | FSC[23:16]    |           |          |          |               |             |            |       |
| 0Dh   | IMUX     | FFh     |         | IMUX2[3:0]    |           |          |          | IMUX1[3:0]    |             |            |       |
| 0Eh   | IMAG     | 00h     |         | IMAG2[3:0]    |           |          |          | IMAG1[3:0]    |             |            |       |
| 0Fh   | RESERVED | 00h     |         | 00h           |           |          |          |               |             |            |       |
| 10h   | PGA      | 00h     | Yes     | BYPASS        | 0         | 0        | 0        | 0             | GAIN[2:0]   |            |       |
| 11h   | INPMUX   | FFh     | Yes     | MUXP[3:0]     |           |          |          | MUXN[3:0]     |             |            |       |
| 12h   | INPBias  | 00h     | Yes     | 0             | 0         | 0        | VBIAS    | BOCSP         | BOCS[2:0]   |            |       |

### 10.6.1 Device Identification (ID) Register (address = 00h) [reset = xxh]

**图 80. ID Register**

|             |   |   |   |             |   |   |   |
|-------------|---|---|---|-------------|---|---|---|
| 7           | 6 | 5 | 4 | 3           | 2 | 1 | 0 |
| DEV_ID[3:0] |   |   |   | REV_ID[3:0] |   |   |   |

NOTE: Reset values are device dependent

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**表 30. ID Register Field Descriptions**

| Bit | Field       | Type | Reset | Description                                                                    |
|-----|-------------|------|-------|--------------------------------------------------------------------------------|
| 7:4 | DEV_ID[3:0] | R    | xh    | <b>Device ID</b><br>1000: ADS1261, ADS1261B<br>1010: ADS1260B                  |
| 3:0 | REV_ID[3:0] | R    | xh    | <b>Revision ID</b><br><i>Note: Revision ID can change without notification</i> |

## 10.6.2 Device Status (STATUS) Register (address = 01h) [reset = 01h]

### 81. STATUS Register

| 7    | 6      | 5        | 4        | 3        | 2    | 1     | 0      |
|------|--------|----------|----------|----------|------|-------|--------|
| LOCK | CRCERR | PGAL_ALM | PGAH_ALM | REFL_ALM | DRDY | CLOCK | RESET  |
| R-0h | R/W-0h | R-0h     | R-0h     | R-0h     | R-0h | R-xh  | R/W-1h |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**表 31. STATUS Register Field Descriptions**

| Bit | Field    | Type | Reset | Description                                                                                                                                                                                                             |
|-----|----------|------|-------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7   | LOCK     | R    | 0h    | <b>Register Lock Status</b><br>Indicates register lock status. Register writes are locked by the LOCK command and unlocked by the UNLOCK command.<br>0: Register write not locked (default)<br>1: Register write locked |
| 6   | CRCERR   | R/W  | 0h    | <b>CRC Error</b><br>Indicates that a CRC error is detected by the ADC. The CRC error bit remains set until cleared by the user.<br>0: No CRC error<br>1: CRC error                                                      |
| 5   | PGAL_ALM | R    | 0h    | <b>PGA Low Alarm</b><br>Indicates PGA output voltage is below the low limit. The alarm resets at the start of conversion cycles.<br>0: No Alarm<br>1: Alarm                                                             |
| 4   | PGAH_ALM | R    | 0h    | <b>PGA High Alarm</b><br>Indicates PGA output voltage is above the high limit. The alarm resets at the start of conversion cycles.<br>0: No Alarm<br>1: Alarm                                                           |
| 3   | REFL_ALM | R    | 0h    | <b>Reference Low Alarm</b><br>Indicates reference voltage is below the low limit. The alarm resets at the start of conversion cycles.<br>0: No Alarm<br>1: Alarm                                                        |
| 2   | DRDY     | R    | 0h    | <b>Data Ready</b><br>Indicates conversion data ready.<br>0: Conversion data <b>not new</b> since the previous read operation<br>1: Conversion data <b>new</b> since the previous read operation                         |
| 1   | CLOCK    | R    | xh    | <b>Clock</b><br>Indicates internal or external clock mode. The ADC automatically selects the clock source.<br>0: ADC clock is internal<br>1: ADC clock is external                                                      |
| 0   | RESET    | R/W  | 1h    | <b>Reset</b><br>Indicates ADC reset. Clear the bit to detect next device reset.<br>0: No reset<br>1: Reset (default)                                                                                                    |

**10.6.3 Mode 0 (MODE0) Register (address = 02h) [reset = 24h]**
**✎ 82. MODE0 Register**

| 7       | 6 | 5 | 4 | 3 | 2           | 1 | 0 |
|---------|---|---|---|---|-------------|---|---|
| DR[4:0] |   |   |   |   | FILTER[2:0] |   |   |
| R/W-4h  |   |   |   |   | R/W-4h      |   |   |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**表 32. MODE0 Register Field Descriptions**

| Bit | Field       | Type | Reset | Description                                                                                                                                                                                                                                                                                                                                                                                                                |
|-----|-------------|------|-------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7:3 | DR[4:0]     | R/W  | 4h    | <b>Data Rate</b><br>Select the ADC data rate.<br>00000: 2.5 SPS<br>00001: 5 SPS<br>00010: 10 SPS<br>00011: 16.7 SPS<br>00100: 20 SPS (default)<br>00101: 50 SPS<br>00110: 60 SPS<br>00111: 100 SPS<br>01000: 400 SPS<br>01001: 1200 SPS<br>01010: 2400 SPS<br>01011: 4800 SPS<br>01100: 7200 SPS<br>01101: 14400 SPS<br>01110: 19200 SPS<br>01111: 25600 SPS<br>10000 - 11111: 40000 SPS ( $f_{CLK} = 10.24 \text{ MHz}$ ) |
| 2:0 | FILTER[2:0] | R/W  | 4h    | <b>Digital Filter</b><br>Select the digital filter mode.<br>000: sinc1<br>001: sinc2<br>010: sinc3<br>011: sinc4<br>100: FIR (default)<br>101: Reserved<br>110: Reserved<br>111: Reserved                                                                                                                                                                                                                                  |

### 10.6.4 Mode 1 (MODE1) Register (address = 03h) [reset = 01h]

#### ☒ 83. MODE1 Register

| 7      | 6         | 5 | 4      | 3          | 2 | 1 | 0 |
|--------|-----------|---|--------|------------|---|---|---|
| 0      | CHOP[1:0] |   | CONVRT | DELAY[3:0] |   |   |   |
| R/W-0h | R/W-0h    |   | R/W-0h | R/W-1h     |   |   |   |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**表 33. MODE1 Register Field Descriptions**

| Bit | Field      | Type | Reset | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
|-----|------------|------|-------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7   | 0          | R/W  | 0h    | <b>Reserved</b><br>Always write 0                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
| 6:5 | CHOP[1:0]  | R/W  | 0h    | <b>Chop and AC-Excitation Modes</b><br>Select the Chop and AC-excitation modes.<br>00: Normal mode (default)<br>01: Chop mode<br>10: 2-wire AC-excitation mode ( ADS1261 only)<br>11: 4-wire AC-excitation mode ( ADS1261 only)                                                                                                                                                                                                                                                                 |
| 4   | CONVRT     | R/W  | 0h    | <b>ADC Conversion Mode</b><br>Select the ADC conversion mode.<br>0: Continuous conversions (default)<br>1: Pulse (one shot) conversion                                                                                                                                                                                                                                                                                                                                                          |
| 3:0 | DELAY[3:0] | R/W  | 1h    | <b>Conversion Start Delay</b><br>Program the time delay at conversion start. Delay values are with $f_{CLK} = 7.3728$ MHz.<br>0000: 0 $\mu$ s (not for 25600 SPS or 40000 SPS operation)<br>0001: 50 $\mu$ s (default)<br>0010: 59 $\mu$ s<br>0011: 67 $\mu$ s<br>0100: 85 $\mu$ s<br>0101: 119 $\mu$ s<br>0110: 189 $\mu$ s<br>0111: 328 $\mu$ s<br>1000: 605 $\mu$ s<br>1001: 1.16 ms<br>1010: 2.27 ms<br>1011: 4.49 ms<br>1100: 8.93 ms<br>1101: 17.8 ms<br>1110: Reserved<br>1111: Reserved |

**10.6.5 Mode 2 (MODE2) Register (address = 04h) [reset = 00h]**
**✎ 84. MODE2 Register**

|               |   |   |   |               |   |   |   |
|---------------|---|---|---|---------------|---|---|---|
| 7             | 6 | 5 | 4 | 3             | 2 | 1 | 0 |
| GPIO_CON[3:0] |   |   |   | GPIO_DIR[3:0] |   |   |   |
| R/W-0h        |   |   |   | R/W-0h        |   |   |   |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**表 34. MODE2 Register Field Descriptions<sup>(1)</sup>**

| Bit | Field       | Type | Reset | Description                                                                                                                                      |
|-----|-------------|------|-------|--------------------------------------------------------------------------------------------------------------------------------------------------|
| 7   | GPIO_CON[3] | R/W  | 0h    | <b>GPIO3 Pin Connection</b><br>Connect GPIO3 to analog input AIN5.<br>0: GPIO3 not connected to AIN5 (default)<br>1: GPIO3 connected to AIN5     |
| 6   | GPIO_CON[2] | R/W  | 0h    | <b>GPIO2 Pin Connection</b><br>Connect GPIO2 to analog input AIN4.<br>0: GPIO2 not connected to AIN4 (default)<br>1: GPIO2 connected to AIN4     |
| 5   | GPIO_CON[1] | R/W  | 0h    | <b>GPIO1 Pin Connection</b><br>Connect GPIO1 to analog input AIN3.<br>0: GPIO1 not connected to AIN3 (default)<br>1: GPIO1 connected to AIN3     |
| 4   | GPIO_CON[0] | R/W  | 0h    | <b>GPIO0 Pin Connection</b><br>Connect GPIO0 to analog input AIN2.<br>0: GPIO0 not connected to AIN2 (default)<br>1: GPIO0 connected to AIN2     |
| 3   | GPIO_DIR[3] | R/W  | 0h    | <b>GPIO3 Pin Direction</b><br>Configure GPIO3 as a GPIO input or GPIO output on AIN5.<br>0: GPIO3 is an output (default)<br>1: GPIO3 is an input |
| 2   | GPIO_DIR[2] | R/W  | 0h    | <b>GPIO2 Pin Direction</b><br>Configure GPIO2 as a GPIO input or GPIO output on AIN4.<br>0: GPIO2 is an output (default)<br>1: GPIO2 is an input |
| 1   | GPIO_DIR[1] | R/W  | 0h    | <b>GPIO1 Pin Direction</b><br>Configure GPIO1 as a GPIO input or GPIO output on AIN3.<br>0: GPIO1 is an output (default)<br>1: GPIO1 is an input |
| 0   | GPIO_DIR[0] | R/W  | 0h    | <b>GPIO0 Pin Direction</b><br>Configure GPIO0 as a GPIO input or GPIO output on AIN2.<br>0: GPIO0 is an output (default)<br>1: GPIO0 is an input |

(1) ADS1261 and ADS1261B only.

### 10.6.6 Mode 3 (MODE3) Register (address = 05h) [reset = 00h]

#### ☒ 85. MODE3 Register

| 7      | 6       | 5      | 4      | 3             | 2 | 1 | 0 |
|--------|---------|--------|--------|---------------|---|---|---|
| PWDN   | STATENB | CRCENB | SPITIM | GPIO_DAT[3:0] |   |   |   |
| R/W-0h | R/W-0h  | R/W-0h | R/W-0h | R/W-0h        |   |   |   |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**表 35. MODE3 Register Field Descriptions**

| Bit | Field                      | Type | Reset | Description                                                                                                                                   |
|-----|----------------------------|------|-------|-----------------------------------------------------------------------------------------------------------------------------------------------|
| 7   | PWDN                       | R/W  | 0h    | <b>Software Power-down Mode</b><br>Select the software power-down mode.<br>0: Normal mode (default)<br>1: Software power-down mode            |
| 6   | STATENB                    | R/W  | 0h    | <b>STATUS Byte</b><br>Enable the Status byte for the conversion data read operation.<br>0: No Status byte (default)<br>1: Status byte enabled |
| 5   | CRCENB                     | R/W  | 0h    | <b>CRC Data Verification</b><br>Enable CRC data verification.<br>0: No CRC (default)<br>1: CRC enabled                                        |
| 4   | SPITIM                     | R/W  | 0h    | <b>SPI Auto-Reset Function</b><br>Enable the SPI auto-reset function.<br>0: SPI auto-reset disabled (default)<br>1: SPI auto-reset enabled    |
| 3   | GPIO_DAT[3] <sup>(1)</sup> | R/W  | 0h    | <b>GPIO3 Data</b><br>Read or write the GPIO3 data on AIN5.<br>0: GPIO3 is low (default)<br>1: GPIO3 is high                                   |
| 2   | GPIO_DAT[2] <sup>(1)</sup> | R/W  | 0h    | <b>GPIO2 Data</b><br>Read or write the GPIO2 data on AIN4.<br>0: GPIO2 is low (default)<br>1: GPIO2 is high                                   |
| 1   | GPIO_DAT[1] <sup>(1)</sup> | R/W  | 0h    | <b>GPIO1 Data</b><br>Read or write the GPIO1 data on AIN3.<br>0: GPIO1 is low (default)<br>1: GPIO1 is high                                   |
| 0   | GPIO_DAT[0] <sup>(1)</sup> | R/W  | 0h    | <b>GPIO0 Data</b><br>Read or write the GPIO1 data on AIN3.<br>0: GPIO0 is low (default)<br>1: GPIO0 is high                                   |

(1) ADS1261 and ADS1261B only.

**10.6.7 Reference Configuration (REF) Register (address = 06h) [reset = 05h]**
**图 86. REF Register**

| 7      | 6      | 5      | 4      | 3          | 2 | 1          | 0 |
|--------|--------|--------|--------|------------|---|------------|---|
| 0      | 0      | 0      | REFENB | RMUXP[1:0] |   | RMUXN[1:0] |   |
| R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-1h     |   | R/W-1h     |   |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**表 36. REF Register Field Descriptions**

| Bit | Field      | Type | Reset | Description                                                                                                                                                                                         |
|-----|------------|------|-------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7:5 | 0          | R/W  | 0h    | <b>Reserved</b><br>Always write 0h                                                                                                                                                                  |
| 4   | REFENB     | R/W  | 0h    | <b>Internal Reference Enable</b><br>Enable the internal reference.<br>0: Internal reference disabled (default)<br>1: Internal reference enabled                                                     |
| 3:2 | RMUXP[1:0] | R/W  | 1h    | <b>Reference Positive Input</b><br>Select the positive reference input.<br>00: Internal reference positive<br>01: AVDD internal (default)<br>10: AIN0 external<br>11: AIN2 external ( ADS1261 only) |
| 1:0 | RMUXN[1:0] | R/W  | 1h    | <b>Reference Negative Input</b><br>Select the negative reference input.<br>00: Internal reference negative<br>01: AVSS internal (default)<br>10: AIN1 external<br>11: AIN3 external ( ADS1261 only) |

### 10.6.8 Offset Calibration (OFCALx) Registers (address = 07h, 08h, 09h) [reset = 00h, 00h, 00h]

图 87. OFCAL0, OFCAL1, OFCAL2 Registers

|            |    |    |    |    |    |    |    |
|------------|----|----|----|----|----|----|----|
| 7          | 6  | 5  | 4  | 3  | 2  | 1  | 0  |
| OFC[7:0]   |    |    |    |    |    |    |    |
| R/W-00h    |    |    |    |    |    |    |    |
| 15         | 14 | 13 | 12 | 11 | 10 | 9  | 8  |
| OFC[15:8]  |    |    |    |    |    |    |    |
| R/W-00h    |    |    |    |    |    |    |    |
| 23         | 22 | 21 | 20 | 19 | 18 | 17 | 16 |
| OFC[23:16] |    |    |    |    |    |    |    |
| R/W-00h    |    |    |    |    |    |    |    |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

表 37. OFCAL0, OFCAL1, OFCAL2 Registers Field Description

| Bit  | Field     | Type | Reset   | Description                                                                                                                                                                                                                                  |
|------|-----------|------|---------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 23:0 | OFC[23:0] | R/W  | 000000h | <b>Offset Calibration</b><br>These three registers are the 24-bit offset calibration word. The offset calibration is two's complement format. The ADC subtracts the offset value from the conversion result before the full-scale operation. |

### 10.6.9 Full-Scale Calibration (FSCALx) Registers (address = 0Ah, 0Bh, 0Ch) [reset = 00h, 00h, 40h]

图 88. FSCAL0, FSCAL1, FSCAL2 Registers

|            |    |    |    |    |    |    |    |
|------------|----|----|----|----|----|----|----|
| 7          | 6  | 5  | 4  | 3  | 2  | 1  | 0  |
| FSC[7:0]   |    |    |    |    |    |    |    |
| R/W-00h    |    |    |    |    |    |    |    |
| 15         | 14 | 13 | 12 | 11 | 10 | 9  | 8  |
| FSC[15:8]  |    |    |    |    |    |    |    |
| R/W-00h    |    |    |    |    |    |    |    |
| 23         | 22 | 21 | 20 | 19 | 18 | 17 | 16 |
| FSC[23:16] |    |    |    |    |    |    |    |
| R/W-40h    |    |    |    |    |    |    |    |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

表 38. FSCAL0, FSCAL1, FSCAL2 Registers Field Description

| Bit  | Field     | Type | Reset   | Description                                                                                                                                                                                                                                                                                                          |
|------|-----------|------|---------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 23:0 | FSC[23:0] | R/W  | 400000h | <b>Full-Scale Calibration</b><br>These three registers are the 24-bit full scale calibration word. The full-scale calibration is straight binary format. The ADC divides the register value by 400000h then multiplies the result with the conversion data. The scaling operation occurs after the offset operation. |

**10.6.10 IDAC Multiplexer (IMUX) Register (address = 0Dh) [reset = FFh]**
**图 89. IMUX Register**

| 7          | 6 | 5 | 4 | 3          | 2 | 1 | 0 |
|------------|---|---|---|------------|---|---|---|
| IMUX2[3:0] |   |   |   | IMUX1[3:0] |   |   |   |
| R/W-Fh     |   |   |   | R/W-Fh     |   |   |   |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**表 39. IMUX Register Field Descriptions**

| Bit | Field      | Type | Reset | Description                                                                                                                                                                                                                                                                                                                                                                                                                                               |
|-----|------------|------|-------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7:4 | IMUX2[3:0] | R/W  | Fh    | <b>IDAC2 Output Multiplexer</b><br>Select the IDAC2 analog input pin connection.<br>0000: AIN0<br>0001: AIN1<br>0010: AIN2<br>0011: AIN3<br>0100: AIN4<br>0101: AIN5 ( ADS1261 only)<br>0110: AIN6 ( ADS1261 only)<br>0111: AIN7 ( ADS1261 only)<br>1000: AIN8 ( ADS1261 only)<br>1001: AIN9 ( ADS1261 only)<br>1010: AINCOM<br>1011: No connection<br>1100: No connection<br>1101: No connection<br>1110: No connection<br>1111: No connection (default) |
| 3:0 | IMUX1[3:0] | R/W  | Fh    | <b>IDAC1 Output Multiplexer</b><br>Select the IDAC1 analog input pin connection.<br>0000: AIN0<br>0001: AIN1<br>0010: AIN2<br>0011: AIN3<br>0100: AIN4<br>0101: AIN5 ( ADS1261 only)<br>0110: AIN6 ( ADS1261 only)<br>0111: AIN7 ( ADS1261 only)<br>1000: AIN8 ( ADS1261 only)<br>1001: AIN9 ( ADS1261 only)<br>1010: AINCOM<br>1011: No connection<br>1100: No connection<br>1101: No connection<br>1110: No connection<br>1111: No connection (default) |

### 10.6.11 IDAC Magnitude (IMAG) Register (address = 0Eh) [reset = 00h]

#### ☒ 90. IMAG Register

| 7          | 6 | 5 | 4 | 3          | 2 | 1 | 0 |
|------------|---|---|---|------------|---|---|---|
| IMAG2[3:0] |   |   |   | IMAG1[3:0] |   |   |   |
| R/W-0h     |   |   |   | R/W-0h     |   |   |   |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**表 40. IMAG Register Field Descriptions**

| Bit | Field      | Type | Reset | Description                                                                                                                                                                                                                                                                                                                                                                                   |
|-----|------------|------|-------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7:4 | IMAG2[3:0] | R/W  | 0h    | <b>IDAC2 Current Magnitude</b><br>Select the magnitude of current source IDAC2.<br>0000: Off (default)<br>0001: 50 $\mu$ A<br>0010: 100 $\mu$ A<br>0011: 250 $\mu$ A<br>0100: 500 $\mu$ A<br>0101: 750 $\mu$ A<br>0110: 1000 $\mu$ A<br>0111: 1500 $\mu$ A<br>1000: 2000 $\mu$ A<br>1001: 2500 $\mu$ A<br>1010: 3000 $\mu$ A<br>1011: Off<br>1100: Off<br>1101: Off<br>1110: Off<br>1111: Off |
| 3:0 | IMAG1[3:0] | R/W  | 0h    | <b>IDAC1 Current Magnitude</b><br>Select the magnitude of current source IDAC1.<br>0000: Off (default)<br>0001: 50 $\mu$ A<br>0010: 100 $\mu$ A<br>0011: 250 $\mu$ A<br>0100: 500 $\mu$ A<br>0101: 750 $\mu$ A<br>0110: 1000 $\mu$ A<br>0111: 1500 $\mu$ A<br>1000: 2000 $\mu$ A<br>1001: 2500 $\mu$ A<br>1010: 3000 $\mu$ A<br>1011: Off<br>1100: Off<br>1101: Off<br>1110: Off<br>1111: Off |

**10.6.12 Reserved (RESERVED) Register (address = 0Fh) [reset = 00h]**
**图 91. RESERVED Register**

|      |      |      |      |      |      |      |      |
|------|------|------|------|------|------|------|------|
| 7    | 6    | 5    | 4    | 3    | 2    | 1    | 0    |
| 0    | 0    | 0    | 0    | 0    | 0    | 0    | 0    |
| R-0h | R-0h | R-0h | R-0h | R-0h | R-0h | R-0h | R-0h |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**表 41. RESERVED Register Field Descriptions**

| Bit | Field | Type | Reset | Description                                                     |
|-----|-------|------|-------|-----------------------------------------------------------------|
| 7:0 | 0     | R    | 0h    | <b>Reserved</b><br>These bits are read only and always return 0 |

**10.6.13 PGA Configuration (PGA) Register (address = 10h) [reset = 00h]**
**图 92. PGA Register**

|        |        |        |        |        |   |           |   |
|--------|--------|--------|--------|--------|---|-----------|---|
| 7      | 6      | 5      | 4      | 3      | 2 | 1         | 0 |
| BYPASS | 0      | 0      | 0      | 0      |   | GAIN[2:0] |   |
| R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h |   | R/W-0h    |   |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**表 42. PGA Register Field Descriptions**

| Bit | Field     | Type | Reset | Description                                                                                                                    |
|-----|-----------|------|-------|--------------------------------------------------------------------------------------------------------------------------------|
| 7   | BYPASS    | R/W  | 0h    | <b>PGA Bypass Mode</b><br>Select the PGA mode.<br>0: PGA mode (default)<br>1: PGA bypass                                       |
| 6:3 | 0         | R/W  | 0h    | <b>Reserved</b><br>Always write 0                                                                                              |
| 2:0 | GAIN[2:0] | R/W  | 0h    | <b>Gain</b><br>Select the gain.<br>000: 1 (default)<br>001: 2<br>010: 4<br>011: 8<br>100: 16<br>101: 32<br>110: 64<br>111: 128 |

### 10.6.14 Input Multiplexer (INPMUX) Register (address = 11h) [reset = FFh]

#### 93. INPMUX Register

| 7         | 6 | 5 | 4 | 3         | 2 | 1 | 0 |
|-----------|---|---|---|-----------|---|---|---|
| MUXP[3:0] |   |   |   | MUXN[3:0] |   |   |   |
| R/W-Fh    |   |   |   | R/W-Fh    |   |   |   |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**表 43. INPMUX Register Field Descriptions**

| Bit | Field     | Type | Reset | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
|-----|-----------|------|-------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7:4 | MUXP[3:0] | R/W  | Fh    | <b>Positive Input Multiplexer</b><br>Select the positive multiplexer input.<br>0000: AINCOM<br>0001: AIN0<br>0010: AIN1<br>0011: AIN2<br>0100: AIN3<br>0101: AIN4<br>0110: AIN5 ( ADS1261 only)<br>0111: AIN6 ( ADS1261 only)<br>1000: AIN7 ( ADS1261 only)<br>1001: AIN8 ( ADS1261 only)<br>1010: AIN9 ( ADS1261 only)<br>1011: Internal temperature sensor positive<br>1100: Internal (AVDD - AVSS) / 4 positive<br>1101: Internal (DVDD / 4) positive<br>1110: Inputs open<br>1111: Internal connection to V <sub>COM</sub> (default)     |
| 3:0 | MUXN[3:0] | R/W  | Fh    | <b>Negative Input Multiplexer</b><br>Select the negative multiplexer input.<br>0000: AINCOM<br>0001: AIN0<br>0010: AIN1<br>0011: AIN2<br>0100: AIN3<br>0101: AIN4<br>0110: AIN5 ( ADS1261 only)<br>0111: AIN6 ( ADS1261 only)<br>1000: AIN7 ( ADS1261 only)<br>1001: AIN8 ( ADS1261 only)<br>1010: AIN9 ( ADS1261 only)<br>1011: Internal temperature sensor negative<br>1100: Internal (AVDD - AVSS) / 4 negative<br>1101: Internal (DVDD / 4) negative<br>1110: All inputs open<br>1111: Internal connection to V <sub>COM</sub> (default) |

**10.6.15 Input Bias (INPBIAS) Register (address = 12h) [reset = 00h]**
**☒ 94. INPBIAS Register**

| 7      | 6      | 5      | 4      | 3      | 2         | 1 | 0 |
|--------|--------|--------|--------|--------|-----------|---|---|
| 0      | 0      | 0      | VBIAS  | BOCSP  | BOCS[2:0] |   |   |
| R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h    |   |   |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**表 44. INPBIAS Register Field Descriptions**

| Bit | Field     | Type | Reset | Description                                                                                                                                                                                                                          |
|-----|-----------|------|-------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7:5 | 0         | R/W  | 0h    | <b>Reserved</b><br>Always write 0                                                                                                                                                                                                    |
| 4   | VBIAS     | R/W  | 0h    | <b>VBIAS</b><br>Select the VBIAS connection to the AINCOM pin.<br>0: VBIAS disabled (default)<br>1: VBIAS enabled                                                                                                                    |
| 3   | BOCSP     | R/W  | 0h    | <b>Burn-Out Current Source Polarity</b><br>Select the burn-out current source polarity.<br>0: Pull-up mode (default)<br>1: Pull-down mode                                                                                            |
| 2:0 | BOCS[2:0] | R/W  | 0h    | <b>Burn-Out Current Source Magnitude</b><br>Select the burn-out current source magnitude.<br>000: Off (default)<br>001: 50 nA<br>010: 200 nA<br>011: 1 $\mu$ A<br>100: 10 $\mu$ A<br>101: Reserved<br>110: Reserved<br>111: Reserved |

## 11 Application and Implementation

### 注

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 11.1 Application Information

#### 11.1.1 Input Range

In PGA mode, the input voltage must be within the specified input range for linear operation. The following exercise shows how to use 式 5 to verify the input voltage is within specification. The exercise is a thermocouple with the negative lead connected to AINCOM and the level-shift voltage enabled (2.5 V). The gain factor = 32 and the ADC is powered by a single 5-V power supply. The summary of conditions are:

- $V_{AINN}$  = Negative absolute input voltage = 2.5 V
- $V_{AINP}$  = Positive absolute input voltage = 2.56 V
- $V_{IN}$  = Differential input voltage = 60 mV
- $AVDD$  = 4.75 V (worst-case minimum)
- $AVSS$  = 0 V
- Gain = 32

Evaluation of the equation results in:

$$1.23 \text{ V} < 2.5 \text{ V} \text{ and } 2.56 \text{ V} < 3.52 \text{ V}$$

The inequality is satisfied, therefore the absolute input voltages are within the specified PGA input range. The input requirement can also be verified by measuring the PGA output voltages (pins CAPP and CAPN) with a voltmeter. Check that both outputs are within the range:  $AVSS + 0.3 \text{ V} < V_{(CAPP)}$  and  $V_{(CAPN)} < AVDD - 0.3 \text{ V}$ , under the worst-case input and power-supply conditions.

#### 11.1.2 Input Overload

Observe the input overvoltage precautions as outlined in the [ESD Diodes](#) section. If an overvoltage condition occurs on an unused channel, the overvoltage channel may crosstalk to the measurement channel. One solution is to externally clamp the inputs with low-forward voltage diodes as shown in 图 95. The external diodes divert the overvoltage current around the ADC inputs to the power supply and ground. Be aware of the reverse leakage current of the Schottky diodes that may lead to measurement errors.

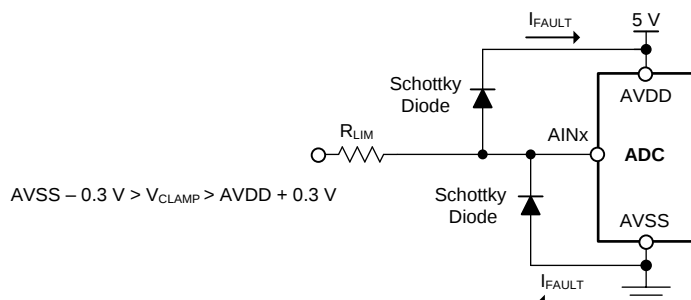
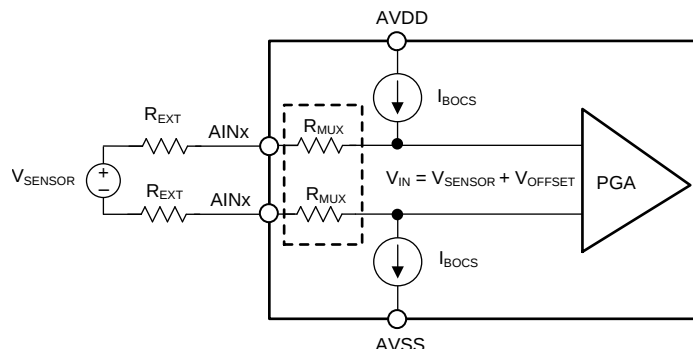


图 95. External Diode Clamps

## Application Information (continued)

### 11.1.3 Burn-Out Current Source

When using the burn-out current sources, be aware of the offset error caused by the currents flowing through impedances in the input path, including the multiplexer resistance  $R_{MUX}$ , external filter resistors and the internal impedance of the sensor  $R_{EXT}$ , as shown in [Figure 96](#). In many cases, the offset error can be calibrated. Be aware that the combination of chop mode and high data rates increases the input current to the PGA. The increased input current can affect the accuracy of the burn-out current sources.



**Figure 96. Burn-Out Current Source Offset Voltage Error**

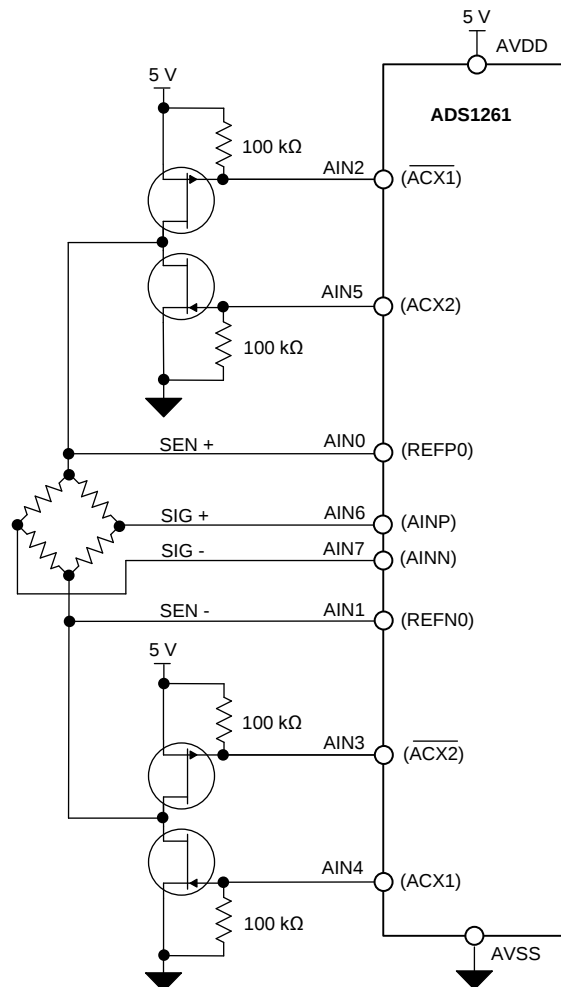
### 11.1.4 Unused Inputs and Outputs

- **Analog inputs:**  
To minimize input leakage of the measurement channel, tie unused inputs to mid-supply voltage ( $(AVDD + AVSS) / 2$  or to  $AVDD$ ).
- **Digital I/O:**  
Not all the digital I/Os may be needed to operate the ADC. Be sure not to float both used and unused digital inputs, including during power-down mode. The following is a summary of the optional digital I/Os connection:
  - $\overline{CS}$ : Tie  $\overline{CS}$  low to permanently enable the serial interface.
  - $CLKIN$ : Tie  $CLKIN$  to  $DGND$  to permanently operate the ADC with the internal oscillator.
  - $START$ : Tie  $START$  to  $DGND$  to control conversions by command. Tie  $START$  to  $DVDD$  to permanently free-run conversions (Continuous-conversion mode only)
  - $RESET$ : Tie  $RESET$  to  $DVDD$  if not using hardware reset. The ADC is reset at power-on. The ADC is also reset by the  $RESET$  command.
  - $PWDN$ : Tie  $PWDN$  to  $DVDD$  if not using the hardware power-down mode. The ADC can be powered down by software.
  - $\overline{DRDY}$ : The functionality of the  $\overline{DRDY}$  output is also provided by the dual-mode  $DOUT/\overline{DRDY}$  pin. The  $DOUT/\overline{DRDY}$  output is active when  $\overline{CS}$  is low. Data ready is also determined by software polling. Because the conversion data are buffered, data can be read at any time without the need to synchronize to data ready.

### Application Information (continued)

### 11.1.5 AC-Excitation

Figure 9-7 shows an example of an AC-excited bridge measurement system. The example shown omits optional filter components for clarity. The transistors switch the bridge excitation voltage by drive signals provided by the GPIO drivers through the analog input pins. The timing of the drive signals are synchronized to the ADC conversions. The drive signals do not overlap in order to avoid bridge commutation during the switching phase of the drive signal. The transistors gate resistors bias the transistors off at power-on. At host start-up, the host configures the ADC to the AC-excitation mode. See Figure 9-7 for timing of the drive signals.



### 97. 4-Wire Drive, AC-Excitation Example

The recommended sequence AC-excitation configuration is as follows:

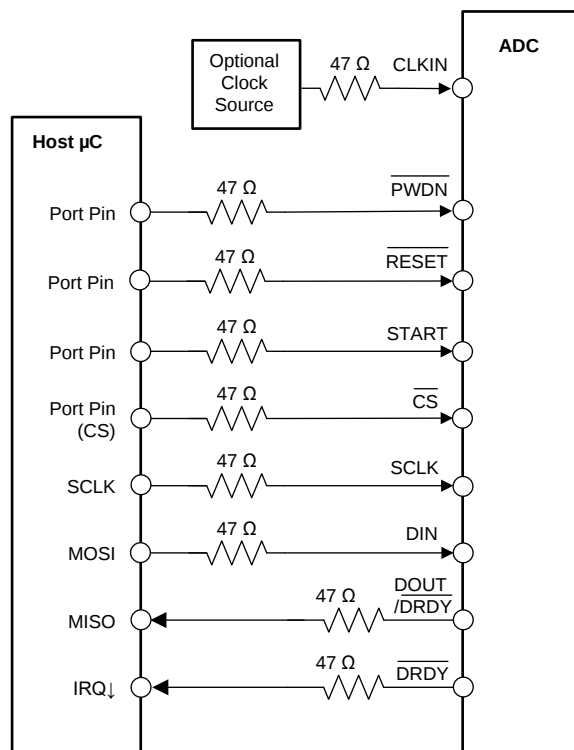
1. Stop conversions by taking the START pin low, or by control of conversions in software mode; send the STOP command
2. Program the input and reference MUX, gain, data rate, filter mode and other configurations as needed
3. Program the 2-wire or 4-wire AC-excitation mode
4. Program the 2 GPIOs or 4 GPIOs internal connection to the analog input pins
5. Program the 2 GPIOs or 4 GPIOs as outputs to enable drive signals at the analog input pins.

Start the conversions. Adjust the time delay parameter as necessary based on the time constant of the input and reference filters.

## Application Information (continued)

### 11.1.6 Serial Interface and Digital Connections

 98 shows an example of the digital connections from a host  $\mu$ C to the ADC. Not all I/O connections are necessary for basic ADC operation; see the [Unused Inputs and Outputs](#) section. Impedance-matching resistors in series with the I/O PCB traces help reduce overshoot and ringing, and is particularly helpful over long trace runs.



 98. Serial Interface and Digital I/O Connections

## 11.2 Typical Application

Figure 99 shows a fault-protected, 3-wire RTD application with hardware-based, lead-wire compensation. Two current sources are used together to compensate the RTD lead wire resistance. One current source (IDAC1) provides excitation to the RTD element through  $R_{LEAD1}$ . The reference voltage of the ADC is derived directly from this current by resistor  $R_{REF}$ . The second current source cancels lead-wire resistance by generating a voltage drop on lead-wire resistance  $R_{LEAD2}$  equal to the voltage drop of  $R_{LEAD1}$ . Because the  $R_{RTD}$  signal voltage is measured differentially via inputs AIN2 and AIN3, the voltages across the lead wire resistance cancel. Resistor  $R_{BIAS}$  level-shifts the RTD signal voltage to within the ADC input range. The current sources route to the RTD element through low  $V_F$  diodes to provide input fault protection.

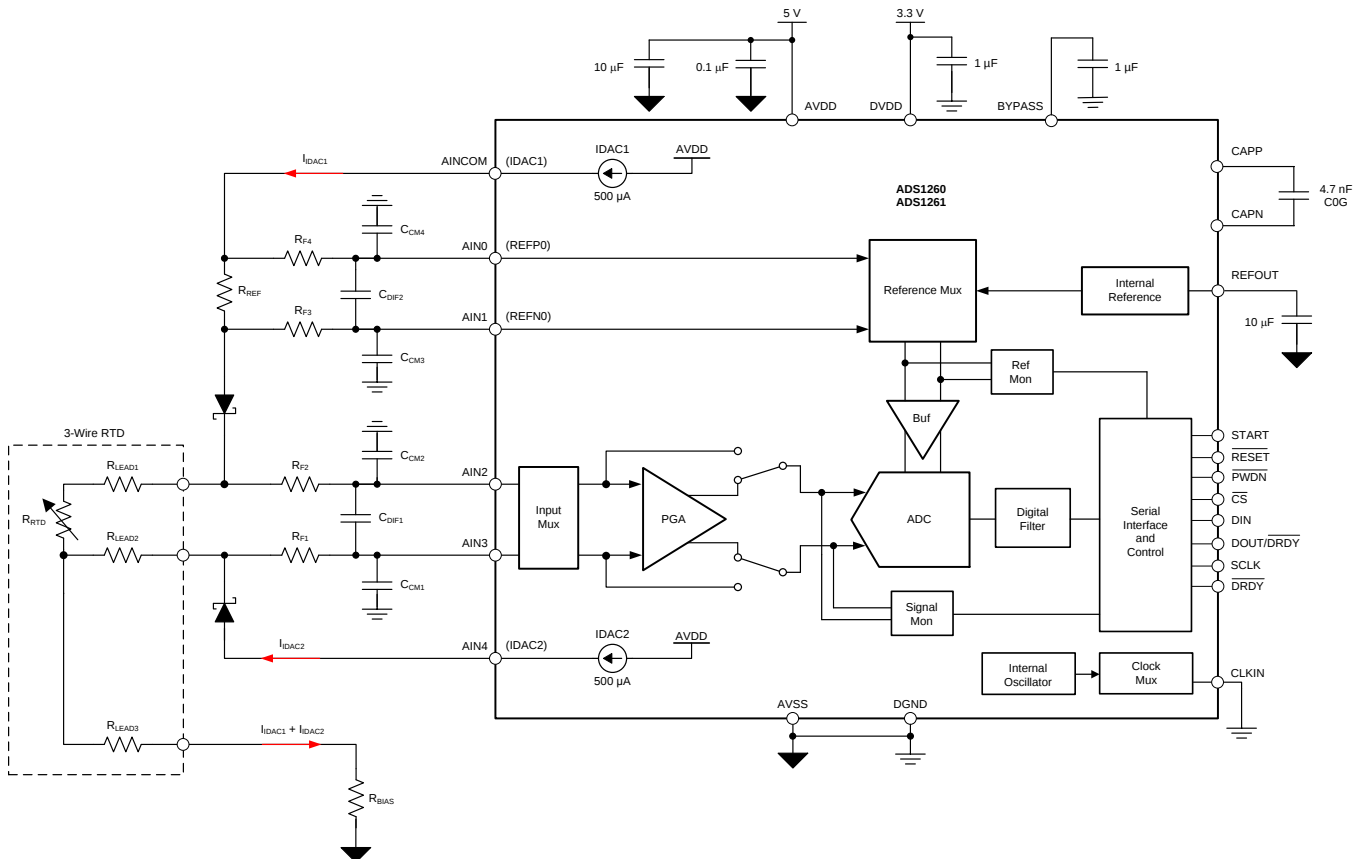


Figure 99. RTD Element With 3-Wire Lead Resistance Compensation

### 11.2.1 Design Requirements

The key considerations in the design of a 3-wire RTD circuit are the accuracy, stability and noise of the measurement, accuracy of the lead-wire compensation and self-heating of the sensor. Stability of the measurement is determined by the offset and gain drift of the ADC and by the drift of the external reference resistor. Measurement noise is determined by the ADC sample rate and by the digital filter settings. These parameters are not summarized here. Table 45 summarizes the basic design goals for a 3-wire Pt100 RTD.

Table 45. Design Goals

| DESIGN PARAMETER          | VALUE                       |
|---------------------------|-----------------------------|
| RTD sensor type           | 3-wire Pt100                |
| RTD resistance range      | 20 $\Omega$ to 400 $\Omega$ |
| RTD lead resistance range | 0 $\Omega$ to 10 $\Omega$   |
| RTD self heating          | < 1 mW                      |

表 46 summarize the parameters of the detailed design procedure that follows.

**表 46. Design Parameters**

| DESIGN PARAMETER |                                                                     | DESIGN VALUE    |
|------------------|---------------------------------------------------------------------|-----------------|
| $I_{IDAC}$       | IDAC current                                                        | 500 $\mu$ A     |
| $P_{RTD}$        | RTD power dissipation                                               | 0.1 mW          |
| $V_{RTD}$        | RTD input voltage                                                   | 0.20 V          |
| Gain             | ADC gain                                                            | 8               |
| $V_{REF}$        | Reference voltage (design target allows for 10% overrange)          | 1.76 V          |
| $R_{REF}$        | Reference resistor (senses the IDAC current to generate $V_{REF}$ ) | 3.52 k $\Omega$ |
| $R_{BIAS}$       | Bias resistor (provides the RTD level-shift voltage)                | 1.10 k $\Omega$ |
| $V_{RTDN}$       | RTD negative input voltage                                          | 1.1 V           |
| $V_{RTDP}$       | RTD positive input voltage                                          | 1.31 V          |
| $V_{IDAC1}$      | IDAC1 loop voltage                                                  | 3.37 V          |

### 11.2.2 Detailed Design Procedure

IDAC1 current flows through reference resistor,  $R_{REF}$ , which generates the ADC reference voltage,  $V_{REF} = I_{IDAC1} \cdot R_{REF}$ . IDAC1 current also flows through the RTD element. Since the same current flows through  $R_{REF}$  and the RTD element, the RTD measurement is ratiometric, which means the drift and error of the current source are cancelled. Therefore, the measurement accuracy is solely dependent on the tolerance of  $R_{REF}$  and on ADC gain and offset errors. The errors are calibrated by host software control using shorted-input calibration and using a 400  $\Omega$  precision resistor for full-scale calibration.

The current of IDAC2 is programmed to the same value as IDAC1 and is connected to  $R_{LEAD2}$ . IDAC2 generates an equal voltage drop across  $R_{LEAD1}$  and IDAC1. The accuracy of lead-wire compensation depends on the matching error between IDAC1 to IDAC2.

Using  $R_{RTD} = 400 \Omega$ , IDAC current = 500  $\mu$ A, and gain = 8, the minimum ADC reference voltage requirement calculates to 1.6 V. To provide 10% design margin,  $R_{REF}$  calculates to 3.52 k $\Omega$  (1.76 V / 500  $\mu$ A). 500  $\mu$ A is selected to minimize heating of the sensor.

Resistor  $R_{BIAS}$  level-shifts the RTD voltage to meet the input range requirement of the ADC. This voltage is  $V_{RTDN}$  and the low limit is calculated by 式 8. The  $V_{RTDN}$  low limit is 1 V.

$$AVSS + 0.3 \text{ V} + V_{RTD} \cdot (\text{Gain} - 1) / 2 \leq V_{RTDN} \quad (8)$$

Using 10% design margin,  $R_{BIAS}$  calculates to 1.1 k $\Omega = 1.1 \text{ V} / (2 \cdot 500 \mu\text{A})$ . The next step is to verify the positive RTD voltage ( $V_{RTDP}$ ) does not exceed the maximum input range, as shown in 式 9:

$$\text{Maximum } V_{RTDP} \leq AVDD - 0.3 \text{ V} - V_{RTD} \cdot (\text{Gain} - 1) / 2 \quad (9)$$

Evaluation of the equation results in the  $V_{RTDP}$  high limit = 3.75 V. Calculate the actual  $V_{RTDP}$  input voltage by 式 10:

$$\text{Actual } V_{RTDP} = V_{RTDN} + I_{IDAC1} \cdot (R_{RTD} + 2 \cdot R_{LEAD}) = 1.1 \text{ V} + 500 \mu\text{A} \cdot (400 \Omega + 20 \Omega) = 1.31 \text{ V} \quad (10)$$

$V_{RTDN} = 1.1 \text{ V}$  and  $V_{RTDP} = 1.31 \text{ V}$  satisfy the negative and positive input voltage requirements of the ADC, respectively.

Verify the burden voltage of current source IDAC1 is below the specified compliance range. The burden voltage is the sum of voltages in the IDAC1 loop as calculated by  $V_{RTDP} + (I_{IDAC1} \cdot R_{REF}) + V_D$  ( $V_D$  = external diode voltage). The result is 3.37 V, which meets the specified compliance voltage of the current source.

External filter components  $R_{F1}$ ,  $R_{F2}$ ,  $C_{DIF1}$ ,  $C_{CM1}$ ,  $C_{CM2}$  and  $R_{F3}$ ,  $R_{F4}$ ,  $C_{DIF2}$ ,  $C_{CM3}$ , and  $C_{CM4}$  filter the signal and reference inputs of the ADC. The filters remove both differential and common-mode noise. The input signal differential filter cutoff frequency as calculated by 式 11:

$$f_{DIF} = 1 / [2\pi \cdot R_{F1} + R_{F2}) \cdot R_{DIF1} + C_{M1} || C_{M2}] \quad (11)$$

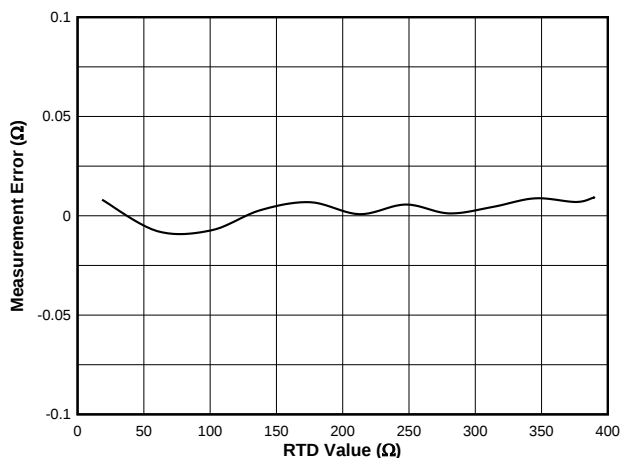
The Input signal common-mode filter is calculated by 式 12:

$$f_{CM} = 1 / (2\pi \cdot R_{F1} \cdot C_{M1}) = 1 / (2\pi \cdot R_{F2} \cdot C_{M2}) \quad (12)$$

Component mismatch in the common-mode filter converts common-mode noise into differential noise. Use a differential capacitor  $C_{DIF1}$  10× higher value than the common-mode capacitors,  $C_{CM1}$  and  $C_{CM2}$  to minimize the effects of mismatch. The recommended range of input resistors is 1 kΩ to 10 kΩ; increasing the resistance beyond 10 kΩ beyond can compromise noise and drift performance of the ADC. Use high-quality COG ceramics or film-type capacitors. For consistent noise performance across the full RTD temperature range, match the corner frequencies of the input and reference filters. Detailed information is found in the [RTD Ratiometric Measurements and Filtering Using the ADS1148 and ADS1248 Family of Devices](#) application report.

### 11.2.3 Application Curves

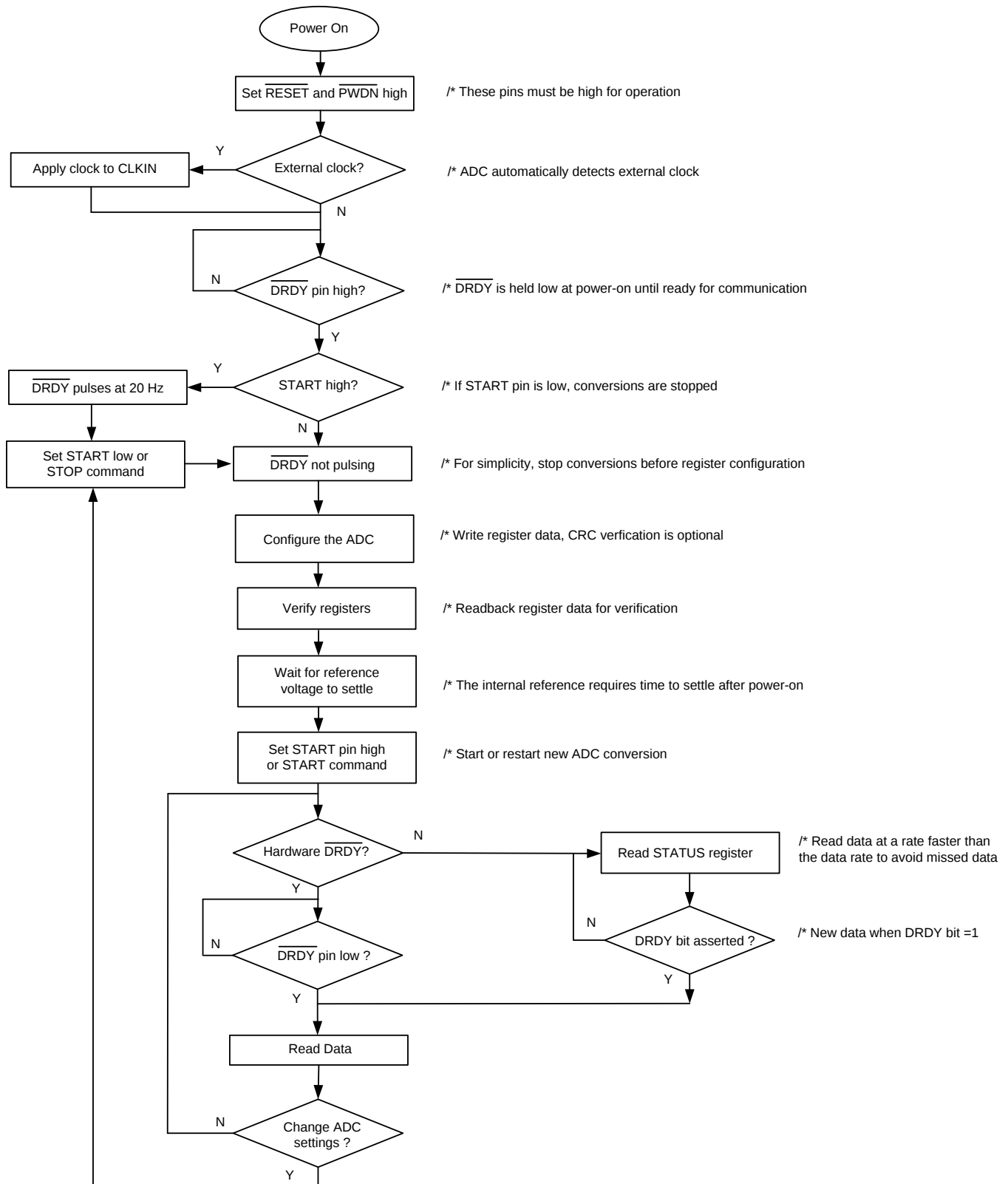
Figure 100 shows the resistance measurement results. The measurements are taken at  $T_A = 25^\circ\text{C}$ . The data are taken using a precision resistor simulator with a 3-wire connection in place of the RTD. A system offset calibration is performed using shorted inputs. A system gain calibration is performed using a 390-Ω precision resistor. The measurement data are in ohms and do not include the error of the RTD sensor. The measured resistance error is  $< \pm 0.02 \Omega$  over the 20-Ω to 400-Ω range.



**Figure 100. 3-Wire RTD Example Measurement Results**

## 11.3 Initialization Setup

Figure 101 shows a general configuration and measurement procedure.



**Figure 101. ADC Configuration and Measurement Procedure**

## 12 Power Supply Recommendations

The ADC requires an analog power supply (AVDD, AVSS) and digital power supply (DVDD). The analog power supply can be bipolar (AVDD = +2.5 V and AVSS = –2.5 V) or unipolar (AVDD = 5 V and AVSS = DGND). The digital supply range is 2.7 V to 5.25 V. DVDD powers the ADC core by use of an internal regulator. DVDD also sets the digital I/O voltage. Keep in mind that the GPIO I/O voltages are AVDD and AVSS. Voltage ripple produced by switch-mode power supplies may interfere with the ADC conversions. Use low-dropout regulators (LDOs) to reduce switch-mode power supply ripple.

### 12.1 Power-Supply Decoupling

Good power-supply decoupling is important in order to achieve optimum performance. Power supplies must be decoupled close to the power supply pins using short, direct connections to ground. For the analog supply, place 0.1-μF and 10-μF capacitors between AVDD and AVSS and 0.1-μF capacitors from each supply to ground. Connect a 1-μF capacitor from DVDD to the ground plane. Connect a 1-μF capacitor from BYPASS to the ground plane.

### 12.2 Analog Power-Supply Clamp

It is important to evaluate circumstances when an input signal is present with the ADC, both powered and unpowered. When the input signal exceeds the power-supply voltage, it is possible to *backdrive* the analog power-supply voltage with the input signal through a conduction path of the internal ESD diodes. Backdriving the ADC power supply can also occur when the power-supply is on. The backdriven current path is illustrated in [Figure 102](#). Depending on how the power supply responds during a backdriven condition, it is possible to exceed the maximum rated ADC supply voltage. The ADC voltage must not be exceeded at all times. One solution is to clamp the analog supply to safe voltage using an external zener diode.

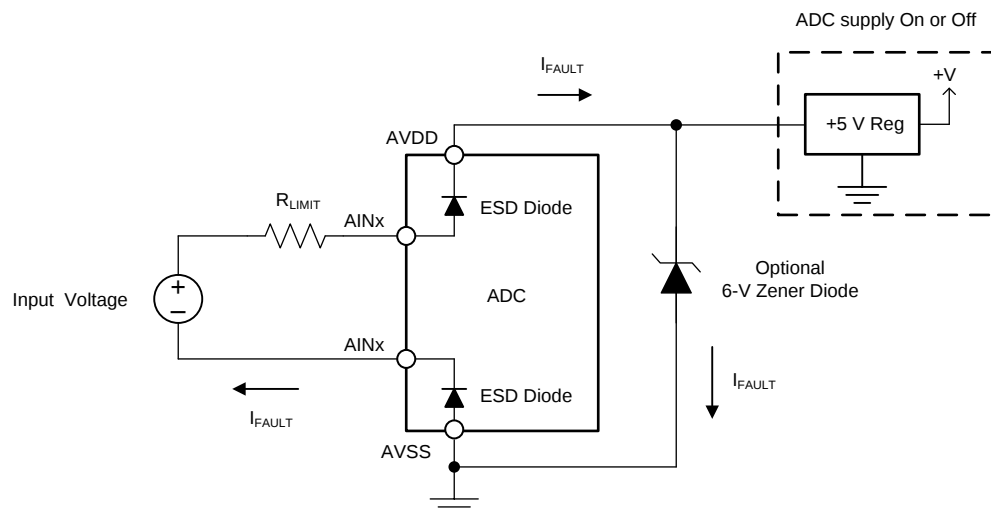


Figure 102. Analog Power-Supply Clamp

### 12.3 Power-Supply Sequencing

The power supplies can be sequenced in any order, but do not allow the analog or digital inputs to exceed the respective analog or digital power-supplies without external limits of the possible input fault currents.

## 13 Layout

Good layout practices are crucial to realize the full-performance of the ADC. Poor grounding can quickly degrade the noise performance. The following layout guidelines help provide the best results.

### 13.1 Layout Guidelines

For best performance, dedicate an entire PCB layer to a ground plane and do not route any other signal traces on this layer. However, depending on restrictions imposed by specific end equipment, a dedicated ground plane may not be practical. If ground plane separation is necessary, make a direct connection of the planes at the ADC. Do not connect individual ground planes at multiple locations because this configuration creates ground loops.

Route digital traces away from the CAPP and CAPN pins, away from the REFOUT pin, and away from all analog inputs and associated components in order to minimize interference.

Avoid long traces on DOUT/ $\overline{\text{DRDY}}$ , because high capacitance on this pin can lead to increase of ADC noise levels. Use a series resistor or a buffer if long traces are used.

The internal reference output return shares the same pin as the AVSS power supply. To minimize coupling between the power supply and reference-return trace, route the traces separately; ideally, as a star connection to the AVSS pin.

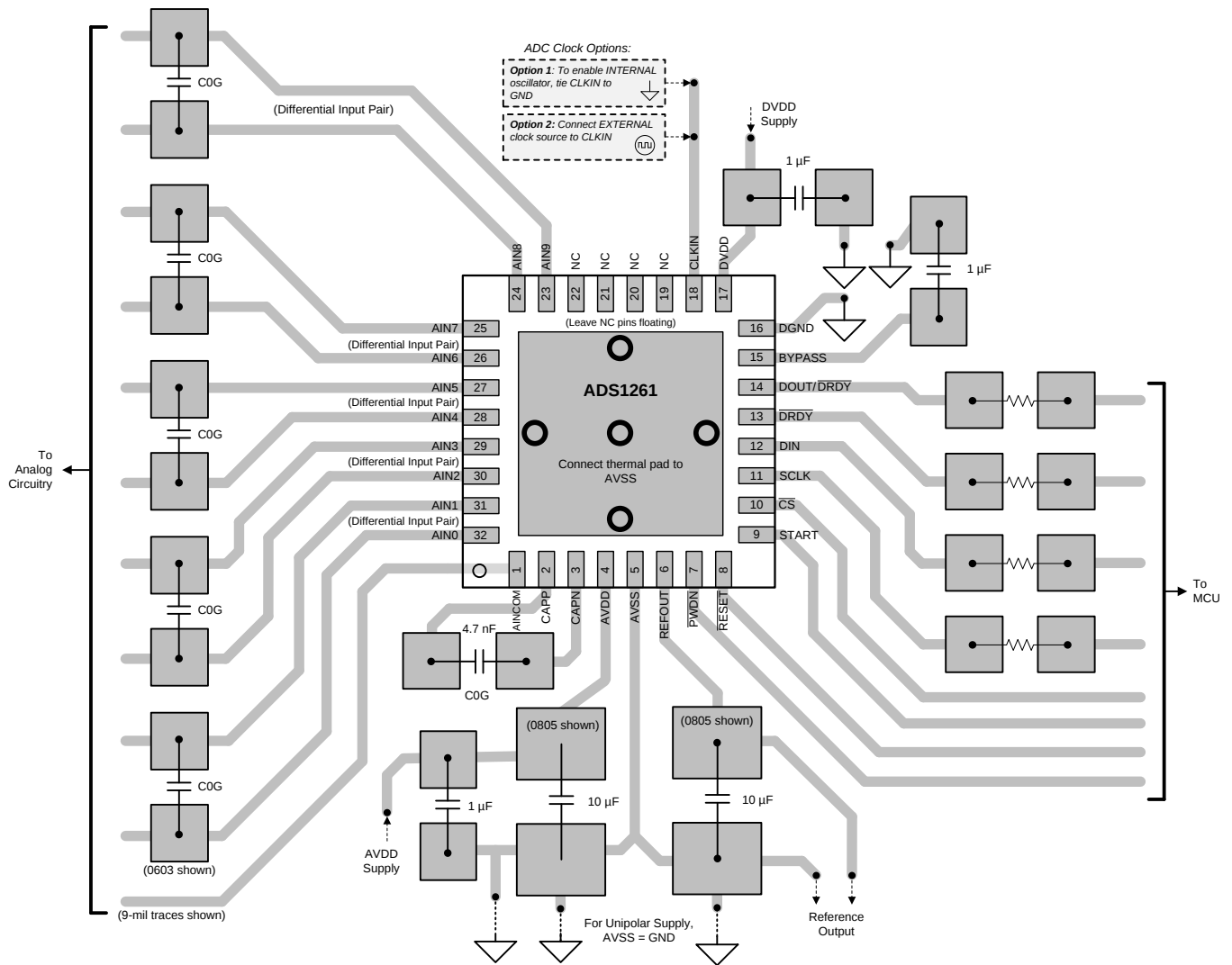
Use C0G capacitors on the analog inputs and for the CAPP to CAPN capacitor. Use ceramic capacitors (for example, X7R grade) for the power supply decoupling capacitors. High-K capacitors (Y5V) are not recommended. The REFOUT pin requires a 10- $\mu\text{F}$  capacitor and can be either ceramic or tantalum type. Place the required capacitors as close as possible to the device pins using short, direct traces. For optimum performance, use low-impedance connections on the ground-side connections of the bypass capacitors.

When applying an external clock, be sure the clock is free of overshoot and glitches. A source-termination resistor placed at the clock buffer often helps reduce overshoot. Glitches present on the clock input can lead to noise within the conversion data.

### 13.2 Layout Example

✎ 103 is an example layout of the ADS1261, requiring a minimum of three PCB layers. The example circuit is shown with single supply operation ( $\text{AVSS} = \text{DGND}$ ). In this example, the inner layer is dedicated to the ground plane and the outer layers are used for signal and power traces. If a four-layer PCB is used, dedicate the additional inner layer as the power plane. In this example, the ADC is oriented in such a way to minimize crossover of the analog and digital signal traces.

### Layout Example (continued)



### ✎ 103. ADS1261 Layout Example

## 14 デバイスおよびドキュメントのサポート

### 14.1 ドキュメントのサポート

#### 14.1.1 関連資料

関連資料については、以下を参照してください。

テキサス・インスツルメンツ『[ADS1261](#) および [ADS1235](#) 評価モジュール』ユーザー・ガイド

### 14.2 関連リンク

次の表に、クイック・アクセス・リンクを示します。カテゴリには、技術資料、サポートおよびコミュニティ・リソース、ツールとソフトウェア、およびご注文へのクイック・アクセスが含まれます。

表 47. 関連リンク

| 製品      | プロダクト・フォルダ              | ご注文はこちら                 | 技術資料                    | ツールとソフトウェア              | サポートとコミュニティ             |
|---------|-------------------------|-------------------------|-------------------------|-------------------------|-------------------------|
| ADS1260 | <a href="#">ここをクリック</a> | <a href="#">ここをクリック</a> | <a href="#">ここをクリック</a> | <a href="#">ここをクリック</a> | <a href="#">ここをクリック</a> |
| ADS1261 | <a href="#">ここをクリック</a> | <a href="#">ここをクリック</a> | <a href="#">ここをクリック</a> | <a href="#">ここをクリック</a> | <a href="#">ここをクリック</a> |

### 14.3 ドキュメントの更新通知を受け取る方法

ドキュメントの更新についての通知を受け取るには、[ti.com](http://ti.com)のデバイス製品フォルダを開いてください。右上の「アラートを受け取る」をクリックして登録すると、変更されたすべての製品情報に関するダイジェストを毎週受け取れます。変更の詳細については、修正されたドキュメントに含まれている改訂履歴をご覧ください。

### 14.4 コミュニティ・リソース

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

**TI E2E™ オンライン・コミュニティ** TIのE2E ( Engineer-to-Engineer ) コミュニティ。エンジニア間の共同作業を促進するために開設されたものです。e2e.ti.comでは、他のエンジニアに質問し、知識を共有し、アイデアを検討して、問題解決に役立てることができます。

**設計サポート** TIの設計サポート役に立つE2Eフォーラムや、設計サポート・ツールをすばやく見つけることができます。技術サポート用の連絡先情報も参照できます。

### 14.5 商標

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### 14.6 静電気放電に関する注意事項



すべての集積回路は、適切なESD保護方法を用いて、取扱いと保存を行うようにして下さい。

静電気放電はわずかな性能の低下から完全なデバイスの故障に至るまで、様々な損傷を与えます。高精度の集積回路は、損傷に対して敏感であり、極めてわずかなパラメータの変化により、デバイスに規定された仕様に適合しなくなる場合があります。

### 14.7 Glossary

**SLYZ022** — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

## 15 メカニカル、パッケージ、および注文情報

以降のページには、メカニカル、パッケージ、および注文に関する情報が記載されています。これらの情報は、指定のデバイスに対して提供されている最新のデータです。このデータは予告なく変更されることがあり、ドキュメントが改訂される場合もあります。本データシートのブラウザ版を使用されている場合は、画面左側の説明をご覧ください。

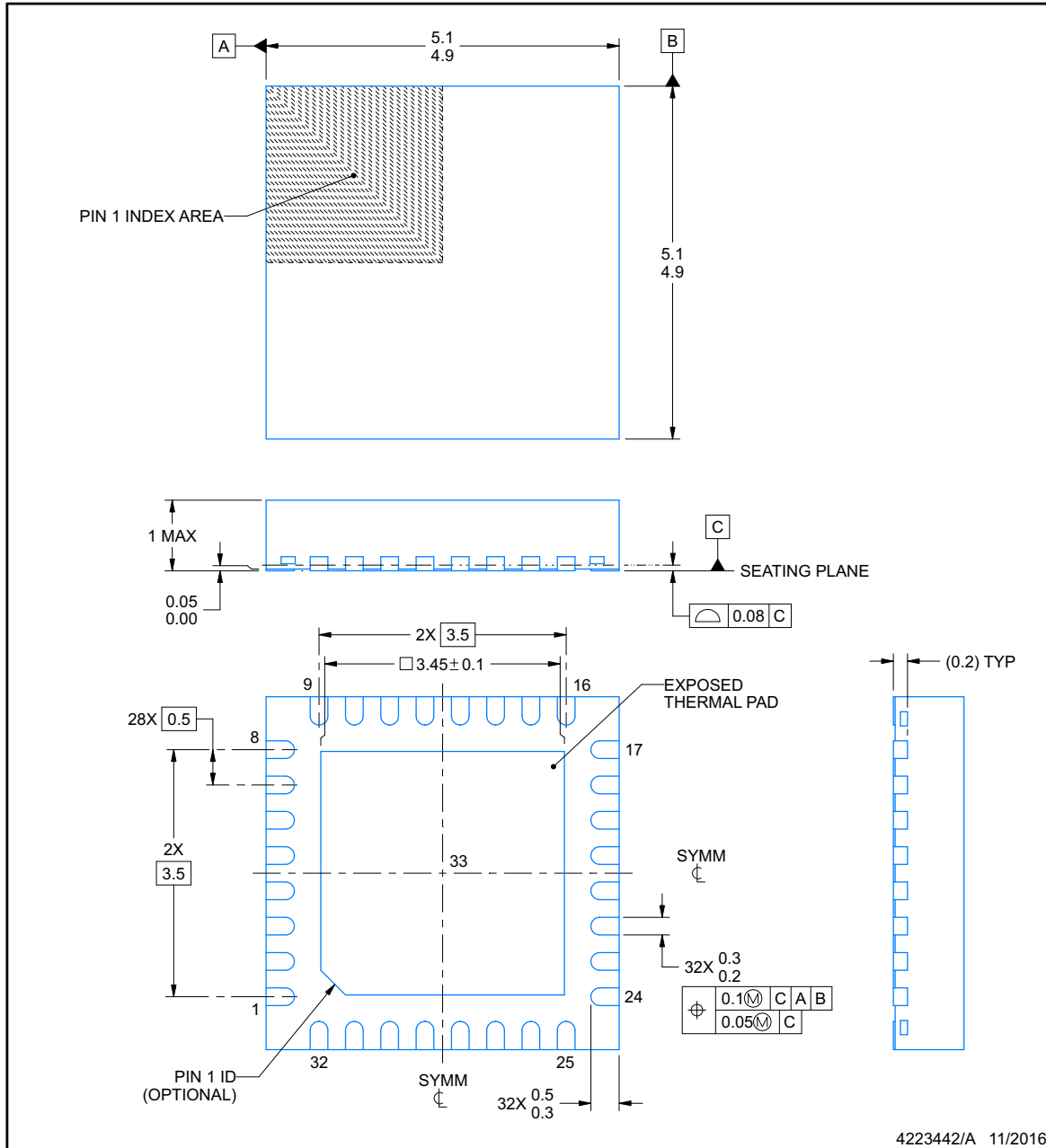


## PACKAGE OUTLINE

**RHB0032E**

**VQFN - 1 mm max height**

PLASTIC QUAD FLATPACK - NO LEAD



NOTES:

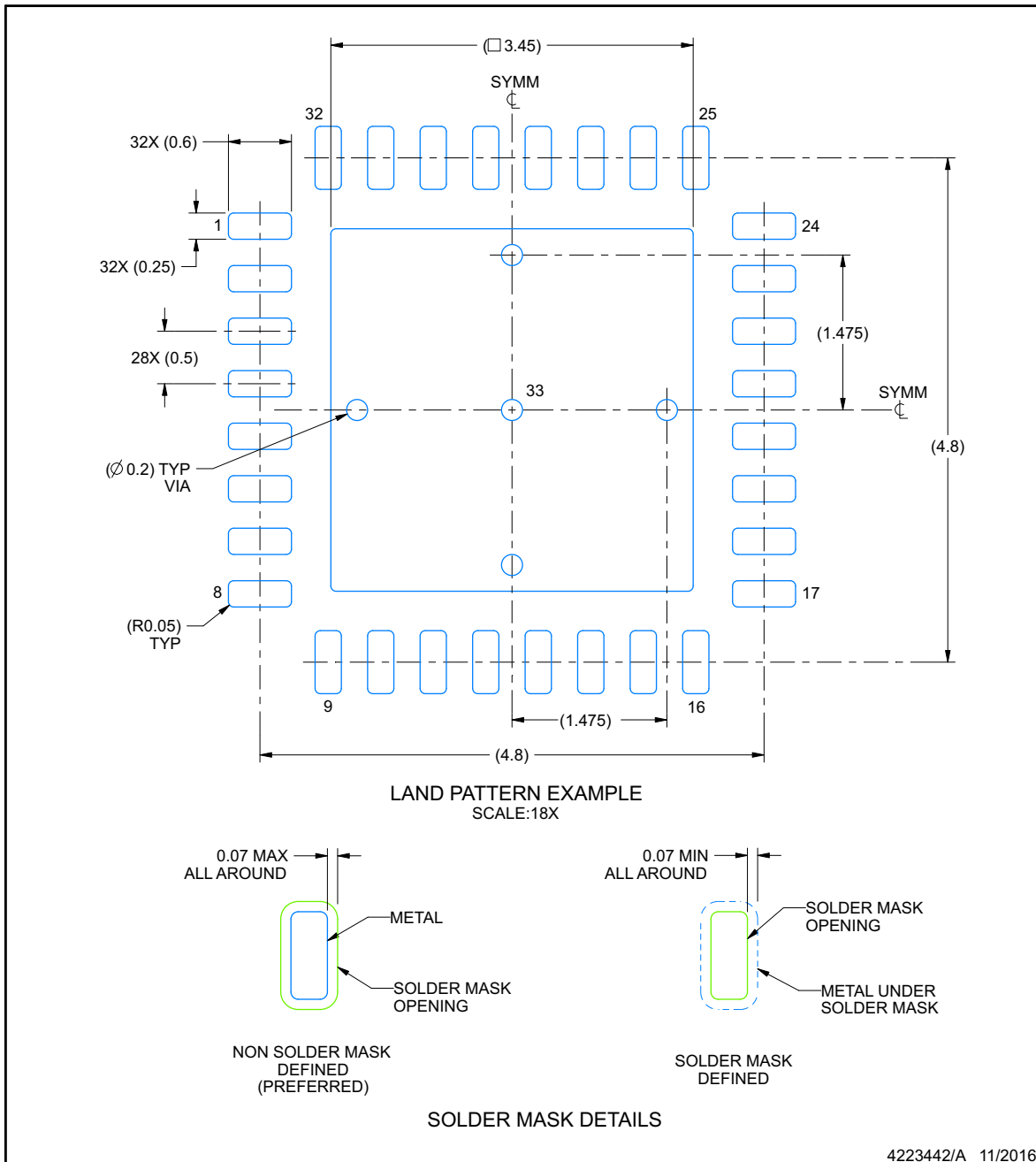
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

## EXAMPLE BOARD LAYOUT

RHB0032E

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



NOTES: (continued)

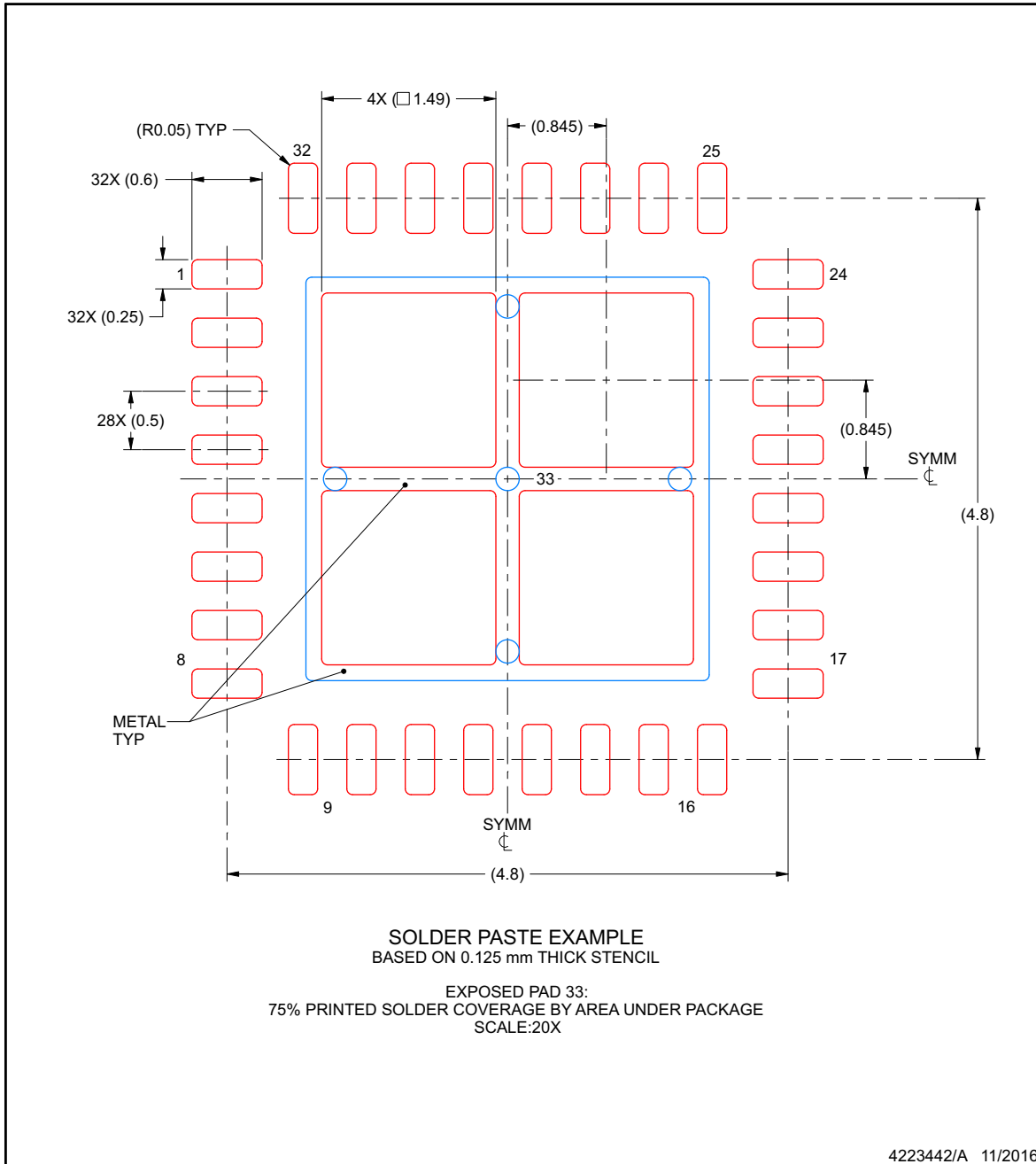
4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/sluea271](http://www.ti.com/lit/sluea271)).
5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

## EXAMPLE STENCIL DESIGN

**RHB0032E**

**VQFN - 1 mm max height**

PLASTIC QUAD FLATPACK - NO LEAD



NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

**PACKAGING INFORMATION**

| Orderable part number         | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-------------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">ADS1260BIRHBR</a> | Active        | Production           | VQFN (RHB)   32 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 125   | ADS<br>1260B        |
| ADS1260BIRHBR.B               | Active        | Production           | VQFN (RHB)   32 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 125   | ADS<br>1260B        |
| <a href="#">ADS1260BIRHBT</a> | Active        | Production           | VQFN (RHB)   32 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 125   | ADS<br>1260B        |
| ADS1260BIRHBT.B               | Active        | Production           | VQFN (RHB)   32 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 125   | ADS<br>1260B        |
| <a href="#">ADS1261BIRHBR</a> | Active        | Production           | VQFN (RHB)   32 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 125   | ADS<br>1261B        |
| ADS1261BIRHBR.B               | Active        | Production           | VQFN (RHB)   32 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 125   | ADS<br>1261B        |
| ADS1261BIRHBRG4               | Active        | Production           | VQFN (RHB)   32 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 125   | ADS<br>1261B        |
| ADS1261BIRHBRG4.B             | Active        | Production           | VQFN (RHB)   32 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 125   | ADS<br>1261B        |
| <a href="#">ADS1261BIRHBT</a> | Active        | Production           | VQFN (RHB)   32 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 125   | ADS<br>1261B        |
| ADS1261BIRHBT.B               | Active        | Production           | VQFN (RHB)   32 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 125   | ADS<br>1261B        |
| <a href="#">ADS1261IRHBR</a>  | Active        | Production           | VQFN (RHB)   32 | 3000   LARGE T&R      | Yes         | Call TI   Nipdau                     | Level-3-260C-168 HR               | -40 to 125   | ADS<br>1261         |
| ADS1261IRHBR.B                | Active        | Production           | VQFN (RHB)   32 | 3000   LARGE T&R      | Yes         | Call TI                              | Level-3-260C-168 HR               | -40 to 125   | ADS<br>1261         |
| <a href="#">ADS1261IRHBT</a>  | Active        | Production           | VQFN (RHB)   32 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 125   | ADS<br>1261         |
| ADS1261IRHBT.B                | Active        | Production           | VQFN (RHB)   32 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 125   | ADS<br>1261         |
| ADS1261IRHBTG4                | Active        | Production           | VQFN (RHB)   32 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 125   | ADS<br>1261         |
| ADS1261IRHBTG4.B              | Active        | Production           | VQFN (RHB)   32 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 125   | ADS<br>1261         |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

**(2) Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

**(3) RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

**(4) Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

**(5) MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

**(6) Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "-" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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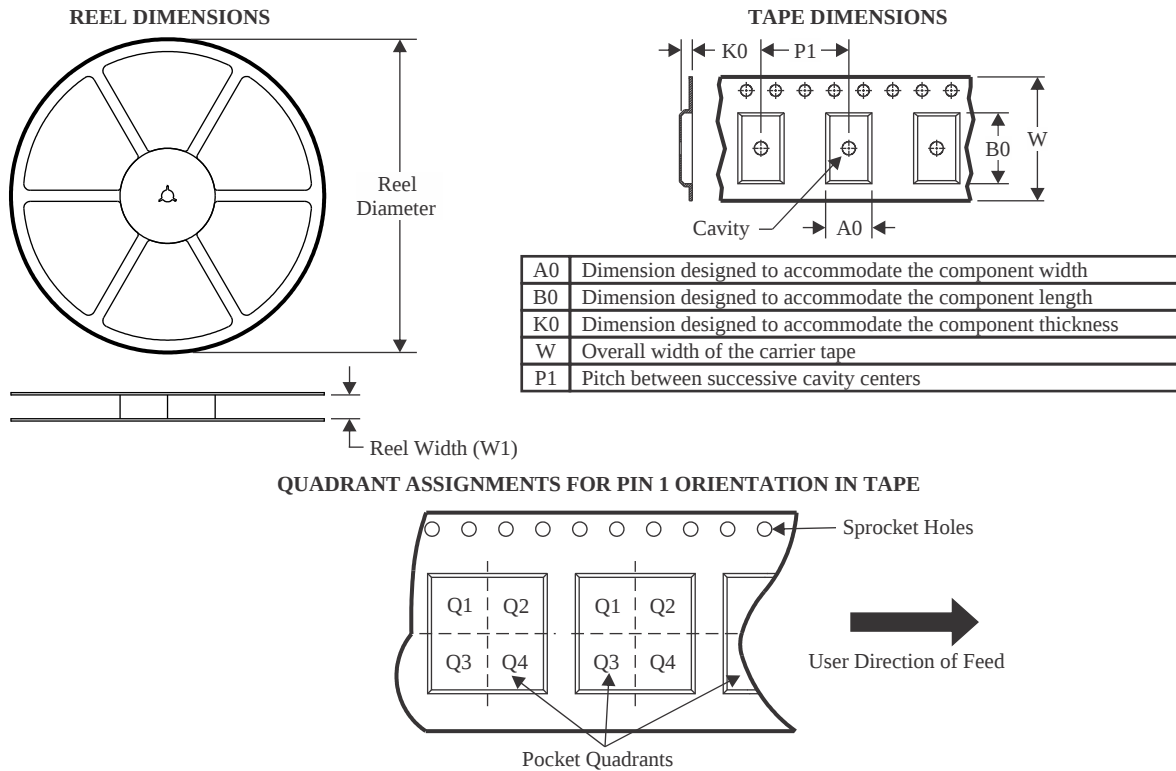
**OTHER QUALIFIED VERSIONS OF ADS1260, ADS1261 :**

- Automotive : [ADS1260-Q1](#), [ADS1261-Q1](#)

NOTE: Qualified Version Definitions:

- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

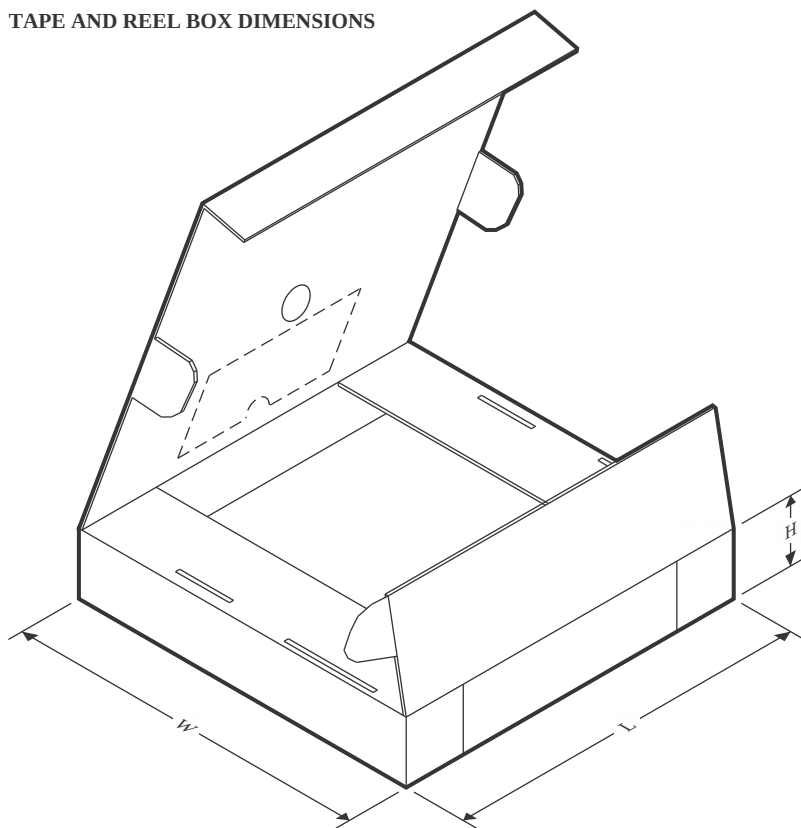
## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device          | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-----------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| ADS1260BIRHBR   | VQFN         | RHB             | 32   | 3000 | 330.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| ADS1260BIRHBT   | VQFN         | RHB             | 32   | 250  | 180.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| ADS1261BIRHBR   | VQFN         | RHB             | 32   | 3000 | 330.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| ADS1261BIRHBRG4 | VQFN         | RHB             | 32   | 3000 | 330.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| ADS1261BIRHBT   | VQFN         | RHB             | 32   | 250  | 180.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| ADS1261IRHBR    | VQFN         | RHB             | 32   | 3000 | 330.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| ADS1261IRHBT    | VQFN         | RHB             | 32   | 250  | 180.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| ADS1261IRHBTG4  | VQFN         | RHB             | 32   | 250  | 180.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device          | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| ADS1260BIRHBR   | VQFN         | RHB             | 32   | 3000 | 346.0       | 346.0      | 33.0        |
| ADS1260BIRHBT   | VQFN         | RHB             | 32   | 250  | 210.0       | 185.0      | 35.0        |
| ADS1261BIRHBR   | VQFN         | RHB             | 32   | 3000 | 346.0       | 346.0      | 33.0        |
| ADS1261BIRHBRG4 | VQFN         | RHB             | 32   | 3000 | 346.0       | 346.0      | 33.0        |
| ADS1261BIRHBT   | VQFN         | RHB             | 32   | 250  | 210.0       | 185.0      | 35.0        |
| ADS1261IRHBR    | VQFN         | RHB             | 32   | 3000 | 346.0       | 346.0      | 33.0        |
| ADS1261IRHBT    | VQFN         | RHB             | 32   | 250  | 210.0       | 185.0      | 35.0        |
| ADS1261IRHBTG4  | VQFN         | RHB             | 32   | 250  | 210.0       | 185.0      | 35.0        |

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